

**DDR Analysis**  
**Memory Interface Electrical Verification and Debug Solution**  
**Printable Application Help**





**DDR Analysis**  
**Memory Interface Electrical Verification and Debug Solution**  
**Printable Application Help**

Copyright © Tektronix. All rights reserved. Licensed software products are owned by Tektronix or its subsidiaries or suppliers, and are protected by national copyright laws and international treaty provisions. Tektronix products are covered by U.S. and foreign patents, issued and pending. Information in this publication supersedes that in all previously published material. Specifications and price change privileges reserved.

TEKTRONIX and TEK are registered trademarks of Tektronix, Inc.

### **Contacting Tektronix**

Tektronix, Inc.  
14150 SW Karl Braun Drive  
P.O. Box 500  
Beaverton, OR 97077  
USA

For product information, sales, service, and technical support:

- In North America, call 1-800-833-9200.
- Worldwide, visit [www.tektronix.com](http://www.tektronix.com) to find contacts in your area.

---

# Table of Contents

Welcome .....	xiii
---------------	------

## Introduction to the application

Related documentation .....	1
Conventions .....	1
Technical support .....	2
Customer feedback .....	2

## Getting started

Product description .....	5
DDRA prerequisites .....	6
Requirements and restrictions .....	6
Supported probes .....	6
Installing the application .....	7
About DDRA .....	8

## Operating basics

About basic operations .....	9
Starting the application .....	9
Menu controls .....	9
Virtual keypad .....	9
Tips on the DDRA user interface .....	10
Basic oscilloscope functions .....	11
Application directories .....	11
File name extensions .....	11
Returning to the application .....	11
Control panel .....	11
Saving and recalling setups .....	12
Saving a setup .....	12
Recalling a saved setup .....	12
Recalling the default setup .....	13
Search and mark .....	13
Limits .....	14
Dynamic limits .....	15

Setting up DDR for analysis .....	16
DDR standards and their measurements .....	16
Derating .....	25
About DDR analysis .....	28
Step 1: Generation rate and levels .....	28
Step 2: Interposer filter .....	31
Step 3: Measurements and sources .....	33
Step 4: Burst detection method .....	38
Step 5: Burst detection settings .....	42
Step 6: Thresholds and scaling .....	42
DQ-DQS phase alignment .....	44
Chip select latency + DQ-DQS phase alignment .....	46
Logic state + burst latency .....	47
Visual search .....	50
Measurement levels .....	53
Hints .....	54
Results as statistics .....	54
Plots .....	55
Reports .....	55
Switching between the DDRA and DPOJET applications .....	55
Salient features of MSO-DDRA integration .....	56

## Tutorial

Introduction to the tutorial .....	57
Setting up the oscilloscope .....	57
Starting the application .....	57
Waveform files .....	57
Recalling a waveform file .....	57
Taking a measurement .....	58

## Parameters

About parameters .....	61
Step 1: Generation rate and levels parameters .....	61
Step 2: Interposer filter parameters .....	62
Step 3: Measurement and sources parameters .....	62
Step 4: Burst detection method parameters .....	63
Step 5: Burst detection settings parameters .....	63
Step 6: Thresholds and scaling parameters .....	65

## Reference

DDR measurement sources .....	67
DDR2 measurement sources .....	69
DDR3 measurement sources .....	73
DDR3L measurement sources .....	77
DDR4 measurement sources .....	81
GDDR5 measurement sources .....	84
LPDDR measurement sources .....	86
LPDDR2 measurement sources .....	88
LPDDR3 measurement sources .....	92
LPDDR4 measurement sources .....	96
Measurement range limits .....	99
Dynamic limits for DDR measurements .....	100
Dynamic limits for DDR2 measurements .....	101
Dynamic limits for DDR3 measurements .....	101
Dynamic limits for DDR3L measurements .....	102
Dynamic limits for DDR4 measurements .....	103
Dynamic limits for LPDDR measurements .....	104
Dynamic limits for LPDDR2 measurements .....	104
Dynamic limits for LPDDR3 measurements .....	105
Dynamic limits for LPDDR4 measurements .....	106
Vih-Vil reference levels .....	107
Using digital channels .....	109
Error codes and warnings .....	116

## Algorithms

About algorithms .....	121
Write measurements .....	121
Data eye height .....	121
Data eye width .....	122
DDRARXMask .....	122
tDQSS .....	123
tDQS2DQ .....	123
VIHL_AC .....	124
SRIN_dIVW_Rise .....	124
SRIN_dIVW_Fall .....	124
TdIPW-High .....	124

TdIPW-Low .....	124
Differential DQS measurements .....	124
Input Slew-Diff-Rise(DQS) .....	124
Input Slew-Diff-Fall(DQS) .....	125
tDH-Diff(base) .....	125
tDH-Diff(derated) .....	126
tDH-Diff(Vref-based) .....	126
tDS-Diff(base) .....	126
tDS-Diff(derated) .....	127
tDS-Diff(Vref-based) .....	127
tDQSH .....	127
tDQSL .....	128
tDSS-Diff .....	128
tDSH-Diff .....	128
tDQSS-Diff .....	128
Single ended DQS .....	128
Slew Rate-Hold-SE-Fall(DQS) .....	128
Slew Rate-Hold-SE-Rise(DQS) .....	129
Slew Rate-Setup-SE-Fall(DQS) .....	129
Slew Rate-Setup-SE-Rise(DQS) .....	129
tDS-SE(base) .....	129
tDIPW-SE .....	129
tDSS-SE .....	129
tDSH-SE .....	129
tDQSS-SE .....	130
tDH-SE(base) .....	130
tDVAC(CK) .....	130
tWPRE .....	130
tWPST .....	131
tWRPDE .....	132
tWRSRE .....	132
Differential DQS read measurements .....	132
tDQSCK-Diff .....	132
tDQSQ-DBI .....	133
tDQSQ-Diff .....	133
tAC-Diff .....	133
tQH .....	133
SRQdiff-Rise(DQS) .....	134
SRQdiff-Fall(DQS) .....	134



Single-ended DQS read measurements .....	135
tDQSQ-SE .....	135
tDQSCK-SE .....	135
DDR2-tDQSCK .....	135
Slew rate DQ .....	136
SRQse-Fall(DQ) .....	136
SRQse-Rise(DQ) .....	136
tRDPDE .....	137
tRDSRE .....	137
tRPRE .....	137
tRPST .....	138
DQ measurements .....	139
Slew Rate-Hold-Fall(DQ) .....	139
Slew Rate-Hold-Rise(DQ) .....	139
Slew Rate-Setup-Fall(DQ) .....	139
Slew Rate-Setup-Rise(DQ) .....	139
Clock(Diff) measurements .....	139
SSC Downspread(CK) .....	139
SSC mod Freq(CK) .....	140
SSC Profile(CK) .....	140
tCH .....	140
tCK .....	140
tCL .....	140
tCH(abs) .....	140
tCH(avg) .....	141
tCK(abs) .....	141
tCK(avg) .....	141
tCL(abs) .....	141
tCL(avg) .....	142
tHP .....	142
tERR .....	142
tJIT(cc) .....	143
tJIT(duty) .....	143
tJIT(per) .....	144
VID(ac) .....	144
Input Slew-Diff-Rise(CK) .....	144
Input Slew-Diff-Fall(CK) .....	144
Clock (Single ended) .....	145
AC-Overshoot(CK#) .....	145

AC-Overshoot(CK)	145
AC-OvershootArea(CK#)	145
AC-OvershootArea(CK)	146
AC-Undershoot(CK#)	146
AC-Undershoot(CK)	146
AC-UndershootArea(CK#)	147
AC-UndershootArea(CK)	147
CKslew-Fall(CK)	148
CKslew-Fall(CK#)	148
CKslew-Rise(CK)	148
CKslew-Rise(CK#)	148
VIN(CK)	148
VIN(CK#)	148
Vix(ac)CK	148
Vox(ac)CK	149
VSWING(MAX)CK#	149
VSWING(MAX)CK	149
VSEH(AC)CK	149
VSEH(AC)CK#	150
VSEH(CK#)	150
VSEH(CK)	150
VSEL(AC)CK#	151
VSEL(AC)CK	151
VSEL(CK#)	151
VSEL(CK)	151
DQS(Single ended) measurements	151
Vix(ac)DQS	151
Vox(ac)DQS	151
AC-Overshoot(DQS)	152
AC-Overshoot(DQS#)	152
AC-OvershootArea(DQS#)	152
AC-OvershootArea(DQS)	153
AC-Undershoot(DQS)	153
AC-Undershoot(DQS#)	153
AC-UndershootArea(DQS#)	154
AC-UndershootArea(DQS)	154
WCK (Diff)	155
SSC Downspread(WCK)	155
SSC mod Freq(WCK)	155

SSC Profile(WCK)	155
tDVAC(WCK)	155
tWCK	155
tWCK-DJ	155
tWCKH	156
tWCKHP	156
tWCKL	156
tWCK-Rise-Slew	156
tWCK-Fall-Slew	156
tWCK-RJ	156
tWCK-TJ	156
VWCK-Swing	157
WCK (Single ended)	157
VIN(WCK)	157
VIN(WCK#)	157
Vix(ac)WCK	157
VOL(WCK)	157
VOH(WCK)	157
VOL(WCK#)	158
VOH(WCK#)	158
WCKslew-Fall(WCK)	158
WCKslew-Fall(WCK#)	158
WCKslew-Rise(WCK)	158
WCKslew-Rise(WCK#)	158
Address-Command measurements	159
AC-Overshoot	159
AC-OvershootArea	159
AC-Undershoot	160
AC-UndershootArea	160
Slew Rate-Hold-Fall(Addr-Cmd)	161
Slew Rate-Hold-Rise(Addr-Cmd)	161
Slew Rate-Setup-Fall(Addr-Cmd)	161
Slew Rate-Setup-Rise(Addr-Cmd)	161
tAH	161
tAPW	161
tAS	162
tCIPW-High	162
tCIPW-Low	162
tCMDH	162

tCMDPW .....	162
tCMDS .....	162
tIS(base) .....	162
tIH(base) .....	162
tIS(derated) .....	163
tIH(derated) .....	163
tIPW-High .....	163
tIPW-Low .....	163
Refresh .....	163
tCKSRE .....	163
tCKSRX .....	163
tRFC .....	164
tREFTR(Read) .....	164
tREFTR(Write) .....	164
tXSNRW .....	164
Power down .....	164
tPD .....	164
Active .....	164
tRAS .....	164
tRC .....	165
tRCDRD .....	165
tRCDWR .....	165
Precharge .....	166
tPPD .....	166
tRP(ACT) .....	166
tRP(MRS) .....	166
tRP(REF) .....	167
tRP(SRE) .....	167
tRTPL .....	167

## GPIB commands

About the GPIB program .....	169
GPIB reference materials .....	169
Argument types .....	169
Commands .....	170
DDRA:APPLYBurstconfig .....	170
DDRA:ADDALLTerr .....	170
DDRA:ADDALLSLewdq .....	171
DDRA:ADDALLDiffdq .....	171

DDRA:ADDCMDFLTFile .....	172
DDRA:ADVBURSTLevelmode .....	172
DDRA:ADDALLSEdqs .....	173
DDRA:ADDMeas .....	173
DDRA:ALTernatethresholds .....	175
DDRA:AMPBasedmargin .....	175
DDRA:BURSTIDMethod .....	176
DDRA:BURSTDETECTmethod .....	176
DDRA:BURSTLEngth .....	177
DDRA:BURSTLAtency .....	177
DDRA:BURSTLevelmode .....	178
DDRA:BURSTTOlerance .....	178
DDRA:BUS .....	179
DDRA:CLKFLTFile .....	179
DDRA:CSACTive .....	180
DDRA:CLEARALLMeas .....	180
DDRA:CSSOUrce .....	180
DDRA:CLKBARFLTFile .....	181
DDRA:CASMAX .....	181
DDRA:CASMIN .....	182
DDRA:CSLEvel .....	182
DDRA:CSMOde .....	182
DDRA:CUSTOMRate .....	183
DDRA:DATAHIGH .....	183
DDRA:DATALOW .....	184
DDRA:DQSBARFLTFile .....	184
DDRA:DQSFLTFile .....	185
DDRA:DQFLTFile .....	185
DDRA:DATAMID .....	186
DDRA:DATARate .....	186
DDRA:DQDQSLEVELSatus? .....	187
DDRA:FLTtype .....	187
DDRA:GENeration .....	187
DDRA:HYSTERESis .....	188
DDRA:HORIZontalscaling .....	188
DDRA:ISOLBurstlen .....	189
DDRA:LASTError? .....	189
DDRA:LOGICTrigger .....	189
DDRA:MEASType .....	190

DDRA:MARGIN .....	190
DDRA:POSTamble .....	190
DDRA:PREAmbletype .....	191
DDRA:PTPeak .....	191
DDRA:RXMASKFile .....	191
DDRA:SOURCE:ADDRCMD .....	192
DDRA:SOURCE:CLOCK .....	192
DDRA:SOURCE:STROBE .....	193
DDRA:SOURCE:DATA .....	193
DDRA:SOURCE? .....	194
DDRA:SOURCE:CLOCKBar .....	194
DDRA:SOURCE:STRObebar .....	195
DDRA:STROBEHIGH .....	195
DDRA:STROBEMID .....	196
DDRA:STROBELOW .....	196
DDRA:SOURCE:WCKBar .....	196
DDRA:SOURCE:WCK .....	197
DDRA:SYMBOLFile .....	197
DDRA:THREShold .....	198
DDRA:TDQS2DQMode .....	198
DDRA:TDQS2DQ .....	198
DDRA:TCKAVG .....	199
DDRA:TIMGMode .....	199
DDRA:TCKAVGMIN .....	199
DDRA:VCENTCA .....	200
DDRA:VCENTDQ .....	200
DDRA:VDD .....	200
DDRA:VDDMode .....	201
DDRA:VERTicalscaling .....	201
DDRA:VERsion? .....	202
DDRA:VIHACMin? .....	202
DDRA:VIHDCMin? .....	202
DDRA:VILACMax? .....	203
DDRA:VILDCMax? .....	203
DDRA:VREF .....	203
DDRA:VREFDC? .....	204
DDRA:VREFMode .....	204
DDRA:WRITEAmpgtread .....	204
DDRA:WCKBARFLTFile .....	205

DDRA:WCKFLTFile .....	205
-----------------------	-----





# Welcome

DDR (Dual Data Rate) is a dominant and fast-growing memory technology. It offers the high data transfer rates needed for virtually all computing applications, from consumer products to the most powerful servers. The high speeds of these signals require high performance measurement tools.

The DDRA application includes compliance measurements as part of our DDR Analysis solution. The DDR Analysis solution enables you to achieve new levels of productivity, efficiency, and measurement reliability. It requires the Jitter and Eye Diagram Analysis tool (Opt. DJA) and the Advanced Search and Mark capability (Opt. ASM).

Some of the DDRA features are:

- Provides debug, analysis, and compliance in one solution for multiple DDR standards such as DDR, DDR2, DDR3, DDR3L, DDR4, LPDDR, LPDDR2, LPDDR3, LPDDR4, GDDR3, and GDDR5.
- Enables analysis of compliance measurements either through the DDRA or DPOJET application for all bursts in an acquisition.
- Differentiates data reads from writes, or analyzes signal integrity on the clock or on a data (DQ) line during Read or Write cycles, or measures Data to Strobe setup and hold during Write cycles.
- Includes limit files to test measurement pass/fail status per standard, speed grades and speed bins. Supports non-standard speed grades.
- Provides both single-ended and differential measurements on Data, Strobe, Clock, Address and Command signals.
- Includes comprehensive measurement statistics.
- Includes sophisticated graphical analysis tools such as Histograms, Time Trends, Spectrums, Bathtub Plots, and Real-Time Eye® diagrams with superimposition of the strobe eye with the data eye.
- Produces consolidated reports automatically with pass/fail information, statistical measurement results, setup information, limits information, waveform path location, plots and user comments, if any.
- Automatically applies signal slew rate derating of measurement limits for Address/Command and data signals.
- Dynamically normalizes limits for clock measurements such as tERR based on the measured tCK(avg).
- Logic state configuration using the DDRA user interface.

## DDR

DDR is the DRAM (Dynamic Random Access Memory) technology responsible for increasing data transfer rates to meet high-speed requirements and data capacity of computer systems.

## DDR2

DDR2 is the Double Data Rate 2 SDRAM and is widely available in products with data rates up to 1066MT/s.

## DDR3

DDR3 DRAM memory is widely available in products and extends data rates to 1600 MT/s and faster rates to come.

## DDR3L

DDR3L (low voltage) DRAM memory is widely available in products and extends data rates to 1600 MT/s and faster rates to come.

## DDR4

DDR4 DRAM memory is widely available in products and extends data rates to 3200 MT/s and faster rates to come.

### **Low Power DDR**

LPDDR (Low Power DDR) is a technology for mobile phones and portable computing devices, driven by the need for faster operation with long battery life.

### **Low Power DDR2**

LPDDR2 (Low Power DDR2) is a technology for mobile phones and portable computing devices as it supports advanced power management. Includes a reduced interface voltage of 1.2 V from the 1.8 V specification as compared to LPDDR memory technology. This results in a power consumption reduced by over 50%.

### **Low Power DDR3**

LPDDR3 (Low Power DDR3) is a technology for mobile phones and portable computing devices as it supports advanced power management. Includes a reduced interface voltage of 1.2 V from the 1.8 V specification as compared to LPDDR memory technology. This results in a power consumption reduced by over 50%.

### **LPDDR4**

LPDDR4 (Low Power DDR4) is an emerging technology for mobile phones and portable computing devices as it supports advanced power management. Includes a reduced interface voltage of 1.1 V from the 1.8 V specification as compared to LPDDR memory technology.

### **Graphic DDR3**

GDDR3 (Graphic DDR) offers faster access and is used in graphics-intensive applications such as video cards and gaming systems.

### **GDDR5**

GDDR5 (Graphic DDR) is a type of high performance dynamic random-access graphics card memory designed for applications requiring high bandwidth.

# Introduction to the application

## Related documentation

Tektronix manuals are available at: [www.tektronix.com/manuals](http://www.tektronix.com/manuals) and [www.tektronix.com/software](http://www.tektronix.com/software). Use the following table to determine the document that you need:

**Table 1: List of reference documents**

For information on	Refer to
<ul style="list-style-type: none"><li>■ Operating the Oscilloscope</li></ul>	Oscilloscope user manual. Oscilloscope user online help.
<ul style="list-style-type: none"><li>■ Software warranty</li><li>■ List of available applications</li><li>■ Compatible oscilloscopes</li><li>■ Relevant software and firmware version numbers</li><li>■ Applying a new option key label</li><li>■ Installing an application</li><li>■ Enabling an application</li><li>■ Downloading updates from the Tektronix Web site</li></ul>	<i>Optional Applications Software on Windows-Based Oscilloscopes Installation Manual</i> , which is provided on the Optional Applications Software on Windows-Based Oscilloscopes DVD, in the Documents directory.




## Conventions

Online Help uses the following conventions:

- When steps require a sequence of selections using the application interface, the > delimiter marks each transition between a menu and an option. For example, **Analyze> DDR Analysis**.
- The terms DDR application and application refer to DDRA.
- The term DPOJET application or DPOJET refers to Jitter and Eye Diagram Analysis Tool.
- The term oscilloscope refers to any product on which this application runs.
- The term DUT is an abbreviation for Device Under Test.
- The term select is a generic term that applies to the methods of choosing an option: with a mouse or with the touch screen.
- User interface screen graphics are taken from a DPO7000 series oscilloscope.

You can find a PDF (portable document format) file for this document in the Documents directory on the *Optional Applications Software on Windows-Based Oscilloscopes DVD*. The DVD booklet contains information on installing the application from the DVD and on how to apply a new label.

**Table 2: Icon descriptions**

Icon	Meaning
	This icon identifies important information.
	This icon identifies conditions or practices that could result in loss of data.
	This icon identifies additional information that will help you use the application more efficiently.

## Technical support

Tektronix welcomes your comments about products and services. Contact Tektronix through mail, telephone, or the Web site. Click [Contacting Tektronix](#) for more information. Tektronix also welcomes your feedback. Click [Customer feedback](#) for suggestions for providing feedback to Tektronix.

## Customer feedback

Tektronix values your feedback on our products. To help us serve you better, please send us your suggestions, ideas, or other comments you may have regarding the application or oscilloscope.

Direct your feedback via e-mail to

**techsupport@tektronix.com**

Or FAX at (503) 627-5695, and include the following information:

### General Information

- Oscilloscope series (for example: DPO7000C or DSA/DPO/MSO7000C/D/DX series) and hardware options, if any.
- Software version number.
- Probes used.

### Application-specific Information

- Description of the problem such that technical support can duplicate the problem.
- If possible, save the oscilloscope and application setup files as `.set` and associated `.xml` files.
- If possible, save the waveform on which you are performing the measurement as a `.wfm` file.

Once you have gathered this information, you can contact technical support by phone or through e-mail. In the subject field, please indicate DDRA Problem and attach the `.set`, `.xml` and `.wfm` files to your e-mail. If there is any query related to the actual measurement results, then you can generate a `.mht` report and send it. If you need to send very large files, technical support can assist you to transfer the files via ftp (file transfer protocol).

The following items are important, but optional:

- Your name
- Your company
- Your mailing address

- Your phone number
- Your FAX number

Enter your suggestion. Please be as specific as possible.

Please indicate if you would like to be contacted by Tektronix regarding your suggestion or comments.



# Getting started

## Product description

DDR Analysis is a standard specific solution tool for Tektronix Performance Digital Oscilloscopes (DPO7000C or DSA/DPO/MSO7000C/D/DX series). DDR Analysis requires Jitter and Eye Diagram Analysis Tool (Opt.DJA) and the advanced Search and Mark capability (Opt. ASM).

The features of DDRA are:

- Provides debug, analysis, and compliance in one solution for multiple DDR standards such as DDR, DDR2, DDR3, DDR3L, DDR4, LPDDR, LPDDR2, LPDDR3, LPDDR4, GDDR3, and GDDR5.
- Identifies Read and/or Write operations automatically.
- Custom data rates and input levels to tailor DDRA Read and/or Write burst identification.
- Provides both single-ended and differential measurements on Data, Strobe, Clock, Address and Command signals.
- Analyze compliance measurements either through DDRA or Jitter and Eye Diagram Analysis Tool.
- Limit files to test measurement pass/fail status.
- Automatically applies signal slew rate derating of measurement limits for Address/Command and data signals.
- Preferences shortcut available for all DDRA steps. For more details, refer to the DPOJET online help.
- Logic state configuration using the DDRA user interface.

### DDR

DDR is the DRAM (Dynamic Random Access Memory) technology responsible for increasing data transfer rates to meet high-speed requirements and data capacity of computer systems.

### DDR2

DDR2 is the Double Data Rate 2 SDRAM and is widely available in products with data rates up to 1066MT/s.

### DDR3

DDR3 DRAM memory is widely available in products and extends data rates to 1600 MT/s and faster rates to come.

### DDR3L

DDR3L (low voltage) DRAM memory is widely available in products and extends data rates to 1600 MT/s and faster rates to come.

### DDR4

DDR4 DRAM memory is widely available in products and extends data rates to 3200 MT/s and faster rates to come.

### Low Power DDR

LPDDR (Low Power DDR) is an emerging technology for mobile phones and portable computing devices, driven by the need for faster operation with long battery life.

### Low Power DDR2

LPDDR (Low Power DDR) is an emerging technology for mobile phones and portable computing devices, driven by the need for faster operation with long battery life.

### **Low Power DDR3**

LPDDR3 (Low Power DDR3) is a technology for mobile phones and portable computing devices as it supports advanced power management. Includes a reduced interface voltage of 1.2 V from the 1.8 V specification as compared to LPDDR memory technology. This results in a power consumption reduced by over 50%.

### **Low Power DDR4**

LPDDR4 (Low Power DDR4) is an emerging technology for mobile phones and portable computing devices as it supports advanced power management. Includes a reduced interface voltage of 1.1 V from 1.8 V specification as compared to LPDDR memory technology.

### **Graphic DDR3**

GDDR3 (Graphic DDR) offers faster access and is used in graphics-intensive applications such as video cards and gaming systems.

### **GDDR5**

GDDR5 (Graphic DDR) is a type of high performance dynamic random-access graphics card memory designed for applications requiring high bandwidth.

## **DDRA prerequisites**

To use the DDRA application on instruments using 64-bit operating systems, you need DPOJET Advanced (Opt. DJA) enabled.

## **Requirements and restrictions**

DPOJET (DJA) is required to operate DDRA on your oscilloscope. Also refer to subsequent requirements for DPOJET.

## **Supported probes**

The application supports the following probes:

- TAP2500
- TAP1500
- TCP0030
- P6158
- P6101B
- P6246
- P6247 (DPO7254 only)
- P6248 (DPO7254 only)
- P6249
- P6150
- P6158
- P7240
- P7260
- P7330
- P7340A



- P7350
- P7360A
- P7380A
- P7313A
- P7513
- P7520A
- P7520
- P7500 Series TriMode

## Installing the application

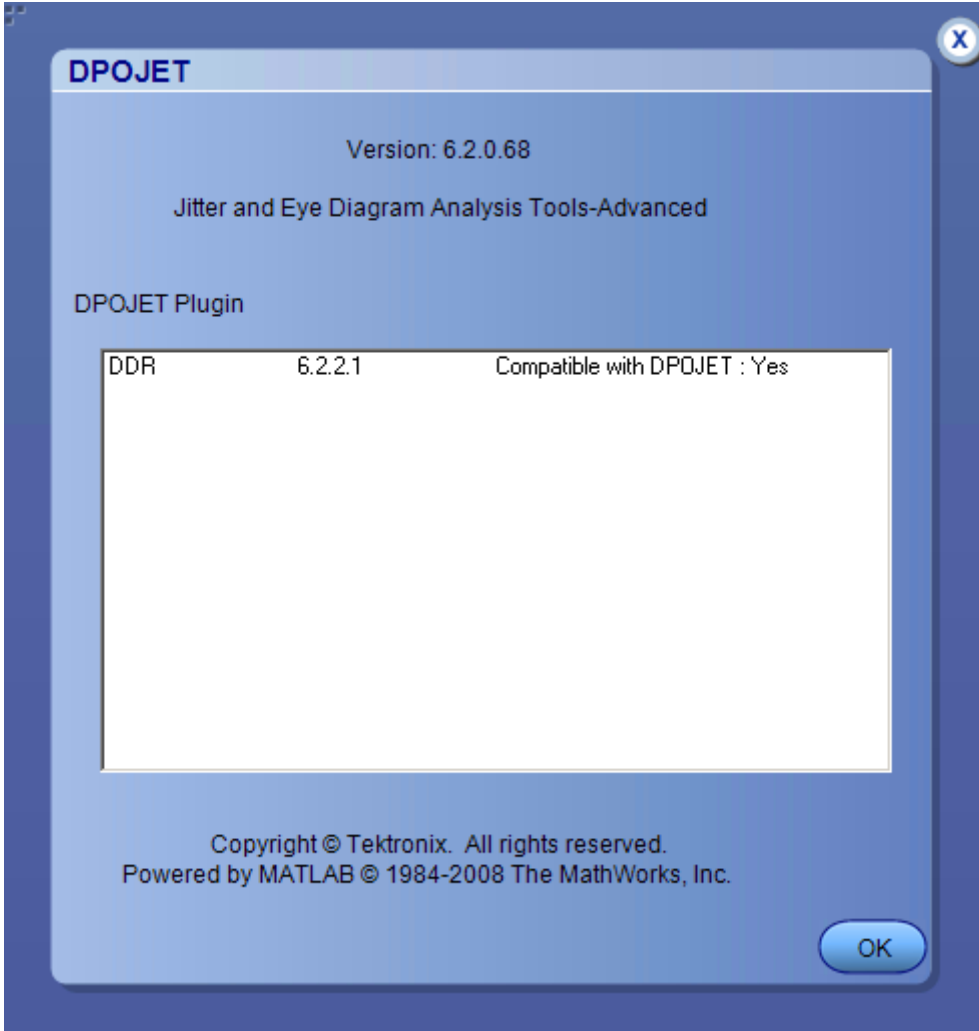
Refer to the *Optional Applications Software on Windows-Based Oscilloscopes Installation Manual* for the following information:

- Software warranty.
- List of available applications, compatible oscilloscopes, and relevant software and firmware version numbers.
- Applying a new option installation key label.
- Installing an application.
- Enabling an application.
- Downloading updates from the Tektronix Web site.

You can find a PDF (portable document format) file for this document in the Documents directory on the *Optional Applications Software on Windows-Based Oscilloscopes DVD*. The DVD booklet contains information on how to install the application from the DVD and on how to apply a new option installation key label.

## About DDRA

Click **Help > About DPOJET** to view DDRA application details such as the software released version number, application name and copyright.



---

**NOTE.** The version displayed above is indicative only, the version number displayed will vary depending upon the exact version of the application installed.

---

# Operating basics





## About basic operations

### Starting the application


On the oscilloscope menu bar, click **Analyze > DDR Analysis** to open the application.

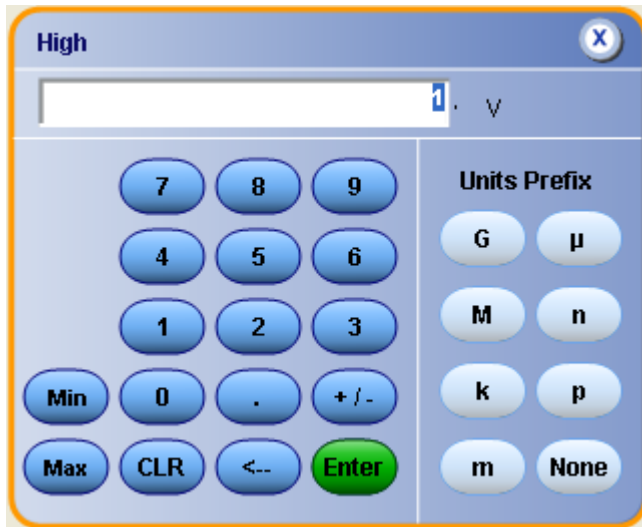
### Menu controls

**Table 3: Application Menu Controls descriptions**

Item	Description
Tab	Shortcut to a menu in the menu bar or a category of menu options; most tabs are short cuts.
Area	Visual frame with a set of related options.
Option button	Button that defines a particular command or task.
Field	Box that you can use to type in text, or to enter a value with the Keypad or a Multipurpose knob.
Check Boxes	Use to select configuration options or clear preferences.
Browse	Displays a window where you can look through a list of directories and files.
Command button	Button that initiates an immediate action such as Run command button  in the control panel.
Virtual Keypad icon 	Click to use on-screen keypad to enter alphanumeric values.
MP knob references (a or b)  	Identifiers that show which Multi Purpose Knob (MPK) may be used as an alternate means to control a parameter; turn the knob on the oscilloscope front panel to adjust the corresponding parameter. Also, the value can be entered directly on the MPK display component.





### Virtual keypad

Select the  icon and use the virtual keypad to enter alphanumeric values, such as reference voltage levels.



### Tips on the DDRA user interface

Here are some tips to help you with the application user interface:

- Use the Single button  to obtain a set of measurements from a single new waveform acquisition. Pushing the button again before process is completed will interrupt the processing cycle.
- Use the Run button  to continuously acquire and accumulate measurements. If prior measurements have been acquired and have not been cleared, the new measurement are added to the existing set. Push the button again to interrupt the current acquisition.
- Use the Recalc button  to perform measurements on the waveform currently displayed on the oscilloscope without performing a new acquisition. This is useful if you wish to modify a configuration parameter and re-run the measurements on the current waveform.
- Use the Clear button  to clear all existing measurement results. Note that adding or deleting a measurement, or changing a configuration parameter of an existing measurement, will also cause measurements to be cleared. This is to prevent the accumulation of measurement statistics or sets of statistics that are not coherent.

## Basic oscilloscope functions

### Application directories

The installation directory for DDRA executable files is `C:\TekApplications\DDRA` for oscilloscope running with Windows and `C:\Users\Public\Tektronix\TekApplications\DDRA` for oscilloscopes running with Windows7 operating system. During installation, the application sets up a limits folder in the user directory. This folder contains limit files for various DDR standards and speed grades.

For 64-bit systems, the DDRA installer copies the symbol files into the following location: `C:\Users\Public\Tektronix\TekScope\BusDecodeTables\DDR`. This is different from the default TekScope location at `C:\Users\[Username]\Tektronix\Tekscope\BusDecodeTables`.


### File name extensions

**Table 4: File name extensions**

File Extension	Description
.csv	An ascii file containing Comma Separated Values. This file format may be read by any ascii text editor (such as Notepad) or may be imported into spreadsheets such as Excel.
.xml	An ascii file containing measurement setup information, limits or other data in Extensible Markup Language.
.set	A binary file containing oscilloscope setup information in a proprietary format.
.mht	An HTML archive file, compatible with common Windows applications; contains the full report, including text and graphics.
.wfm	A binary file containing an oscilloscope waveform record in a recallable, proprietary format.
.tsf	A symbol file containing various symbols for various logic trigger patterns.
.chm, .pdf	Help manuals.

### Returning to the application

When you access oscilloscope functions, the DDRA control windows may be replaced by the oscilloscope control windows or by the oscilloscope graticule. You can access oscilloscope functions in the following ways:

- From the menu bar on the oscilloscope, choose **Analyze > DDR Analysis**.
- Alternatively, you can switch between recently used control panels using the forward or backward arrows  on the right corner of the control panel.

### Control panel

The Control Panel appears on the right of the application window. Using this panel, you can start or stop the sequence of processes for the application and the oscilloscope to acquire information from the waveform. The controls are Clear, Recalc, Single, and Run. The following table describes each of these controls:

Item	Description
Clear	Clears the current result display and resets any statistical results and autoset ref levels. For any input sources that have reference level autoset enabled, clears the current ref levels so that they will be recalculated during the next acquisition.
Recalc	Runs the selected measurements on the currently displayed waveform(s), without first performing a new acquisition.

Item	Description
Single	Initiates a single new acquisition and runs the selected measurements.
Run	Initiates new acquisitions and runs the selected measurements repeatedly until Stop is clicked. For any non-live sources (Reference waveforms or Math waveforms not dependent on a live channel), only a single processing cycle will occur.
Show Plots	Displays the plot summary window when clicked. This button appears in the control panel only when one or more plots have been defined.
Advanced Setup DPOJET	Transitions to the Jitter and Eye Diagram Analysis application when clicked, importing all currently defined DDRA measurements. This button appears in the control panel when you open the DDR analysis application. This is useful if you wish to add additional measurements not defined in DDRA, or wish to change measurement configurations to intentionally deviate from those recommended by DDRA.



## Saving and recalling setups

### Saving a setup

The DDRA application state is automatically saved along with the oscilloscope state. To save the oscilloscope settings and the application state, follow these steps:

1. Click **File > Save As > Setup**.
2. In the file browser, select the directory to save the setup file.
3. Select or enter a file name. The application appends \*\_DDRA.xml and \*\_DPOJET.xml to store the DDR setup, and \*.set to store the oscilloscope settings.
4. Click **Save**.

---

**NOTE.** After the oscilloscope application is started, DDRA needs to be launched at least once before any saved DDRA configuration can be recalled.

---

### Recalling a saved setup

To recall a previously saved set of application and oscilloscope settings, do the following steps:

---

**NOTE.** While recalling setup files with both DDRA and DPOJET saved settings, DDRA setup values get a higher precedence over DPOJET setup values. For example: Select a DPOJET measurement and a DDRA measurement, change the ref levels of DPOJET measurement and save the setup file. On recalling the setup file, you will see that the DPOJET ref level settings are overwritten by the DDRA measurement ref levels.

---

1. Click **File > Recall**.
2. Click **Setup** in the left column if it is not already selected.
3. Select the directory in the file browser from which you wish to recall the setup file.
4. Select a .set file and click **Recall**.

---

**NOTE.** Only .set files can be selected for recall; any corresponding \*\_DDRA.xml and \*\_DPOJET.xml file in the same directory will be recalled as well, if DDRA has been launched at least once since the oscilloscope application was started. If DDRA has not been launched at least once, the oscilloscope settings will be recalled but the DDRA configuration will be ignored.

---

## Recalling the default setup

To recall the default application and oscilloscope settings, click **File > Recall Default Setup**.

---

**NOTE.** Recalling default setup sets the DDRA application to DDR3 generation and data rate, None.

---

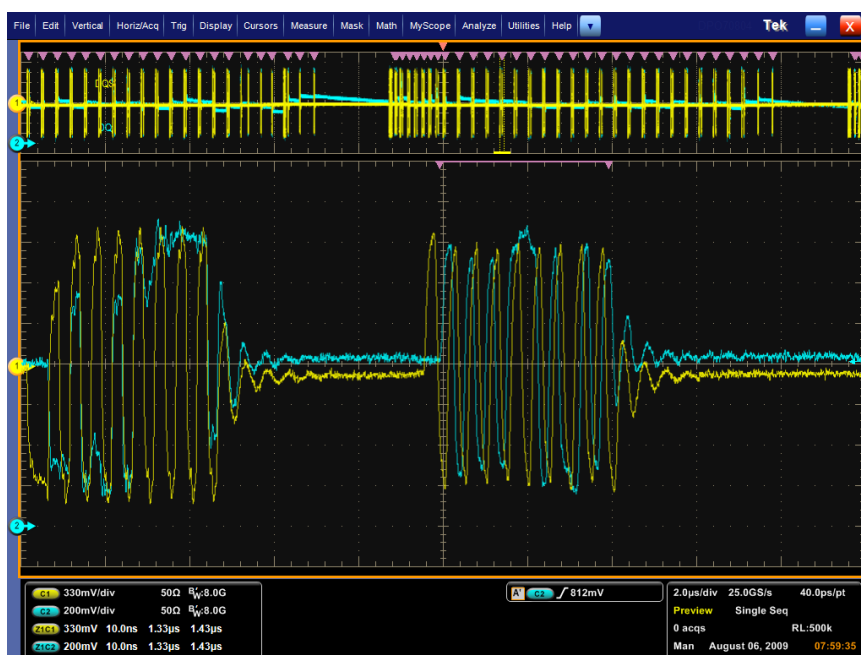
## Search and mark

The data rate, generation, and measurement type selected in DDRA are also set in Advanced Search and Mark (ASM). Marks are available only for Read and Write bursts measurement type. You can configure Search using **Advance > Search > Configure**. The identified bursts are shown as small inverted marks (■) in the oscilloscope display area. Each pair of marks specifies the start and stop of a burst. You can traverse from one mark to the other using the Mark Control window.

---

**NOTE.** LPDDR4 burst cannot be configured from ASM window.

---



## Limits

A limits file allows you to configure the limits used to determine Pass or Fail status for tests. Each limits file includes a list of one or more measurements, and the ranges of acceptable values for any or all statistics for each measurement that include combinations of all measurements and statistical characteristics, and an appropriate range of values for each combination.

The application provides preconfigured limits files for many combinations of standards and speed grades. You can create one by specifying limits for any of the result parameters such as Mean, Std Dev, Max, Min, peak-to-peak, population, MaxPosDelta and MinPosDelta. For each of these result parameters, you can specify the Upper Limit Equality (ULE), Lower Limit Equality (LLE), or Both. The measurement names in the limits file must be entered as mentioned in [About DDR Analysis](#).

To include Pass/Fail status in the result statistics, you can create a custom limits file in the following format using an XML editor or any other editor. If the file is created in any other editor such as Notepad, it should be saved in Unicode format.

The following is a sample of the limit file for DDR2 generation, the data rate being 667 MHz

```
<?xml version="1.0" encoding="utf-16" ?>
<Main>
<Measurement>
<NAME>DDR Ho1d-Di ff</NAME>
<STATS>
<STATS_NAME>Min</STATS_NAME>
<LIMIT>BOTH</LIMIT>
<ULE>175e-12</ULE>
<LLE>0</LLE>
</STATS>
<Measurement>
<NAME>tdH-Di ff(base)</NAME>
<STATS>
<STATS_NAME>Min</STATS_NAME>
<LIMIT>BOTH</LIMIT>
<ULE>175e-12</ULE>
<LLE>0</LLE>
</STATS>
</Measurement>
</Main>
```

You can find limit files for various data rates of different DDR standards and speed bins at C:\Users\Public\Tektronix\TekApplications\DDRA\Limits.

---

**NOTE.** Base limit values change based on the selected AC configuration at Step 6. For DDR3 1333 MT/s and 1600 MT/s, AC 150 ref level are applied independent of the specified AC config.

---

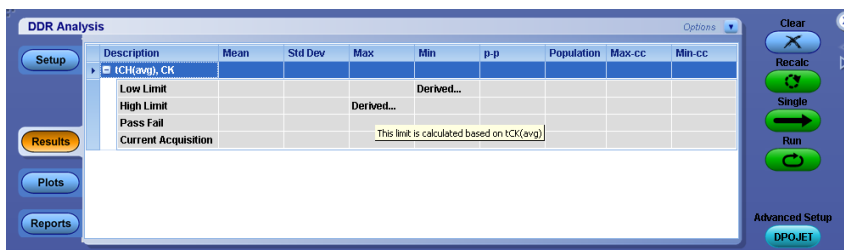


## Dynamic limits

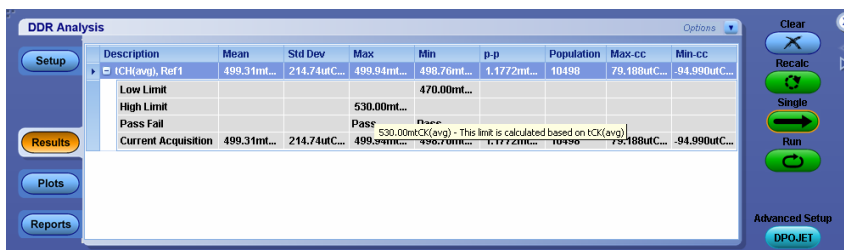
The application supports both static (predefined using limits file) and dynamic limits. Dynamic limits are available for DDRA clock and other measurement groups. They are calculated using the result of other measurement(s).

The concept of dynamic limits is explained taking an example of a measurement, tCH(avg):

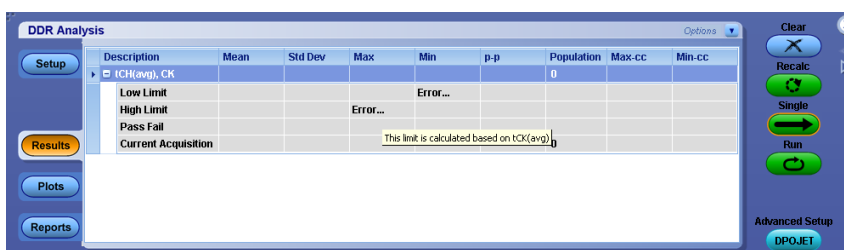
- If the dynamic limits of a measurement depend on the result of other measurement(s) that has not yet been calculated, the limit text field in the results panel shows Derived.... A tool tip displays the message This limit is calculated based on measurement tCK(avg).



- On clicking Run/Single, the results are shown in the following figure:



- If there is an error in calculating dynamic limits, the limit text field displays Error... as shown. A tool tip displays the message This limit is calculated based on measurement tCK(avg).



## References

[Dynamic Limits for LPDDR Measurements](#)

[Dynamic Limits for LPDDR2 Measurements](#)

[Dynamic Limits for LPDDR4 Measurements](#)

[Dynamic Limits for DDR Measurements](#)

[Dynamic Limits for DDR2 Measurements](#)

[Dynamic Limits for DDR3 Measurements](#)

## Setting up DDR for analysis

### DDR standards and their measurements

The following tables lists the measurements displayed for each DDR standard:

**NOTE.** For more details on the measurements, refer to the Algorithms section.

The clock measurements displayed for LPDDR and DDR standards are tCH, tCK, tHP, and tCL.

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
<b>Write Bursts</b>											
Data Eye Width	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
Data Eye Height	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
tWRSRE											✓
tWRPDE											✓
tDQS2DQ									✓		
tWPRE	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tWPST	✓	✓	✓	✓	✓	✓	✓	✓	✓		
DDRARXMask					✓				✓		
<b>Differential DQS</b>											
Input Slew-Diff-Fall(DQS)		✓	✓	✓			✓	✓	✓		
Input Slew-Diff-Rise(DQS)		✓	✓	✓			✓	✓	✓		
tDH-Diff(base)		✓	✓	✓		✓	✓				
tDH-Diff(derated)		✓	✓	✓			✓	✓			
tDH-Diff(Vref-based)							✓	✓			
tDQSH	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tDQSL	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tDS-Diff(base)		✓	✓	✓		✓	✓				
tDS-Diff(derated)		✓	✓	✓			✓	✓			
tDS-Diff(Vref-based)							✓	✓			

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
tDSS-Diff	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tDQSS-Diff		✓	✓	✓	✓						
tDSH-Diff	✓	✓	✓	✓	✓	✓	✓	✓	✓		
TdIPW-High					✓			✓	✓		
TdIPW-Low					✓			✓	✓		
VIHL-AC					✓				✓		
SRIN_dIVW_Rise					✓				✓		
SRIN_dIVW_Fall					✓				✓		
tDVAC(DQS)			✓	✓	✓		✓	✓			
Single Ended DQS											
Slew Rate-Hold-SE-Fall(DQS)		✓									
Slew Rate-Hold-SE-Rise(DQS)		✓									
Slew Rate-Setup-SE-Fall(DQS)		✓									
Slew Rate-Setup-SE-Rise(DQS)		✓									
tDH-SE(base)	✓	✓				✓					
tDH-SE(derated)		✓									
tDS-SE(base)	✓	✓				✓					
tDS-SE(derated)		✓									
tDIPW-SE	✓	✓	✓	✓		✓	✓				
tDQSS-SE		✓	✓	✓							
tDSH-SE	✓	✓	✓	✓		✓					
tDSS-SE	✓	✓	✓	✓		✓					
Slew Rate DQ											
Slew Rate-Hold-Fall(DQ)		✓	✓	✓			✓	✓			
Slew Rate-Hold-Rise(DQ)		✓	✓	✓			✓	✓			
Slew Rate-Setup-Fall(DQ)		✓	✓	✓			✓	✓			
Slew Rate-Setup-Rise(DQ)		✓	✓	✓			✓	✓			
tDQSS									✓		
RX Mask					✓						
Read Bursts											
Data Eye Width	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
Date Eye Height	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
tRDSRE											✓

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
tRDPDE											✓
tDQSCK		✓					✓	✓	✓		
tQW_Total									✓		
tQW_Total_DBI									✓		
tRPRE	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tRPST	✓	✓	✓	✓	✓	✓	✓	✓	✓		
<b>Differential DQS</b>											
tAC-Diff	✓	✓				✓					
tDQSCK-Diff	✓		✓	✓	✓	✓					
tDQSQ-Diff		✓	✓	✓	✓		✓	✓	✓		
tDQSQ-DBI									✓		
tDVAC(DQS)			✓	✓	✓		✓	✓			
tQH	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tQH_DBI									✓		
tQSL			✓	✓	✓		✓	✓	✓		
tQSL_DBI									✓		
tLZ(DQ)					✓		✓				
tHZ(DQ)					✓		✓				
tQSH			✓	✓	✓		✓	✓	✓		
tQSH_DBI									✓		
SRQdiff-Rise(DQS)			✓	✓	✓		✓	✓	✓		
SRQdiff-Fall(DQS)			✓	✓	✓		✓	✓	✓		
<b>Single Ended DQS</b>											
tDIPW-SE			✓								
tDQSS-SE			✓								
tDSH-SE			✓								
tDSS-SE			✓								
tDQSCK-SE		✓									
tDQSQ-SE	✓	✓				✓					
Vox(ac)DQS		✓									
tLZ(DQS)					✓		✓				
tHZ(DQS)					✓		✓				
<b>Slew Rate (DQ)</b>											
SRQse-Fall(DQ)			✓	✓	✓		✓	✓	✓		
SRQse-Rise(DQ)			✓	✓	✓		✓	✓	✓		
<b>Clock (Diff)</b>											
Clock Eye Height	✓	✓	✓	✓	✓	✓	✓	✓	✓		
Clock Eye Width	✓	✓	✓	✓	✓	✓	✓	✓	✓		

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
tCH(abs)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tCH(avg)		✓	✓	✓	✓		✓	✓	✓		
tCK(abs)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tCK(avg)		✓	✓	✓	✓		✓	✓	✓		
tCL(abs)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
tCL(avg)		✓	✓	✓	✓		✓	✓	✓		
tDVAC(CK)			✓	✓	✓		✓	✓			
tERR (Includes measurements from tERR2 to 49per)											
tERR(11–50per)		✓	✓	✓	✓		✓	✓			
tERR(2per)		✓	✓	✓	✓		✓	✓			
tERR(3per)		✓	✓	✓	✓		✓	✓			
tERR(4per)		✓	✓	✓	✓		✓	✓			
tERR(5per)		✓	✓	✓	✓		✓	✓			
tERR(6–10per)		✓	✓	✓	✓		✓	✓			
tJIT(cc)		✓	✓	✓	✓		✓	✓	✓		✓
tJIT(duty)		✓	✓	✓	✓		✓	✓	✓		✓
tJIT(per)		✓	✓	✓	✓		✓	✓	✓		
tHP	✓	✓				✓	✓				✓
VID(ac)	✓	✓				✓					
Input Slew-Diff- Rise(CK)		✓	✓		✓		✓	✓	✓		
Input Slew-Diff- Fall(CK)		✓	✓		✓		✓	✓	✓		
tDVAC(CK)					✓			✓			✓
tCK											✓
tCH											✓
tCL											✓
SSC Downspread (CK)											✓
SSC Mod Freq (CK)											✓
<b>Clock (Single Ended)</b>											
AC- Overshoot(CK#)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC- Overshoot(CK)	✓	✓	✓	✓	✓	✓	✓	✓	✓		

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
ACOvershootArea(CK#)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
ACOvershootArea(CK)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-Undershoot(CK#)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-Undershoot(CK)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-UndershootArea(CK#)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-UndershootArea(CK)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
VIXCA							✓				
Vix(ac)CK	✓	✓	✓	✓	✓	✓		✓	✓		✓
Vox(ac)CK		✓									
VSWING(MAX)CK		✓									
VSWING(MAX)CK#		✓									
VSEH(AC)CK			✓	✓			✓	✓			
VSEH(AC)CK#			✓	✓			✓	✓			
VSEH(CK#)			✓	✓	✓				✓		
VSEH(CK)			✓	✓	✓				✓		
VSEL(AC)CK			✓	✓			✓	✓			
VSEL(AC)CK#			✓	✓			✓	✓			
VSEL(CK#)			✓	✓	✓				✓		
VSEL(CK)			✓	✓	✓				✓		
VIN(CK)											✓
VIN(CK#)											✓
CKSlew-Rise(CK)											✓
CKSlew-Rise(CK#)											✓
CKSlew-Fall(CK)											✓
CKSlew-Fall(CK#)											✓
<b>DQS (Single Ended, Write)</b>											
AC-Overshoot(DQ)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-Undershoot(DQ)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-Overshoot(DQS#)	✓	✓	✓	✓	✓		✓	✓	✓		

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
AC-Overshoot(DQS)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-OvershootArea(DQ)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-UndershootArea(DQ)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-OvershootArea(DQS#)	✓	✓	✓	✓	✓		✓	✓	✓		
AC-OvershootArea(DQS)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-Undershoot(DQS#)	✓	✓	✓	✓	✓		✓	✓	✓		
AC-Undershoot(DQS)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-UndershootArea(DQS)	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-UndershootArea(DQS#)	✓	✓	✓	✓	✓		✓	✓	✓		
Vix(ac)DQS			✓	✓	✓			✓	✓		
VIXDQ							✓				
VSWING(MAX)DQS		✓									
VSWING(MAX)DQS#		✓									
VSEH(AC)DQS							✓	✓	✓		
VSEH(AC)DQS#							✓	✓	✓		
VSEH(DQS#)			✓	✓	✓						
VSEH(DQS)			✓	✓	✓						
VSEL(AC)DQS							✓	✓	✓		
VSEL(AC)DQS#							✓	✓	✓		
VSEL(DQS#)			✓	✓	✓						
VSEL(DQS)			✓	✓	✓						
<b>DQS (Single Ended, Read)</b>											
AC-OvershootArea(DQ)	✓	✓	✓	✓		✓	✓	✓	✓		

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
AC-UndershootArea(DQ)	✓	✓	✓	✓		✓	✓	✓	✓		
AC-Overshoot(DQ)	✓	✓	✓	✓		✓	✓	✓	✓		
AC-Undershoot(DQ)	✓	✓	✓	✓		✓	✓	✓	✓		
AC-OvershootArea(DQS)	✓	✓	✓	✓		✓	✓	✓	✓		
AC-UndershootArea(DQS)	✓	✓	✓	✓		✓	✓	✓	✓		
AC-Overshoot(DQS)	✓	✓	✓	✓		✓	✓	✓	✓		
AC-Undershoot(DQS)	✓	✓	✓	✓		✓	✓	✓	✓		
AC-OvershootArea(DQS#)	✓	✓	✓	✓			✓	✓	✓		
AC-UndershootArea(DQS#)	✓	✓	✓	✓			✓	✓	✓		
AC-Overshoot(DQS#)	✓	✓	✓	✓			✓	✓	✓		
AC-Undershoot(DQS#)	✓	✓	✓	✓			✓	✓	✓		
Vox(ac)DQS		✓									
VESH(AC)DQS											
VESH(AC)DQS#											
VESH(DQS#)			✓								
VSEH(DQS)			✓								
VSEK(AC)DQS			✓								
VSEL(AC)DQS											
VSEL(AC)DQS#											
VSEL(DQS#)			✓								
VSEL(DQS)			✓								
<b>Address/Command</b>											
AC-Overshoot	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-OvershootArea	✓	✓	✓	✓	✓	✓	✓	✓	✓		
AC-Undershoot	✓	✓	✓	✓	✓	✓	✓	✓	✓		



Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
AC-UndershootArea	✓	✓	✓	✓	✓	✓	✓	✓	✓		
DDRARXMask									✓		
SRIN_cIVW_Fall									✓		
SRIN_cIVW_Rise									✓		
VIHL_AC(CA)									✓		
InputSlew-Diff-Fall(CK)		✓					✓	✓			
InputSlew-Diff-Rise(CK)		✓					✓	✓			
Slew Rate-Hold-Fall(Addr/Cmd)		✓	✓	✓			✓	✓			
Slew Rate-Hold-Rise(Addr/Cmd)		✓	✓	✓			✓	✓			
Slew Rate-Setup-Fall(Addr/Cmd)		✓	✓	✓			✓	✓			
Slew Rate-Setup-Rise(Addr/Cmd)		✓	✓	✓			✓	✓			
tIH(base)	✓	✓	✓	✓		✓	✓				
tIH(base)CA								✓			
tIH(base)CS								✓			
tIH(derated)CA								✓			
tIH(derated)CS								✓			
tIPW-High(CA)								✓			
tIPW-High(CS)								✓			
tIPW-Low(CA)								✓			
tIPW-Low(CS)								✓			
tIS(base)CA								✓			
tIS(base)CS								✓			
tIS(derated)CA								✓			
tIS(derated)CS								✓			
tIS(base)	✓	✓	✓	✓		✓	✓				
tIS(derated)		✓	✓	✓			✓				
tIS(Vref-based)							✓				
tIH(Vref-based)							✓				
tIH(derated)		✓	✓	✓			✓				
tIPW-High	✓	✓	✓	✓	✓	✓	✓				
tIPW-Low	✓	✓	✓	✓	✓	✓	✓				
tDIPW											✓
tCMDS											✓

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
tCMDH											✓
tCHDPW											✓
tAS											✓
tAH											✓
tAPW											✓
TCIPW-High									✓		
TCIPW-Low									✓		
<b>WCK (Differential)</b>											
tWCK-Rise-Slew											✓
tWCK-Fall-Slew											✓
tWCK-TJ											✓
tWCK-DJ											✓
tWCK-RJ											✓
VWCK-Swing											✓
tDVAC(WCK)											✓
tJIT(cc)											✓
tJIT(per)											✓
tWCK											✓
tWCKH											✓
tWCKL											✓
tWCKHP											✓
SSC Downspread (WCK)											✓
SSC Mod Freq (WCK)											✓
SSC Profile(WCK)											✓
<b>WCK (Single Ended)</b>											
VIN(WCK)											✓
VIN(WCK#)											✓
VIX(AC)WCK											✓
VOL(WCK)											✓
VOH(WCK)											✓
VOL(WCK#)											✓
VOH(WCK#)											✓
WCKSlew-Rise(WCK)											✓
WCKSlew-Rise(WCK#)											✓
WCKSlew-Fall(WCK)											✓

Measurements	DDR	DDR2	DDR3	DDR3L	DDR4	LPDDR	LPDDR2	LPDDR3	LPDDR4	GDDR3	GDDR5
WCKSlew-Fall(WCK#)											✓
<b>Refresh</b>											
tCKSRE											✓
tCKSRX											✓
tRFC											✓
tXSNRW											✓
tREFTR(Write)											✓
tREFTR(Read)											✓
<b>Power Down</b>											
tPD											✓
<b>Active</b>											
tRC											✓
tRAS											✓
tRCDRD											✓
tRCDWR											✓
<b>Precharge</b>											
tPPD											✓
tRP							✓				
tRP(ACT)			✓							✓	✓
tRP(MRS)		✓	✓								✓
tRP(REF)		✓									✓
tRP(SRE)											✓
tRTPL											✓

**NOTE.** The clock measurements displayed for LPDDR and DDR standards are *tCH*, *tCH*, *tHP*, and *tCL*.

When you select GDDR3 as the standard, the application displays a message: GDDR3 not completely supported.

## Derating

Signal slew rate derating is required to verify the setup and hold timing requirements on address/command and data signals. The base setup and hold limits are defined using input signals that have a 1.0 V/ns slew rate. To determine final pass/fail status, the limits must be adjusted based on the actual slew rates of the target signals, according to derating tables appearing in the DDR2 and DDR3 specifications.

DDR2 derated measurements for data signals are as follows:

- tDS-SE(derated)
- tDH-SE(derated)
- tDS-Diff(derated)
- tDH-Diff(derated)

DDR3 derated measurements are as follows:

- tDS-Diff(derated)
- tDH-Diff(derated)

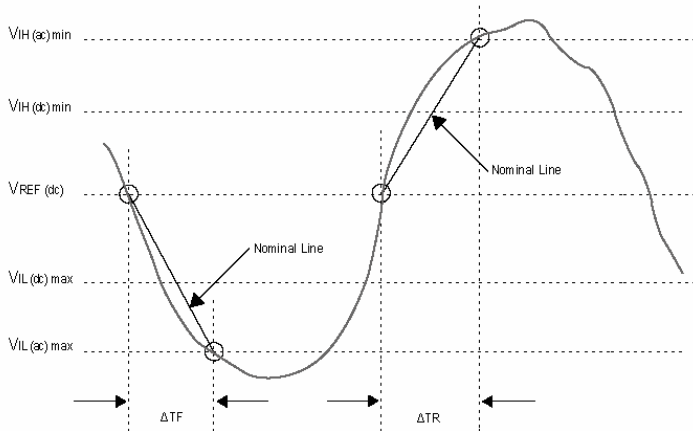
The DDR2/DDR3 Address/Command derated measurements are as follows:

- tIH(derated)
- tIS(derated)

The derated value ( $\Delta$ ) is calculated as per the JEDEC standard using either the DDR Method or Nominal Method, depending on the user configuration.

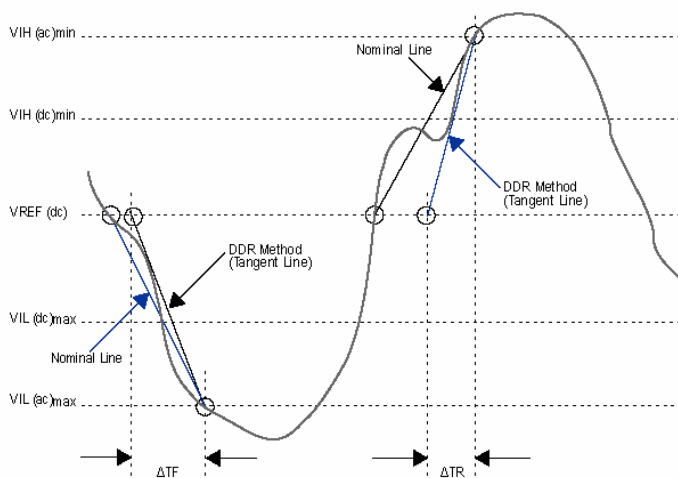
Derating is explained taking an example of Setup(tIS) measurement. The same concept is applicable for other derated measurements.

When the nominal method is set, Setup(tIS) nominal slew rate for a rising signal is defined as the slew rate between the last crossing of  $V_{REF(dc)}$  and the first crossing of  $V_{IH(ac)min}$ . Setup (tIS) nominal slew rate for a falling signal is defined as the slew rate between the last crossing of  $V_{REF(dc)}$  and the first crossing of  $V_{IL(ac)max}$ .



+

If the DDR Method is set, the application takes the maximum slope. This method is applicable if the actual signal is earlier than the nominal slew rate line.



According to the specified reference levels, rise slew rate is always positive whereas fall slew rate is negative. A single slew rate value is obtained by averaging the absolute values of rise and fall slew rate. Using this value and a similarly-derived slew rate for the clock signal, the total setup time (tIS) is calculated by adding  $\Delta tIS$  to the tIS(base)limit from the following table:

**Table 5: Address/Command Setup and Hold Values**

Units(ps)	DDR3–800	DDR3–1066	DDR3–1333	DDR3–1600	Units
tIS(base) AC 175	200	125	65	45	ps
tIS(base) AC150	350	275	190	170	ps
tIH(base)	275	200	140	120	ps

**NOTE.** For DDR3 speeds 1333 and 1600 MT/s, the AC 150 reference levels are applied, though the default selection in the Step 6 is AC175.

$\Delta tIS$  is determined using the derating table (AC 175), where the Y-axis represents the Address/Command slew rate and the X-axis, the clock differential value. By indexing the Address/Command value and Clock differential value,  $\Delta tIS$  value is obtained from AC175 table.

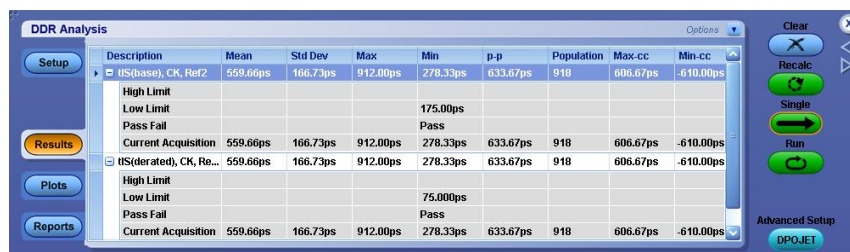
The calculated slew rate is approximated to the derating table specified value (Example: 0.4 V/ns  $\approx$  1.0V/ns). For values greater than 4.0 V/ns, the table returns the base limit value.

For example: For a Clock differential value= 1.0 V/ns, Address/Command Slew Rate =1.0 V/ns, and AC 175 Threshold selected in Step 6, the resulting derated values are:

$$tIS_{\text{deratedlimit}} = tIS(\text{base})_{\text{limit}} + \Delta tIS.$$

$$tIS_{\text{deratedlimit}} = 200 + 40 = 240$$

The result statistics of the both tIS(base) and tIS(derated) are the same as shown in the following figure. In case of derating, the limit values get changed depending on the signal slew rate.



**Reference.**

[DDR3 Measurement Sources](#)

[DDR2 Measurement Sources](#)

## About DDR analysis

The DDR Analysis window allows you to select various standards, set up and run a pre-configured measurement either through the DDRA or the DPOJET application.

Select **Analyze > DDR Analysis** to open the DDRA application.

The setup panel in the DDR Analysis application includes the following steps:

[Generation, Rate and Levels](#)

[Interposer Filter](#)

[Measurements and Sources](#)

[Burst Detection Method](#)

[Burst Detection Settings](#)

[Thresholds and Scaling](#)

---

**NOTE.** You can use the Next/Prev buttons or click directly on the step numbers to traverse through the steps in the DDR Analysis. The steps for which configuration is complete are denoted .

---


The setup panel displays hints to help you understand the configuration options wherever applicable.

You can run a set of measurement in either of the two ways:

- Click **Run** to start the acquisition sequence using the selected settings and to view the results in the DDRA window. This is the normal way to generate results.

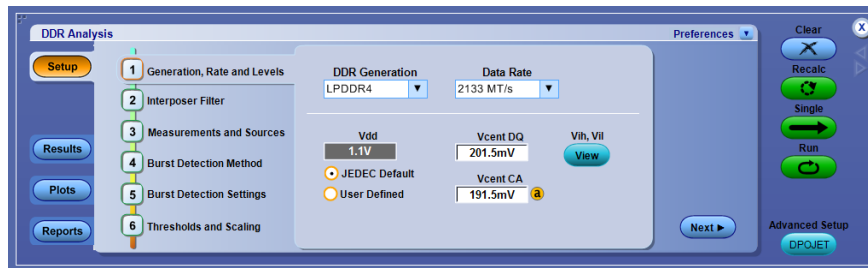


Click  to move to the DPOJET application, where you can add or modify measurements before

sequencing. For more details, refer to the DPOJET Online Help. You need to click  in the DPOJET application to return to the DDRA window. Alternatively, you can reselect **Analyze >DDR Analysis** from the menu bar.

### Step 1: Generation rate and levels

Select the DDR generation, data rate and the voltage levels (if required). There are different *speed bins* for each standard data rate for specific DDR generations.



- Select the DDR Generation from the drop-down list.
- Select the Data Rate from the drop-down list. On selecting Custom, an edit box allows you to enter the value using the virtual keypad. Limit files are not defined for custom data rates for Pass/Fail status and as a result, the application displays a hint at the bottom of the screen Please provide a limits file under Jitter and Eye Analysis > Limits. Note that selecting non-standard data rates in ASM (under Search > DDR Read or DDR Write), changes the data rate to None in DDRA.

3. Set the voltage levels:

- If you select JEDEC Defaults, the application uses the nominal voltage levels according to the JEDEC specification. The Vdd field is not editable.
- If you select User Defined, enter the Vdd or Vref voltage values using the virtual keypad.

**NOTE.** The Vcent DQ and Vcent CA voltage values are only available for LPDDR4. For DDR4 and LPDDR4, the external Vref is not available. Vcent is similar to the traditional Vref parameter but takes into account the fact that the actual reference voltage used inside the DRAM is adjusted during write training and is not physically visible at the balls of the DRAM.

4. (Optional) Click **View** to view the Vih and Vil values calculated automatically based on the Vref value. To manually adjust the reference levels, go to [Step6](#) of DDRA or use the DPOJET source configuration panel.

**Vdd**  
Is the supply voltage for each DDR standard. Vdd is based on DDR generation.

**Vref**  
Is the reference voltage for each DDR standard. Vref is calculated using Vdd, which in turn is based on DDR generation. In most cases, Vref=0.5Vdd.

**VcentDQ**  
VcentDQ is the voltage at which the cumulative eye of the pin DQx is widest.

**VcentCA**  
VcentCA is the voltage at which the cumulative eye of the pin CAx is widest.

The following table lists the minimum and maximum values of Vdd, Vref, VcentDQ, and VcentCA in the **User Defined** mode for all DDR generations:

DDR Generations	Vdd			Vref			VcentDQ			VcentCA		
	Default	Min	Max	Default	Min	Max	Default	Min	Max	Default	Min	Max
DDR <sup>1</sup>	2.5 V	-6 V	6 V	1.25 V	-6 V	6 V	NA	NA	NA	NA	NA	NA
DDR2	1.8 V	-6 V	6 V	900 mV	-6 V	6 V	NA	NA	NA	NA	NA	NA
DDR3	1.5 V	-6 V	6 V	750 mV	-6 V	6 V	NA	NA	NA	NA	NA	NA
DDR3L	1.35 V	-6 V	6 V	675 mV	-6 V	6 V	NA	NA	NA	NA	NA	NA
DDR4	1.2 V	-6 V	6 V	NA	NA	NA	850mV	-2 V	2 V	600mV	-2 V	2 V
LPDDR	1.8 V	-6 V	6 V	900 mV	-6 V	6 V	NA	NA	NA	NA	NA	NA
LPDDR2	1.2 V	-6 V	6 V	600 mV	-6 V	6 V	NA	NA	NA	NA	NA	NA
LPDDR3	1.2 V	-6 V	6 V	600 mV	-6 V	6 V	NA	NA	NA	NA	NA	NA
GDDR3	1.8 V	-6 V	6 V	900 mV	-6 V	6 V	NA	NA	NA	NA	NA	NA
GDDR5	1.5 V	-6 V	6 V	750 mV	-6 V	6 V	NA	NA	NA	NA	NA	NA
LPDDR4	1.1V	-6 V	6 V	NA	NA	NA	201.5 mV	-1 V	1 V	191.5 mV	-1 V	1 V

<sup>1</sup> DDR 400 MT/s has Vdd value set to 2.6 V and Vref Value set to 1.3 V.

**Vdd and Vref.** The configured values of Vdd and Vref are used to calculate  $V_{IH(ac)min}$ ,  $V_{IH(dc)min}$ ,  $V_{IL(dc)max}$  and  $V_{IL(ac)max}$ , which are applied on the input signal. These levels are further used for calculating Setup and Hold measurements.

For DDR2, the relationship between Vdd and Vref is as shown in the following tables:

**Table 6: Input DC logic Level**

Symbol	Parameter	Min	Max	Units
$V_{IH(dc)}$	DC input logic high	$V_{ref}+0.125$	NA	V
$V_{IL(dc)}$	DC input logic low	-0.3	$V_{ref}-0.125$	V

**Table 7: Input AC logic Level**

Symbol	Parameter	DDR2-400, DDR2-533		DDR2-667,DDR2-800		Units
		Min	Max	Min	Max	
$V_{IH(ac)}$	AC input logic high	$V_{ref}+0.250$	NA	$V_{ref}+0.200$	NA	V
$V_{IL(ac)}$	AC input logic low	NA	$V_{ref}-0.250$	-	$V_{ref}+0.200$	V

---

**NOTE.** Similar reference voltage levels are defined for DDR3 standard.

---



**Speed Bins.** For each DDR standard, the DDRA application automatically applies limits appropriate for the standard data rates without speed bins. Limit values are different for different speed bins. If you want to test according to a speed bin, you must manually configure the limit values from within DPOJET by manually overriding the limit file before running the measurements.

For more details, refer to Limits in the DPOJET help.

The following table lists the speed bins available for which pre-configured limit files are provided:

DDR Generation	Speed bins
DDR-400	400A, 400B and 400C
<b>DDR2</b>	
DDR2-667	800C and 800D
DDR2-800	800C, 800D and 800E
<b>DDR3</b>	
DDR3-800	800D and 800E
DDR3-1066	1066E, 1066F and 1066G
DDR3-1333	1333F <sup>2</sup> , 1333G, 1333H and 1333J <sup>2</sup>
DDR3-1600	1600G <sup>3</sup> , 1600H, 1600J and 1600K <sup>3</sup>

**NOTE.** You can find limit files for various speed bins at . You need to manually select these limit files by clicking .

#### Vih

Is the input logic HIGH voltage.

#### Vil

Is the input logic LOW voltage.

## Step 2: Interposer filter

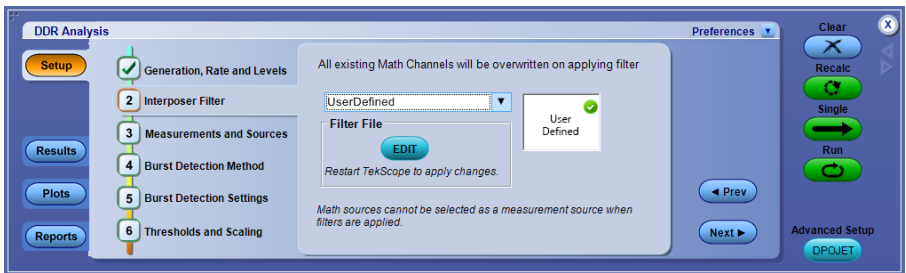
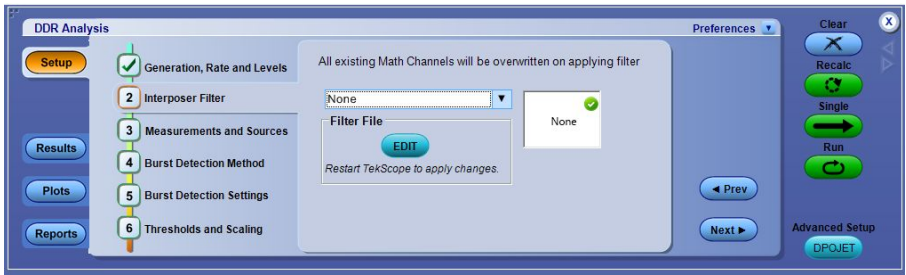
Allows you to select and apply interposer type for each of the sources. Filter.xml file is available at C:\Users\Public\Filters. This file can be edited to add different interposer types. The absolute filter path for each source can be specified. You can specify filter files either for all the available sources or only to a subset of sources

When interposer filters are applied, MATH cannot be used as the measurement source in Step 3. The filter file will be applied when the scope acquisition sample rate is supported in the filter file..

**NOTE.** The fields and options on the Interposer filter panel will populate based on the type of generation selected.

<sup>2</sup> 1333F and 1333J are optional

<sup>3</sup> 1600G and 1600K are optional



### Filter types

- **None:** Select if you do not want to apply filter files. This option is selected by default.
- **Direct Attached:** Select to attach pre-defined filter files.
- **User Defined:** Select to define pre-defined filter files. If you do not define at least one filter for a source, then, after clicking OK, the Interposer selection becomes None.

---

**NOTE.** Interposer types such as None, Direct Attached and User Defined are embedded in the application.

---


You can add additional filter files by adding the filter file name to the Filter.xml file. Once you update the XML file, restart the Tekscope to apply the changes. The names you added are now referenced in the **Interposer** filter type drop-down list.

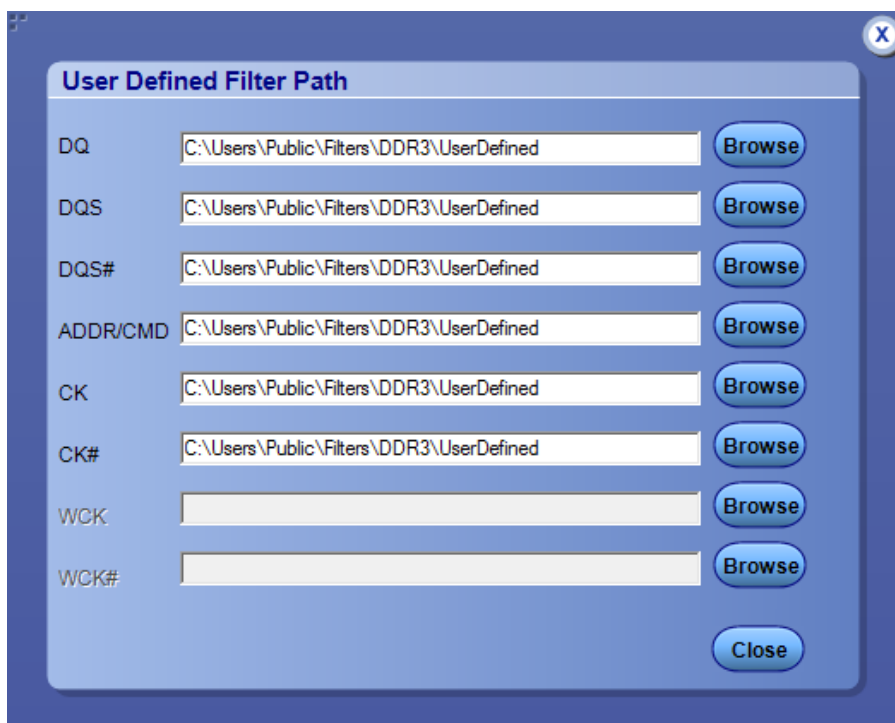
---

**NOTE.** If filter files do not exist or there is any typo in entering the path, the application displays a message as Filter File does not exist for <source name> in the path specified. The list of sources for which the filter files are not found will be listed.

---

**Edit** button: Opens the Filter.xml file for editing.

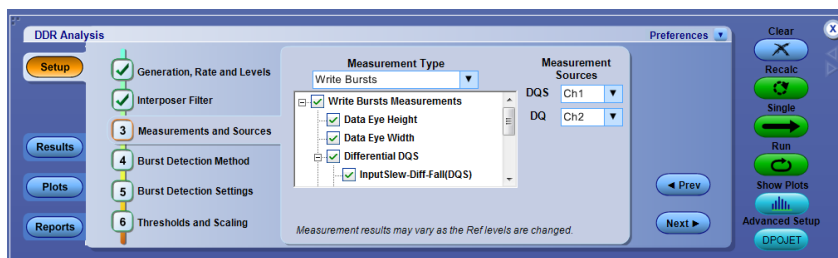
When you select User Defined from the drop-down list, User Defined text is auto populated on the  image box. Click on the image box to view the User Defined Filter Path dialog box, and then select different filter files for each source.



**NOTE.** The source displayed in User Defined Filter Path dialog box shall be enabled or disabled based on generation. For example, the source DQ, DQS shall remain disabled for GDDR5 and WCK shall be disabled for DDR3, DDR3L, DDR4, LPDDR3 and LPDDR4. You can select filter files either for all the available sources or only a subset of sources. The Filters.xml file is located at C:\Users\Public\Filters folder. The filter file can be modified outside the application as well.

### Step 3: Measurements and sources

Select measurements and their corresponding [sources](#) in this step. Measurement availability depends on the selected DDR standard. Select the **Measurement Type** (Read Bursts, Write Bursts, Clock(Diff), Clock(Single Ended), Address/Command, Address/Command, DQS(Single Ended), WCK(Single Ended), WCK(Diff), Refresh, Power Down, Active, or Precharge) from the drop-down list. WCK(Single Ended), WCK(Diff), Refresh, Power Down, Active, or Precharge are only available for GDDR5. Power Down, Active, and Precharge are only available 64-bit instruments. A message prompts you to select one or more measurements before moving to the next step.



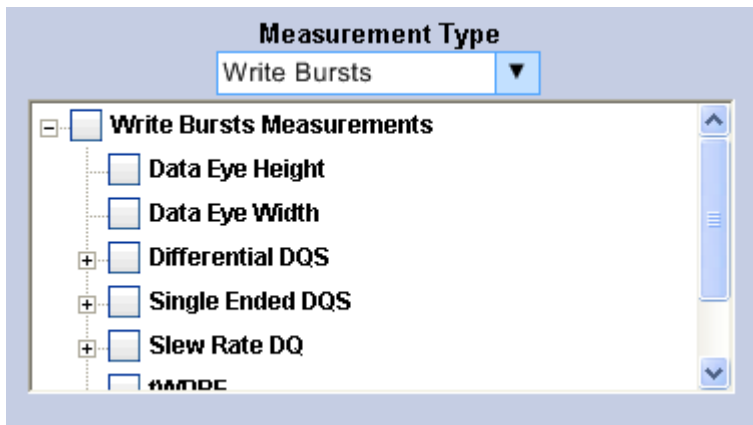
**Measurement Type Reference Levels.** The voltage reference levels for each measurement are automatically set to be consistent with JEDEC guidelines unless they are manually overridden. In cases where none of the chosen measurements have any applicable guidelines or manually set levels, DDRA will automatically choose reference levels based on the signal's maximum and minimum levels. DDRA displays a hint if both Single Ended DQS and Differential DQS measurements are selected at the same time, and measurements made with this configuration may not be accurate due to conflicting ref level requirements. When two or more measurements are selected in different sub-node categories under a Measurement Type, the following precedence is set for measurement ref levels:

- Slew Rate ref levels
- Single Ended specific ref levels
- Differential specific ref levels

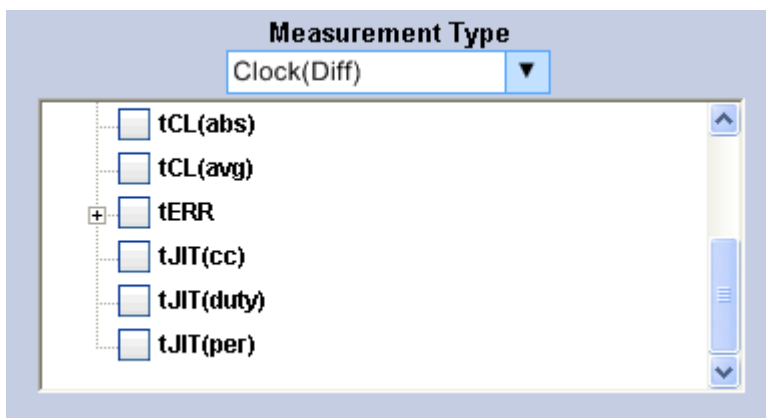
For Example: When Eye Width measurement is selected along with Differential DQS or Single Ended DQS or Slew Rate measurements, Eye measurement may not produce the expected results. This is because the actual mid level needed by Eye Width gets overwritten with SE levels and hence produces no results.

**Tree Structure Flow.** The measurement tree structure is as follows:

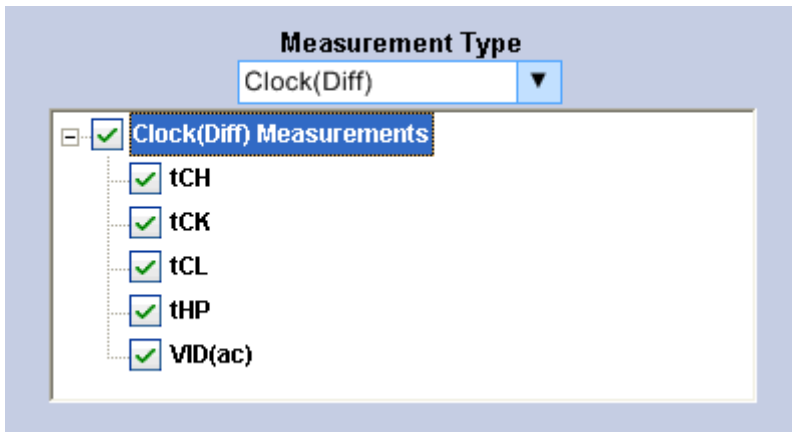
- The tree structure displays only those measurements appropriate for the selected measurement type.



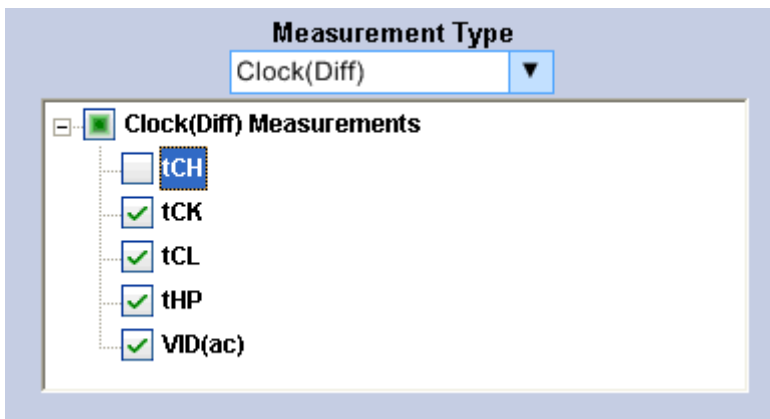
- All generations except GDDR3 display both parent and nested elements under measurement type (such as tERR) as shown:



- Click + to expand and show the elements within the parent element.
- Click - to collapse and hide the elements within the parent element.
- Selecting the parent check box, selects all the children elements. Selecting all the children elements, selects the parent element.

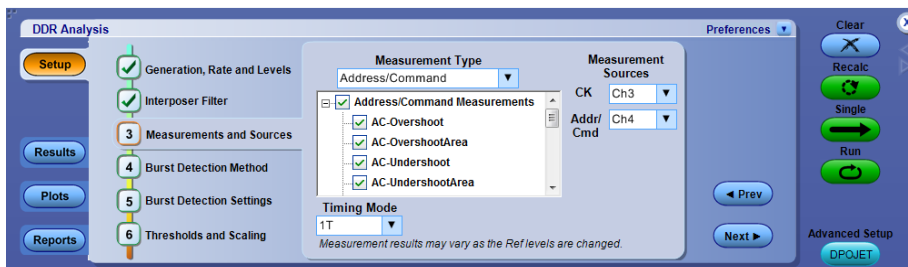


- Clearing the parent check box clears all the children elements.
- When the children include both checked and unchecked elements, the parent element becomes highlighted as shown:

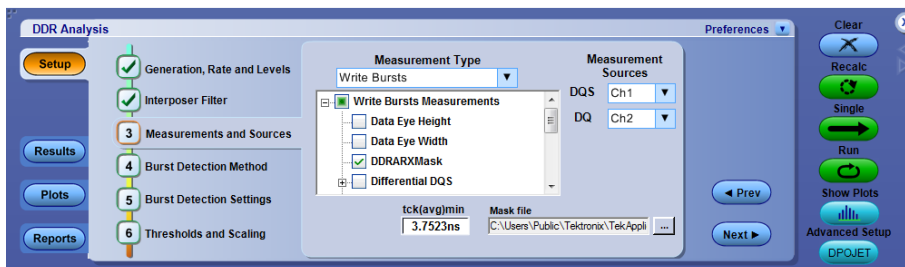


**NOTE.** If you move to the next step without selecting any measurements, the application displays the message *Please select measurements in Step3.*

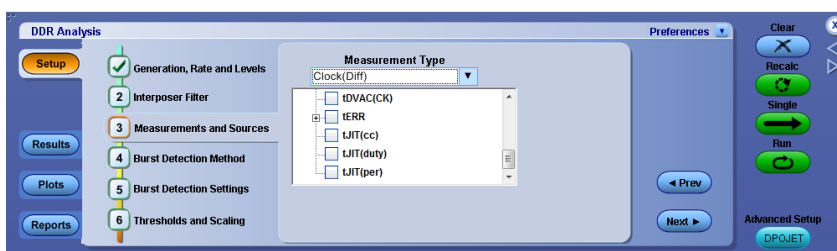
**Timing Mode.** When you select any measurement from the Address/Command group, the Timing Mode drop-down field is populated. Select either 1T or 2T depending on memory mode in which they are operating. This field is applicable for DDR3, DDR3L, and DDR4 generations. Selecting 1T and 2T timing is mandatory for Address/Command setup and hold measurements.



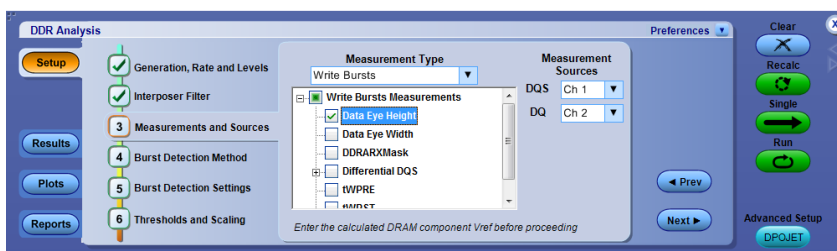
**Mask Margin Measurement.** You can specify a custom mask file using the **Mask file** control. The Mask file control allows you to change mask width, mask height, and mask position. When Mask margin measurement is selected, the application will update the default mask file depending on the data rate selected. You should not modify the default mask files.



**Timing error (tERR) measurements.** Timing error measurements such as tERR(2per), tERR(3per) until tERR(50per) are grouped together and included as a nested element (tERR) under the parent element, Clock(Diff)measurements. Selecting tERR selects all the timing error measurements.



**Sources.** Select a measurement to view the sources available for the measurement. The sources are mutually exclusive. For each required signal, select the appropriate source. A tool tip displays the required sources for the selected measurement at the nodes of the measurement tree. A maximum of four analog sources are available at a time.



**NOTE.** If the same channels are used for DQ/DQS/Clock sources (Example: DQ=Ch1, DQS=Ch1), the application displays a hint *Cannot use the same waveform for different sources*. If Live and Ref channels are used together (Example: Ch1 for DQS and Ref2 for DQ), the application displays a hint *Cannot use Live and Ref waveforms together*.

**Reference.**

[Hints](#)

[LPDDR Measurement Sources](#)

[LPDDR2 Measurement Sources](#)

[LPDDR3 Measurement Sources](#)

[LPDDR4 Measurement Sources](#)

[DDR Measurement Sources](#)

[DDR2 Measurement Sources](#)

[DDR3 Measurement Sources](#)

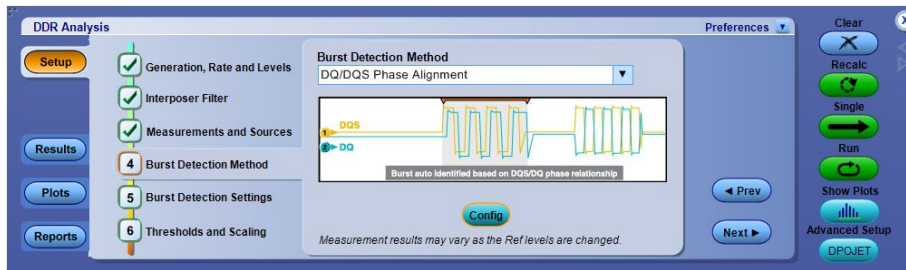
[DDR3L Measurement Sources](#)

[DDR4 Measurement Sources](#)

[GDDR5 Measurement Sources](#)

**Step 4: Burst detection method**

Burst Detection is based on the measurement type and generation, and is applicable only for Write Bursts, Read Bursts, DQS(Single Ended, Read) and DQS(Single Ended) measurement types.



The application supports the following burst detection methods for DPO/DSA/MSO oscilloscopes:

- [DQ/DQS Phase Alignment](#)
- [Chip Select, Latency + DQ/DQS Phase Alignment](#)
- [Logic State + Burst Latency](#) (Available only for MSO series of oscilloscopes)
- [Visual Search](#)
- Preamble Pattern Matching
- Amplitude Based

---

**NOTE.** The Preamble Pattern Matching and Amplitude Based detection methods are applicable only to LPDDR4.

---

**Config button**

Click the **Config** button to select Preamble Pattern Matching and Amplitude Based burst identification method. The fields on the Configuration panel are populated based on the measurement type selected in Step 3.

---

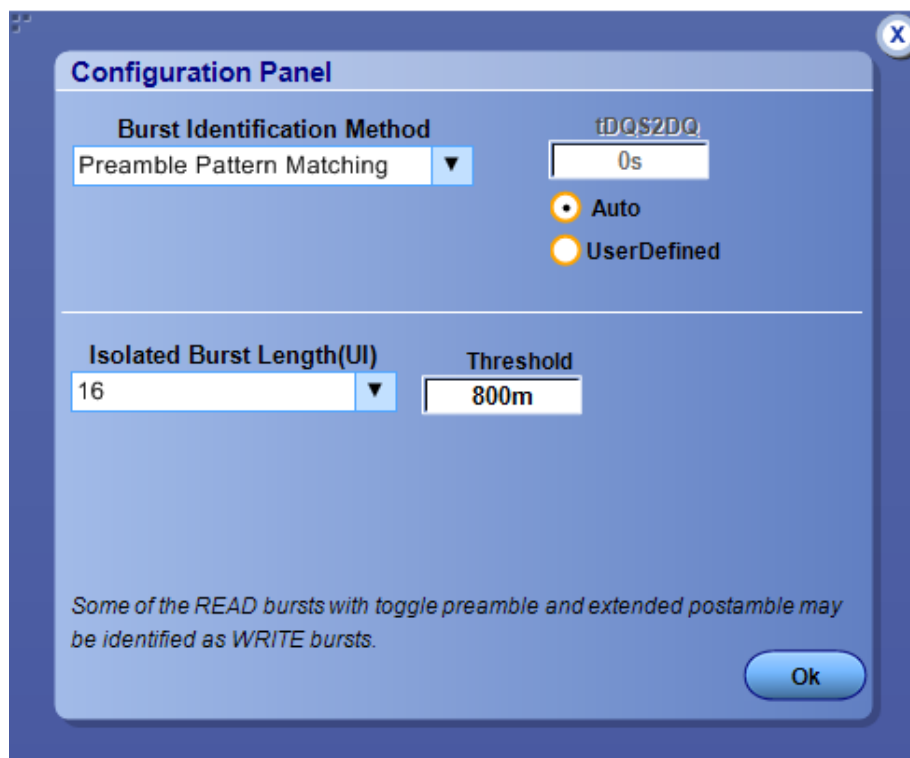
**NOTE.** The Config button appears only for LPDDR4 generation.

---

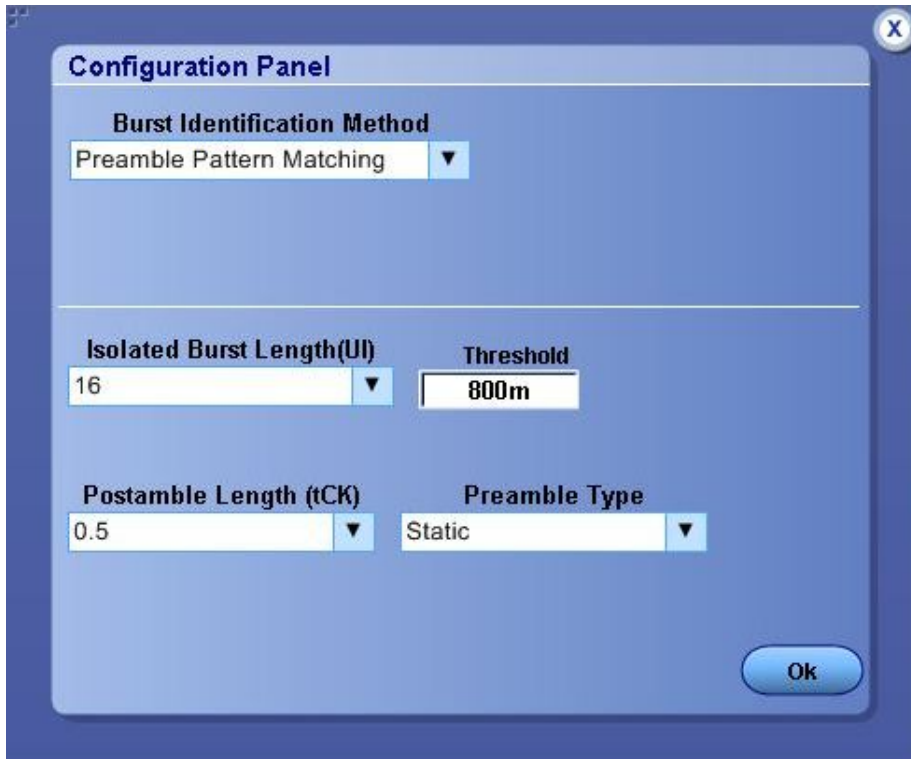


The Configuration panel dialog box is displayed.

**Measurement Type=Writer Burst=Preamble Pattern Matching**



**Measurement Type=Read Burst=Preamble Pattern Matching**



**Table 8: Burst Detection Parameter**

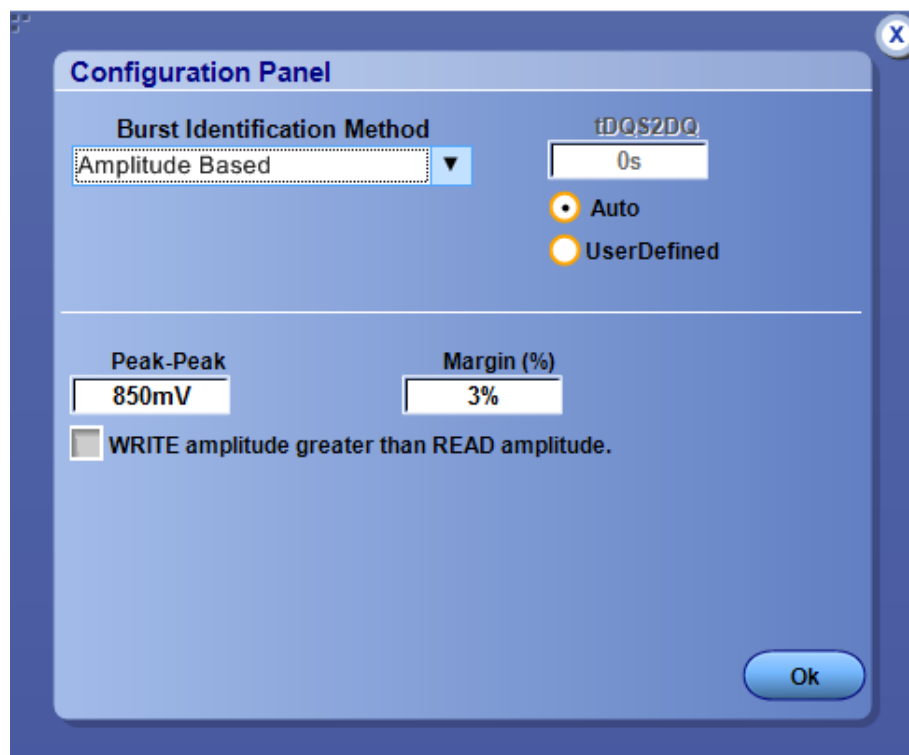
Parameters	Description
Preamble Pattern Matching	This algorithm is based on finding the appropriate preamble patterns over the entire acquisition. Each burst's association index (similarity coefficient) is compared with the user provided threshold to determine whether a burst is READ or WRITE.
Isolated Burst Length	Specifies the isolated burst length. For LPDDR4 it could be 16 or 32.
Threshold	Specifies the threshold with which the burst's association index will be compared. This parameter measures the similarity between READ and WRITE burst preambles.
Preamble Type	Specifies the READ burst preamble type as either Static or Toggle.  <b>NOTE.</b> This option is applicable only for Read Bursts and DQS (Single Ended, Read) group measurements.
Postamble Length	Specifies the READ burst postamble length. This could be either 0.5 tCK or 1.5 tCK (extended postamble). This control is used only for Read Bursts and DQS (Single Ended, Read) group measurements.

**Limitations**

### Preamble Pattern Matching

- Needs at least one isolated burst in the acquisition.
- In some scenarios, the algorithm may not distinguish properly between WRITE bursts and READ bursts with toggle preamble and extended postamble.

### Measurement Type=Write Burst=Amplitude Based



**Table 9: Burst Detection Parameter**

Parameters	Description
<b>Amplitude Based</b>	Select this measurement when there is a voltage difference between READ and WRITE burst peak to peak level.
Peak-Peak	Specifies the strobe (DQS) Pk-Pk voltage level of either READ or WRITE bursts.
Margin	Specifies the voltage variance allowed in terms of percentage of peak-peak voltage.
WRITE amplitude greater than READ amplitude	Check if WRITE burst amplitude is greater than READ burst amplitude; otherwise, uncheck.

This option is available for both the DQ-DQS Phase Alignment and Chip Select Latency + DQ-DQS Phase Alignment methods. By default, the Preamble Pattern Matching option is selected. For Write Bursts and DQS (Single Ended, Write) group measurements, you can specify the tDQS2DQ by selecting User Defined. By default, this is set to Auto so that the ASM (Advanced Search and Mark Capability) algorithm will calculate the tDQS2DQ and use that in burst marking. When User Defined is selected, the value you specify is used for burst marking.

**NOTE.** Current version of the application supports only write bursts having 2 clock cycle preamble.

Reference. [Hints](#)

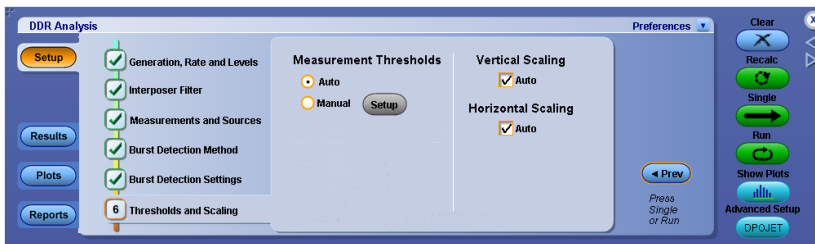
### Step 5: Burst detection settings

Displays the settings based on the burst detection method:

- [DQ/DQS Phase Alignment](#)
- [Chip Select, Latency+ DQ/DQS Phase Alignment](#)
- [Logic State + Burst Latency](#) (Available only for MSO series of oscilloscopes)
- [Visual Search](#)

### Step 6: Thresholds and scaling

The left half of this panel controls selection of critical voltage thresholds used by the measurement algorithms. The right half determines whether scaling is automatically adjusted each time you sequence.



**Measurement Thresholds.** Select either Auto or Manual as the Measurement Threshold type.

- If you select Auto, the application calculates these levels for you based on the DDR generation and speed grade. It is recommended that you use this option.
- If you select Manual, set the [measurements levels](#) by clicking the **Setup** button.

For more details, refer to Ref Levels in the DPOJET help.

**NOTE.** For every measurement selected in DDRA, appropriate reference levels are set in the DPOJET application. You can change these levels, if needed, from the DPOJET application.

**Vertical Scaling.** Selecting Auto performs autoset on the oscilloscope vertical settings only.

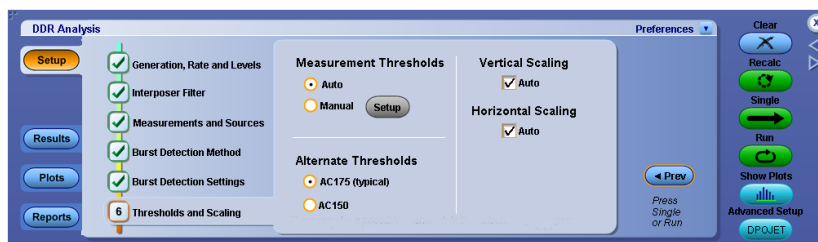
For more details, refer to Source Autoset in the DPOJET help.

**Horizontal Scaling.** Selecting Auto performs autoset on the oscilloscope horizontal settings only.

For more details, refer to Source Autoset in the DPOJET help.

**NOTE.** If both Vertical and Horizontal are checked, the application performs autoset on both vertical and horizontal oscilloscope settings when Single/Run is selected.

**Alternate Thresholds.** Alternate Thresholds are only applicable to DDR3 and DDR3L Address and Command measurement type. It allows you to select derating values( $\Delta$ ) from the derating tables– AC 175 and AC 150. The default is AC 175 (typical).



**AC 175.** The AC 175 Threshold derating table is as follows:

**Table 10: Derating Values for DDR3 800/1066/1333/1600 MT/s tIS/tIH**

$\Delta t_{IS}$ , $\Delta t_{IH}$ derating in ps AC/DC based AC 175 Threshold( $V_{IH}(ac)$ )= $V_{REF}(dc)+175$ mV, $V_{IL}(ac)$ = $V_{REF}(dc)-175$ mV CK , CK# Differential Slew Rate																	
		4.0 V/ns		3.0 V/ns		2.0 V/ns		1.8 V/ns		1.6 V/ns		1.4 V/ns		1.2 V/ns		1.0 V/ns	
		$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$
CMD/ ADD R Slew rate (v/ns)	2.0	88	50	88	50	88	50	96	58	104	66	112	74	120	84	128	100
	1.5	59	34	59	34	59	34	67	42	75	50	83	58	91	68	99	84
	1.0	0	0	0	0	0	0	8	8	16	16	24	24	32	34	40	50
	0.9	-2	-4	-2	-4	-2	-4	6	4	14	12	22	20	30	30	38	46
	0.8	-6	-10	-6	-10	-6	-10	2	-2	10	6	18	14	26	24	34	40
	0.7	-11	-16	-11	-16	-11	-16	-3	-8	5	0	13	8	21	18	29	34
	0.6	-17	-26	-17	-26	-17	-26	-9	-18	-1	-10	7	-2	15	8	23	24
	0.5	-35	-40	-35	-40	-35	-40	-27	-32	-19	-24	-11	-16	-2	-6	5	10
0.4	-62	-60	-62	-60	-62	-60	-54	-52	-46	-44	-38	-36	-30	-26	-22	-10	

AC 150. The AC 150 Threshold derating table is as follows:

**Table 11: Derating Values for DDR3 800/1066/1333/1600 MT/s tIS/tIH**

		$\Delta t_{IS}$ , $\Delta t_{IH}$ derating in ps AC/DC based AC 150 Threshold( $V_{IH(ac)} = V_{REF(dc)} + 150\text{ mV}$ , $V_{IL(ac)} = V_{REF(dc)} - 150\text{ mV}$ ) CK, CK# Differential Slew Rate															
		4.0 V/ns		3.0 V/ns		2.0 V/ns		1.8 V/ns		1.6 V/ns		1.4 V/ns		1.2 V/ns		1.0 V/ns	
		$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$	$\Delta t_{IS}$	$\Delta t_{IH}$
CMD/ ADD R Slew rate (v/ns)	2.0	75	50	75	50	75	50	83	58	91	66	99	74	107	84	115	100
	1.5	50	34	50	34	50	34	58	42	66	50	74	58	82	68	90	84
	1.0	0	0	0	0	0	0	8	8	16	16	24	24	32	34	40	50
	0.9	0	-4	0	-4	0	-4	8	4	16	12	24	20	32	30	40	46
	0.8	0	-10	0	-10	0	-10	8	-2	16	6	24	14	32	24	40	40
	0.7	0	-16	0	-16	0	-16	8	-8	16	0	24	8	32	18	40	34
	0.6	-1	-26	-1	-26	-1	-26	7	-18	15	-10	23	-2	31	8	39	24
	0.5	-10	-40	-10	-40	-10	-40	-2	-32	6	-24	14	-16	22	-6	30	10
	0.4	-25	-60	-25	-60	-25	-60	-17	-52	-9	-44	-1	-36	7	-26	15	-10

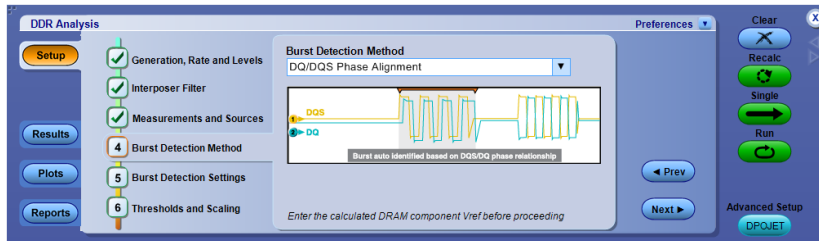
For DDR3 1866 and 2133 speeds, AC135 (typical) and AC125 are default settings.

**Reference.**

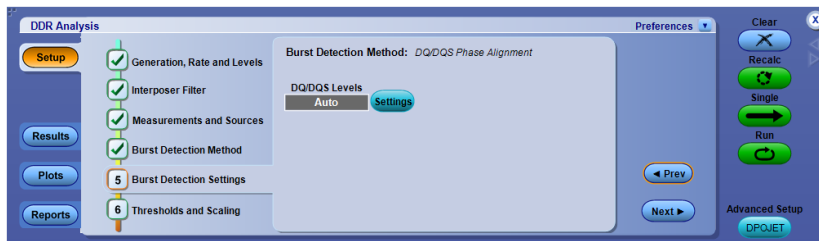
*Hints*

**DQ-DQS phase alignment**

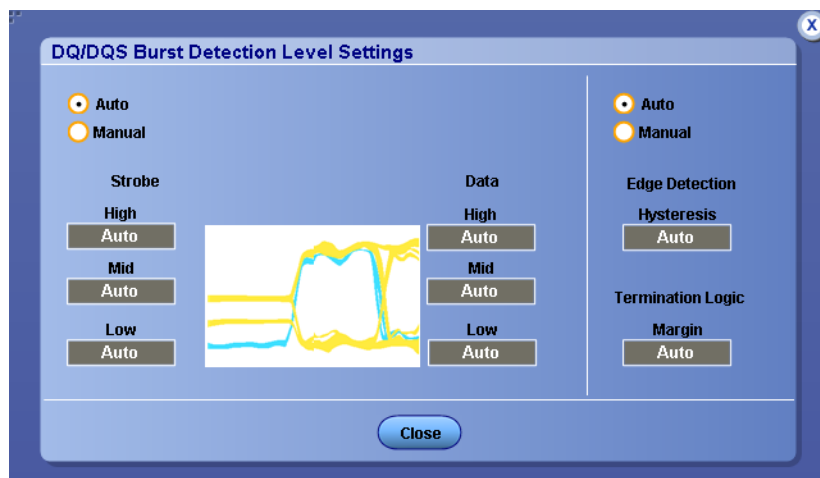
Select the burst detection method as shown:



The DQ/DQS levels indicator shows Auto when both Strobe/Data and Edge detection hysteresis are set to Auto. If one of the options is Manual, then the DQ/DQS levels shows as Manual. Click **Settings** tab to set advanced burst detection parameters.



The burst detection settings panel controls how data bursts are identified within a waveform that includes tri-state levels. For appropriately-probed signals with good signal fidelity, no adjustment to the default values should be required. For signals with poor fidelity or unusual properties, burst detection can be improved by switching to Manual control and adjusting the detection levels.



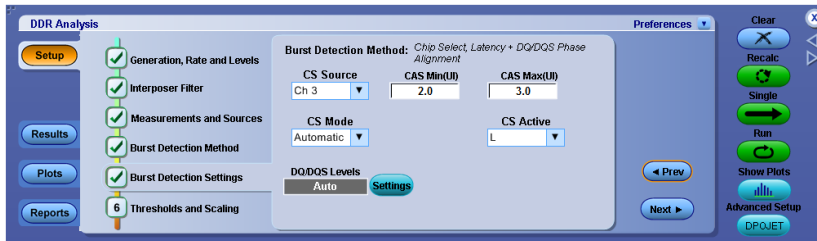
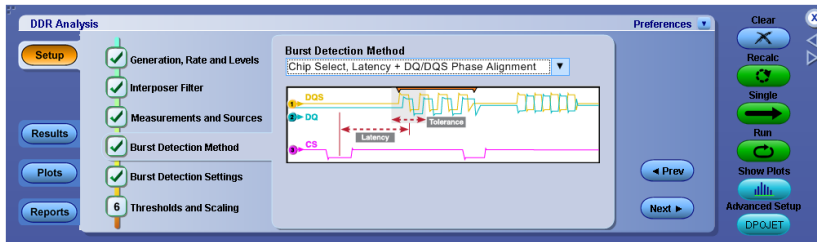
**NOTE.** The High/Mid/Low levels used for burst detection have no relationship to the reference levels used for measurement points. The measurement thresholds are defined in [Step6](#).

1. Select the type of burst detection level for the search.
  - If you select Auto, the application calculates these levels for you. It is recommended unless you find that manual levels are necessary for reliable detection.
  - If you select Manual, enter both the Strobe and Data reference levels for the signal (High, Mid, and Low). As you adjust the detection levels, observe the search-and-mark sprites that appear above the waveform. These sprites are dynamically updated as you adjust the levels, helping you to identify levels that properly delimit the selected burst type.
2. These settings need not be changed in most cases:
  - **Edge Detection Hysteresis:** This control configures the internal edge finder's hysteresis band which is used to detect read or write bursts. In the event of noisy inputs, it can be increased to correct marks which may be larger than appropriate.
  - **Termination Logic Margin:** This control can be increased to help in terminating marks on back-to-back writes in cases where otherwise a continuous strobe would cause a write-mark to merge two back-to-back writes.

## Chip select latency + DQ-DQS phase alignment

1. If you wish to filter the data bursts based on a CS Source signal, select the CS Source using the CS Source drop-down. Select CS Active and CS Mode as shown in the following figure. CS source is available only for Read and Write bursts measurements.

**NOTE.** Postamble length is applicable for LPDDR4 generation Read and DQS (Single Ended, Read) measurements. Set the postamble length to 0.5 tCK or 1.5 tCK, depending on the actual read postamble length.



**NOTE.** If a CS source is selected, CS-DQS(Strobe) is used for signal separation otherwise DQS(Strobe)-DQ(Data) is used. You must configure DQ source to enable Search and Mark.

### CS Source

CS Source is used as a logic input to select read or write bursts corresponding to the chip select signal. When a chip-select signal source other than none is specified, reads or writes will only be shown when the chip-select source is active.

### CS Active

Selects whether the chip-select source logic is considered active high or active low.

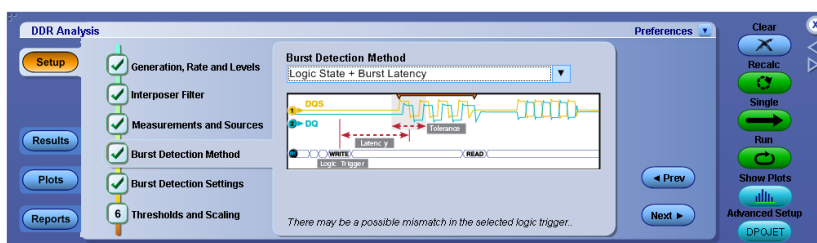
### CS Mode

CS Mode consists of two modes – Auto and Manual. CS Auto mode calculates the level automatically for you (as half the peak-to-peak voltage), while manual mode allows you to specify a CS level. In cases where an entire acquisition could occur with no transitions on the chip-select line, you must select the manual mode to set the correct logic level.

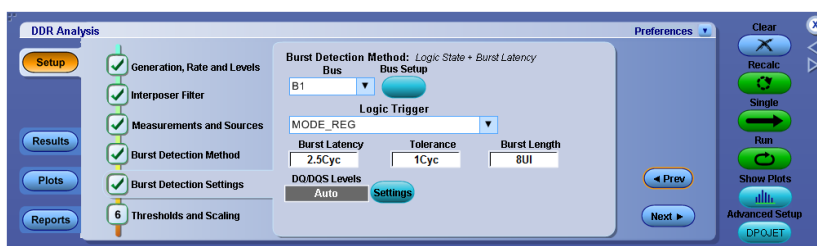


## Logic state + burst latency

This burst detection method is available only on MSO series of oscilloscopes. You can configure the logic state, burst latency, tolerance, burst length, and DQ/DQS levels.



The DDRA application provides a shortcut, **Bus Setup**, to configure the bus in the oscilloscope bus setup window. Click **Bus Setup** in Step 5 to view the Bus setup screen as shown

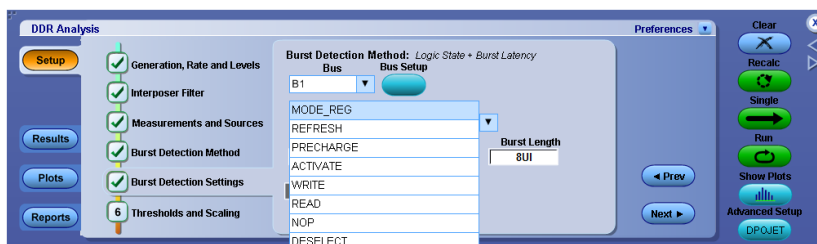


**NOTE.** For more details, refer to *Bus Setup Control Window (Select Tab)* section in your oscilloscope online help.

DDRA application lists the buses defined in the bus setup menu. For DDRA to use the logic bus for read/write burst detection, it must have an associated symbol file.

**NOTE.** The *Burst Length* field is not used for LPDDR4 generation. The LPDDR4 burst detection algorithm will internally analyze the digital Bus to get the burst length.

By default, the DDRA application displays the symbol file that corresponds to the selected DDR generation in Step [Step:1](#). Click **Browse** to select a symbol file of your choice. On selecting the symbol file, the Logic trigger lists the available patterns as shown. The symbol files per generation are located at C:\Users\Public\Tektronix\TekScope\busDecodeTables\DDR. This is different from the default TekScope location at C:\Users\[Username]\Tektronix\Tekscope\BusDecodeTables.



Edit/customize the symbols based on your requirements and save it in \*.tsf format. Place the created symbol files for access at C:\Users\Public\Tektronix\TekScope\busDecodeTables\DDR. Use Bus setup config menu or browse (Step 5) to access the created symbol file. A sample file for DDR3 is as shown:

Symbol	Pattern
MOD_REG	0000
REFRESH	0001
PRECHARGE	0010
ACTIVATE	0011
WRITE	0100
READ	0101
NOP	0111
DESELECT	1XXX

The DDRA application displays a hint There may be a possible mismatch in the selected logic trigger and the measurement type. Please verify before continuing when you select a logic state of READ and the measurement type selected is WRITE or vice versa.

**NOTE.** Any change in the symbol file in the DDRA application, is reflected in the oscilloscope bus configuration menu. The symbols of interest for DDRA are READ and WRITE patterns.

### Symbol File

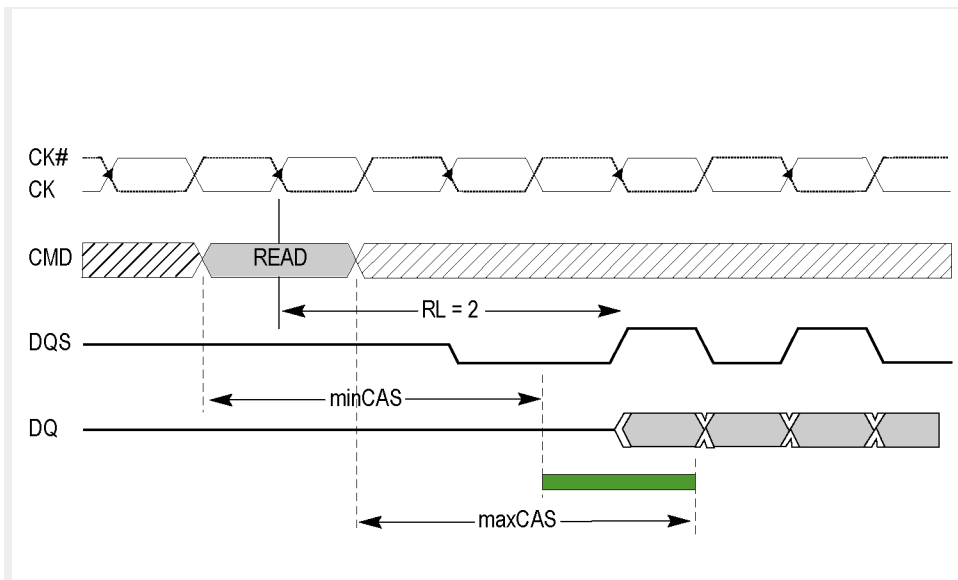
Symbol files are files of alphanumeric symbol names and associated data values, and are used to map a group value to a text string. The oscilloscope displays the symbol in place of the numeric value. For more details on symbol file format, refer to your oscilloscope online help .

Specify the Burst Latency, Tolerance, and burst length values.

### CAS Min and Max

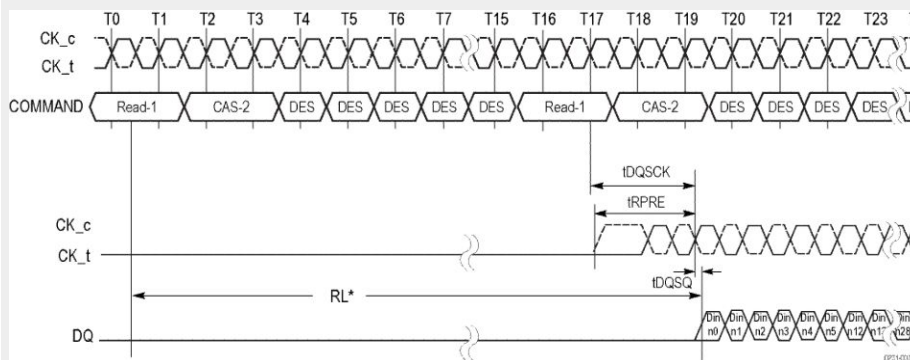
For READ commands, Read Latency (RL) is defined as the delay, in clock cycles, between the rising CLK edge that latches the READ command and the rising DQS edge signifying availability of the first data bit. The Read Latency is equal to the additive Latency and the CAS Latency ( $RL = AL + CL$ ). CAS Min specifies the minimum time delay between the start of READ bus state and the initial rising DQS edge, for the first bit to be recognized. CAS Max specifies the maximum time delay between the end of the READ bus state and the initial rising DQS edge, for the first bit to be recognized. In the following figure, the actual READ latency is 2 and the CAS Min and CAS Max are set to 2. The green zone indicates where the initial rising DQS edge must be for burst recognition to occur.

For WRITE commands, Write Latency (WL) is defined as the delay, in clock cycles, between the rising CLK edge that latches the WRITE command and the rising DQS edge in the center of the first data bit. The Write Latency is equal to the Additive Latency and the CAS Write Latency ( $WL = AL + CWL$ ). As with the READ case, the CAS Max and CAS Min parameters define a window following the WRITE bus state where the initial rising DQS edge must be for burst recognition to occur.



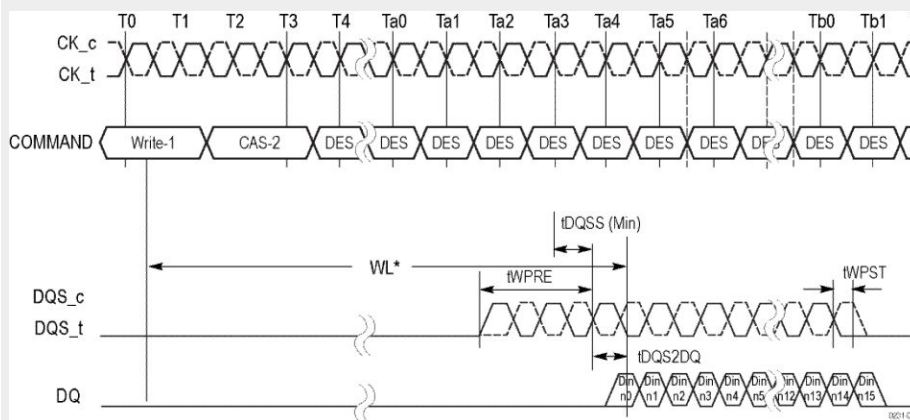
**Entering Read Latency(RL) and Write Latency(LW) in case of LPDDR4**

**Read Latency (RL):** Enter the time delay between the mid of the first READ command to start of the data.



In the above diagram, RL\* is the latency that you have to enter as Read Latency.

**Writer Latency(WL):** Enter the time delay between the mid of the first WRITE command and the center of the first data eye.



In the above diagram, WL\* is the latency that you have to enter as Writer Latency.

### Burst Length

READ and WRITE operations are burst oriented, they start at a selected location, and continue for a burst length. Burst length, specified in cycles, determines where a read/write mark ends after the start of a read/write mark has been identified. Any change in DDR generation resets the burst length to 8.0.

### Reference.

[Salient Features of MSO-DDR Integration Using Digital Channels](#)

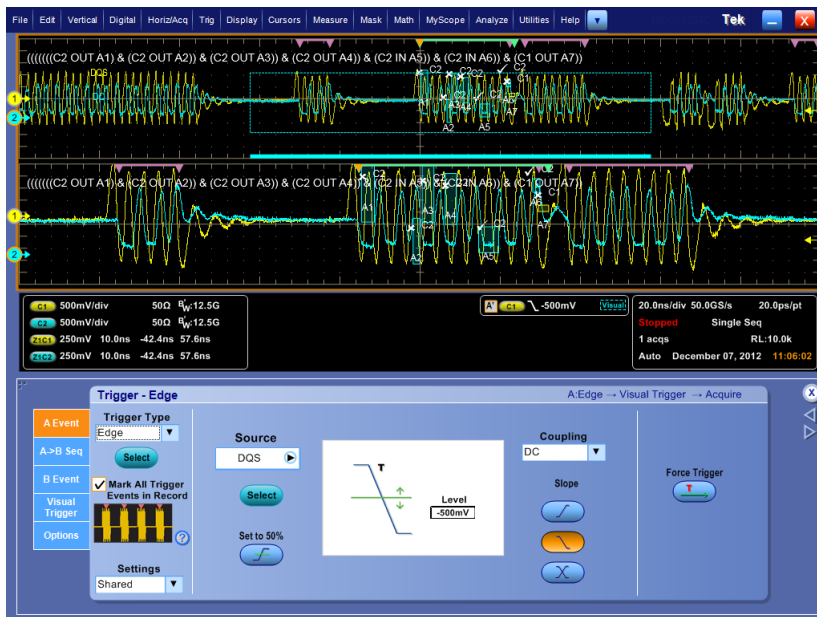
### Visual search

Capturing and analyzing the right part of the waveform can require hours of collecting and sorting through the many acquisitions. The Visual Trigger feature in the oscilloscope makes the identification of the desired waveform events quick and easy by scanning through acquired analog waveforms and graphically comparing them to geometric shapes on the display. By discarding acquired waveforms which do not meet the graphical definition, Visual Triggering extends the trigger capabilities of the oscilloscope beyond the traditional hardware trigger system.

In DDR, Visual Trigger can be used to separate Read bursts from Write Bursts and mark them. By selecting the Visual Search option in Step4: Burst Detection Method, these marked bursts can be used for further debugging and analysis.

**Marking Read/Write bursts using visual trigger.** Visual Trigger can also be used to mark all bursts which have a specific property (for example, marking a Read burst that has a spike just before it comes out of tri-state or marking a Write burst with a known data pattern). The figure below shows Visual Trigger that was used to mark (green marks) Write bursts with a known data pattern.

Along with the Visual search mark, Advanced search and mark (another feature in Tektronix oscilloscopes) has also been used to mark all the Write bursts (pink marks). Visual trigger has been used to isolate a burst with a specific data pattern, which allows the marked burst to be used for further debugging and analysis.



**Isolating Read and Write bursts on the DDR3 bus using Visual trigger.** DDR3 SDRAM is a high speed, dynamic random access memory internally configured as an eight bank DRAM. It can Read (fetch) and Write data as a burst operation. The burst length can be 4 clock cycles, 8 clock cycles, and can go up to 32 clock cycles so that it can fetch the data byte 1 to 8 bytes in a burst.

DDR3 defines the polarity of the Preamble different for Read and Write. For a Read burst, the Preamble would be negative polarity. For a Write burst, the Preamble would be positive polarity. For DDR3, the Read and Write Preamble widths are defined by parameters tRPRE and tWPRE in the JEDEC specification, and whose minimum value has been defined as 0.9 times that of the clock period.

Additionally, the phase between the Strobe signal (DQS) and Data Signals (DQ) are different for Read and Write. DQS and DQ are aligned for Read bursts and shifted by 90 degrees for Write bursts.

**Isolating based on Preamble polarity and phase between DQS and DQ using Visual trigger.** Figure 1 shows a screen capture of using Visual Trigger to isolate Read signals based on Preamble polarity and phase difference between the DQS and DQ signals. Channel 1 of the oscilloscope is DQS and Channel 2 is DQ. Areas A1 and A2 are set so that when a signal is captured, there is no DQS signal in these regions. This ensures that the captured signal is coming out of tri-state. Area A3 is set to select the negative polarity of the Preamble. Areas A4 and A5 are set so that the DQ signal does not enter these regions, making sure that the DQS and DQ are aligned.

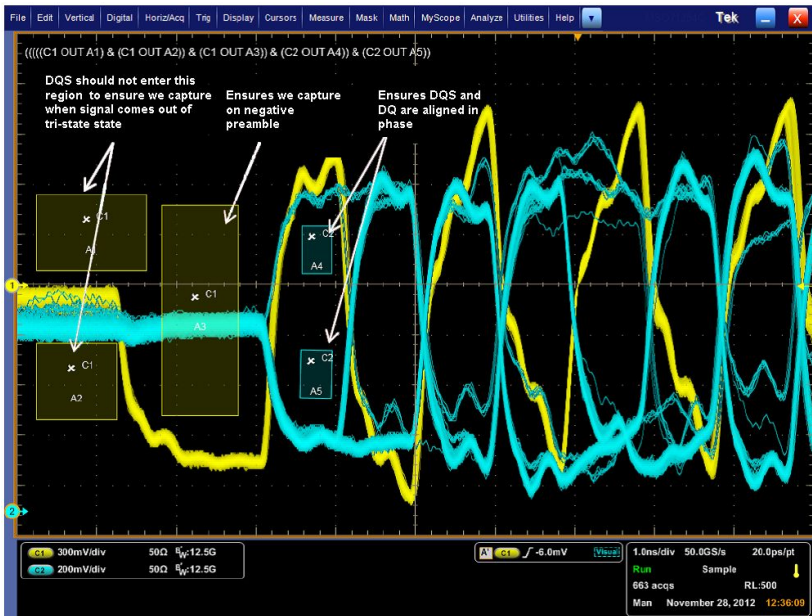


Figure 1: Read burst

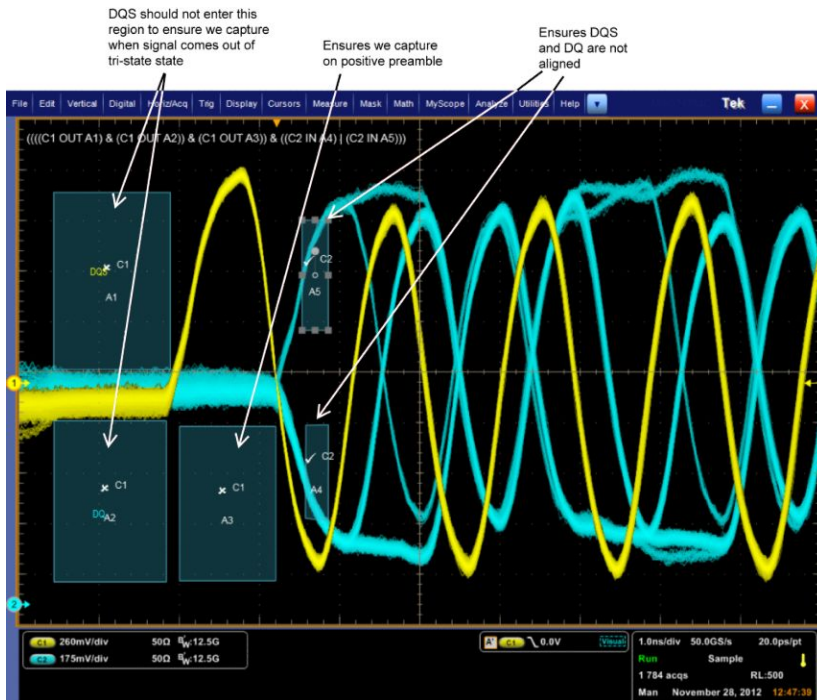
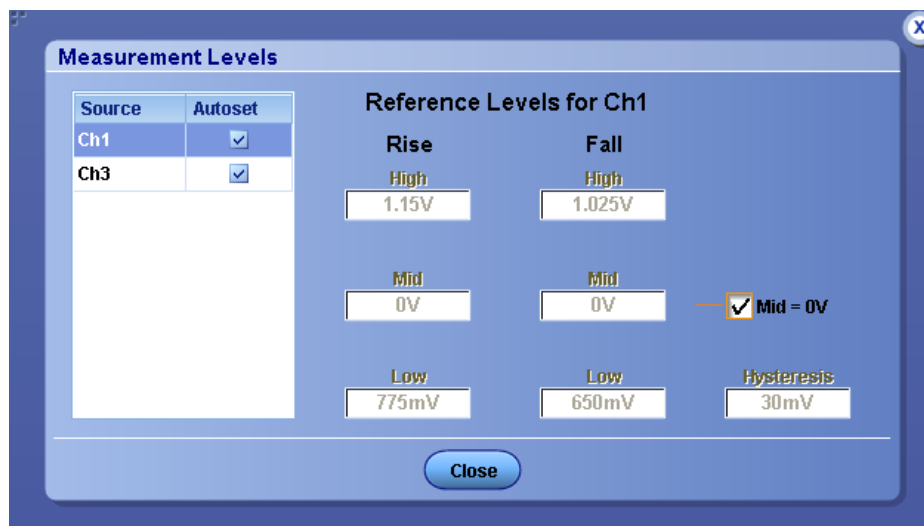


Figure 2: Write burst

## Measurement levels

By definition, edges occur when a waveform crosses specified reference voltage levels. Reference voltage levels must be set so that the application can identify state transitions on a waveform. By default, the application automatically chooses reference voltage levels when necessary.



The DDR application uses three basic reference levels: High, Mid and Low. In addition, a hysteresis value defines a voltage band that prevents a noisy waveform from producing spurious edges. The reference levels and hysteresis are independently set for each source waveform, and are specified separately for rising versus falling transitions.

Item	Description
Measurement Reference Levels Setup (one level per source)	
Rise High	Sets the high threshold level for the rising edge of the source.
Rise Mid	Sets the middle threshold level for the rising edge of the source.
Rise Low	Sets the low threshold level for the rising edge of the source.
Fall High	Sets the high threshold level for the falling edge of the source.
Fall Mid	Sets the middle threshold level for the falling edge of the source.
Fall Low	Sets the low threshold level for the falling edge of the source.
Hysteresis	Sets the threshold margin to the reference level which the voltage must cross to be recognized as changing; the margin is the relative reference level plus or minus half the hysteresis; use to filter out spurious events.

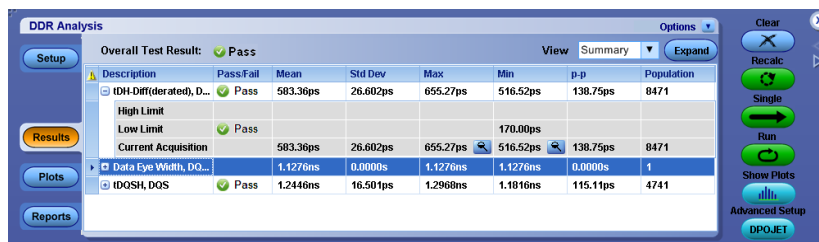
## Hints

The DDRA application displays the following hints at different steps:

Hint	Step	Description
Select a standard data rate in DDRA	1	Displayed when data rate is None. When you select a non standard data rate in ASM, the data rate is set to None in DDRA.
GDDR3 not completely supported. Some features may not function.	1	Displayed on selecting GDDR3 standard, which does not have standard data rates. Only Data Eye Width measurement is available for both Read and Write bursts.
Please provide a Limits file under Jitter and Eye Analysis > Limits	1	Displayed for custom data rates for which limits are not defined. You need to manually configure the limits.
Cannot use Live and Ref waveforms together.	3	Displayed on selecting both Live and Ref waveforms as source for DQ and DQS. Example: Data Eye Width measurement with sources as Ch1 for DQ and Ref1 for DQS.
Cannot use the same waveform for different sources.	3	Displayed on selecting the same source for DQ and DQS. Example: Data Eye Width using Ch3 for both DQ and DQS.
Cannot select Diff and SE measurements at the same time.	3	Displayed on selecting measurements with suffix SE and Diff. Example: DDR2, Write bursts, tDH-Diff and tDH-SE measurements.
Use unique sources that are either Live or Ref.	3	Displayed on selecting measurements which require DQ, DQS and Clock sources. Example: DDR3, 800MT/s, select all Read burst measurements.

## Results as statistics

Result statistics for most of the measurements show **Population** in terms of UI or transitions. According to the JEDEC specification, the analysis for most of the clock measurements is done for a 200-cycle moving window. However, for clock measurements such as tCL(avg) and tCH(avg), the population is shown as tCK(avg) units. For some measurements such as Data Eye Width, exactly one measurement occurs per acquisition. For such measurements, the population increases by one for each acquisition independent of the number of UI in the acquisition.



For more details, refer to Viewing Statistical Results in the DPOJET help.

## Reference.

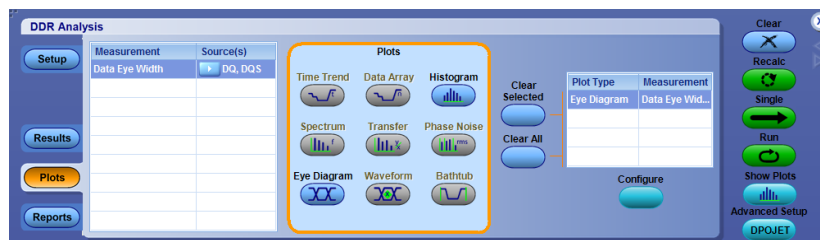
[Dynamic Limits](#)



## Plots

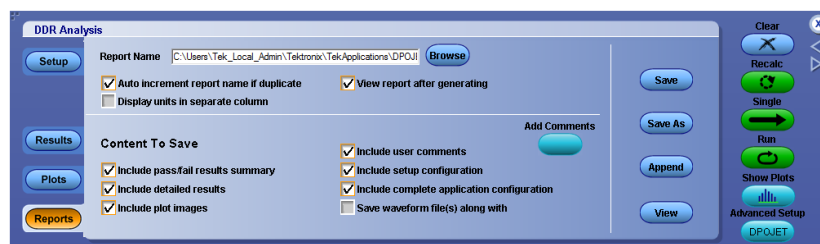
The only measurement for which a plot is automatically configured is *Data Eye Width*, which is available for both Read and Write bursts. However, plots may be added for other measurements through the plot panel. The plot selection and configuration methods are identical to those used for DPOJET. For more details, refer to the DPOJET help.

For acquisitions containing more than one read or write burst, time trend plots connect together all measurements within each burst with a continuous line, but do not draw lines between bursts. If a vertical cursor is placed where it does not intersect a line, the cursor annotation will read NaN (Not a Number).



For more details, refer to About Configuring Plots in the DPOJET help.



## Reports



For more details, refer to About Reports in the DPOJET help.

## Switching between the DDRA and DPOJET applications



For advanced analysis, click  to switch to the DPOJET application. Likewise, click  in the DPOJET application to revert to the DDRA application.

The transition behaves as follows:

- The application name in the title bar switches between **DDR Analysis** and **Jitter and Eye Diagram Analysis Tool**.
- Measurement name remains unchanged while traversing from DDRA to DPOJET.
- Within DPOJET, more measurements may be added to those automatically configured in DDRA. These measurements must be configured manually.
- Once in DPOJET, measurements automatically configured by DDRA may be reconfigured. (The measurements will generally no longer be JEDEC-compliant in this case.)
- Upon returning to DDRA, new or non-standard measurements will be retained.
- Measurement sequencing, results analysis and report generation can be done from either application.
- Any change in generation and measurement type in the DDRA deselects all the currently selected measurements.
- Switching back from DPOJET to DDRA, always resets focus to the Setup panel.

- DPOJET or DDRA application is always accessible from the oscilloscope menu bar, as an alternative to the quick navigation buttons.
- If DPOJET application is opened from the oscilloscope menu (Analyze > Jitter and Eye Diagram Analysis), the shortcut button to DDR Analysis is not shown. This shortcut only appears if DPOJET is entered from the DDRA interface.
- Any change in the reference voltage levels in DPOJET is reflected in DDRA Step 1, *Vih and Vil*. Vih and Vil specify the static voltage reference levels of the measurements. You can modify these levels either in Step 6 of DDRA or in the DPOJET source configuration screen.

### Salient features of MSO-DDRA integration

The following are the salient features of MSO-DDR integration:

- Use the DDRA user interface for the required settings without exiting from the DDRA setup panel for digital configuration.
- Logic State burst detection method is more reliable than the conventional DQ/DQS Phase alignment.
- Digital configurations are available at Step 4 and Step 5 of the DDRA application. The Logic pattern or Logic state triggering is used on the digital control signals such as RAS, CAS, CS and WE, which identify the desired burst type.
- Symbol files per DDR generation are available.
- Identify marks using the specified digital control signals and Burst Latency and Tolerance values. The Burst Latency and Tolerance values are important to precisely mark the bursts.
- Change in DDR generation resets the burst length to 8.0.

---

# Tutorial

## Introduction to the tutorial

This tutorial teaches how to set up the application, take measurements, and view results as plots or statistics.

Before you begin the tutorial, perform the following tasks:

- Set up the oscilloscope.
- Start the application.
- Recall the tutorial waveform.

## Setting up the oscilloscope

The steps to set up the oscilloscope are:

- Click **File > Recall Default Setup** in the oscilloscope menu bar to recall the default settings.
- Press the individual CH1, CH2, CH3, and CH4 buttons as needed to add or remove active waveforms from the display.

## Starting the application

Click **Analyze > DDR Analysis** to open the application.

## Waveform files

The DDRA application provides the following waveforms at C:\Users\Public\Tektronix\TekApplications\DDRA\waveforms for oscilloscopes running the Windows7 operating system:

- DDR2\_800\_DQS\_Write.wfm
- DDR2\_800\_DQ\_Write.wfm
- DDR2\_800\_CLK.wfm


---

**NOTE.** These waveforms have to be used only for Write bursts and CLK.

---

## Recalling a waveform file

To recall a waveform file, follow these steps:

1. Click **File > Recall** in the oscilloscope menu bar to display the Recall dialog box.
2. Click Waveform icon in the left of the Recall dialog box.
3. Select Ref1, Ref2, Ref3, or Ref4 as the Destination option.
4. Browse to select the waveform. Use the keypad to edit the waveform file name.
5. Click **Recall**. The oscilloscope recalls and activates the Reference Waveform control window.
6. Click **On** to display the waveform.
7. Click  to return to the application. Alternatively, DDRA can also be accessed from **Analyze > DDR Analysis**.



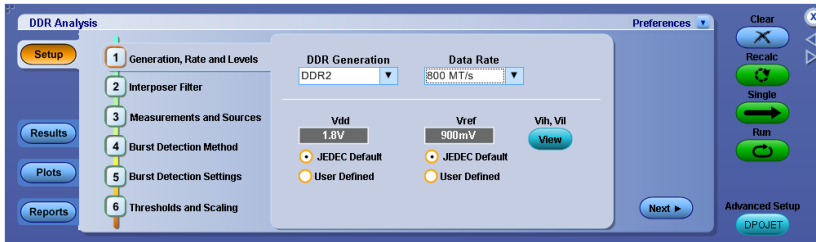
## Taking a measurement

This tutorial uses the following example

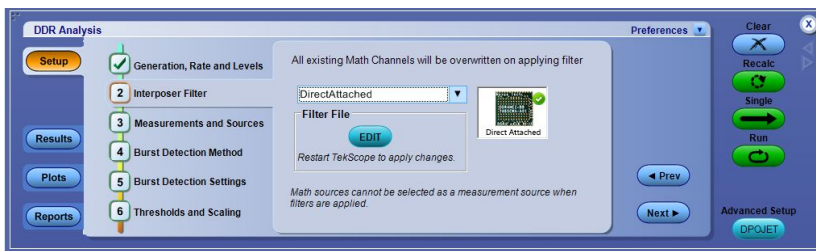
### DDR2 800MT/s, Write bursts - Differential measurements

**Waveforms Used:** DDR2\_800\_DQS\_Write.wfm and DDR2\_800\_DQ\_Write.wfm

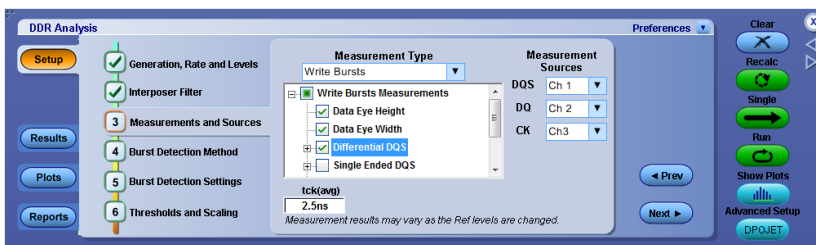
1. To set the application to default values, click **File > Recall Default Setup**. This is not necessary if you have just started the application.
2. To view the DDRA application, select **Analyze > DDR Analysis**.
3. At Step 1, select the DDR2 standard and the data rate as 800 MT/s. The default voltage settings are retained as shown:



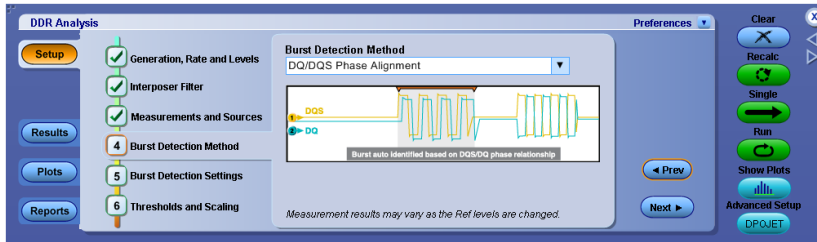
4. At Step 2, select the filter and the probing type.



5. At Step 3, select the measurements and the associated sources.



- At Step 4, select the burst detection method.

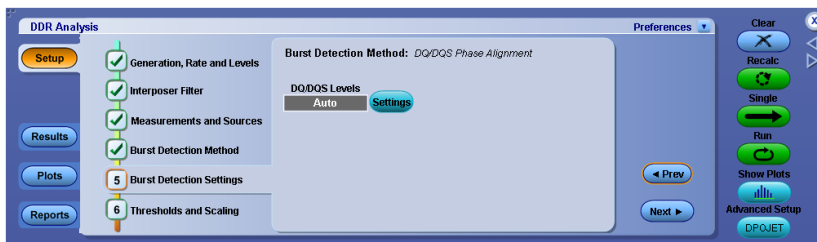


The selected data rate, generation, and measurement type are reflected in ASM on selection in DDRA. Marks are available only for Read and Write bursts measurement type. Configure Search using **Advance > Search > Configure**. The identified bursts are shown as small inverted marks (▼) in the oscilloscope display area. Each pair of marks specifies the start and stop of a burst. You can traverse from one mark to the other using the Mark Control window. For more details, refer to your oscilloscope online help.

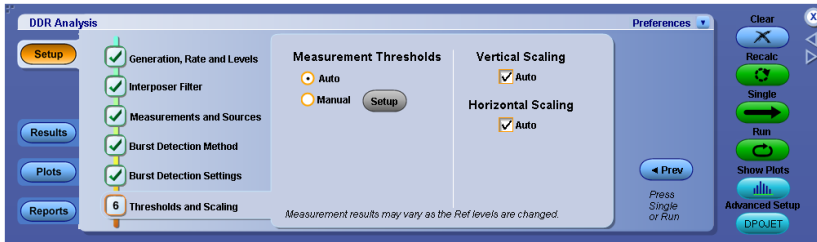


**NOTE.** Logic state+ DQ/DQS Phase Alignment is available only for MSO series of oscilloscopes.

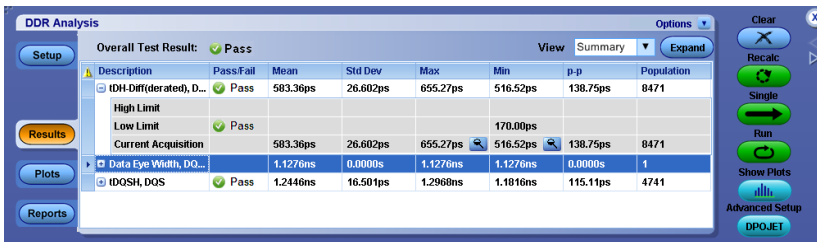
- At Step 5, select the burst detection settings based on the selected burst detection method as shown:



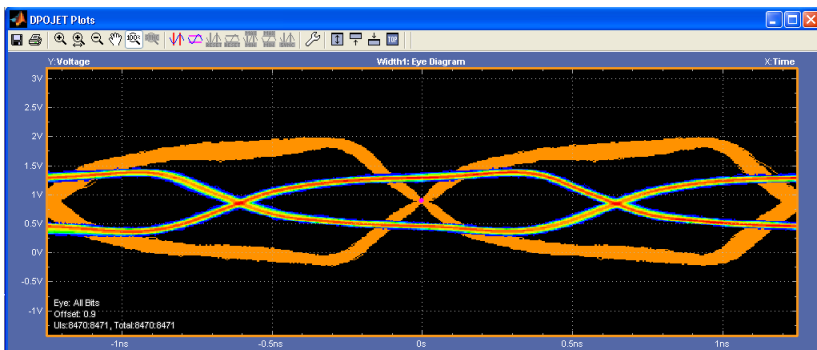
- At Step 6, retain the settings as shown:



- Click **Single** to run the application. When complete, the result statistics with limits are shown in the results tab.



The eye diagram plot is displayed as shown:



# Parameters

## About parameters

This section describes the DDRA application parameters and includes the menu default settings. Refer to the user manual of your oscilloscope for operating details of other controls, such as front-panel buttons.

The parameter tables list the selections or range of values available for each option, the incremental unit of numeric values, and the default selection or value.

## Step 1: Generation rate and levels parameters

Step1 includes the following parameters:

**Table 12: Generation, rate and levels parameters**

Option	Parameters	Default setting
DDR Generation	DDR, DDR2, DDR3, DDR3L, DDR4, LPDDR, LPDDR2, LPDDR3, LPDDR4, GDDR3, and GDDR5	DDR3
Data Rate <sup>1</sup>	<b>DDR:</b> 200 MT/s, 266 MT/s, 333 MT/s, 400 MT/s, Custom and None	200 MT/s for DDR
	<b>DDR2:</b> 400 MT/s, 533 MT/s, 667 MT/s, 800 MT/s, 1066 MT/s, Custom and None	400 MT/s for DDR2
	<b>DDR3:</b> 800 MT/s, 1066 MT/s, 1333 MT/s, 1866 MT/s, 2133 MT/s, Custom and None	800 MT/s for DDR3
	<b>DDR3L:</b> 800 MT/s, 1066 MT/s, 1333 MT/s, 1600 MT/s, 1866 MT/s, Custom and None	800 MT/s for DDR3L
	<b>DDR4:</b> 1600 MT/s, 1866 MT/s, 2133 MT/s, 2400 MT/s, 2466 MT/s, 3200 MT/s, Custom and None	1600 MT/s for DDR4
	<b>LPDDR:</b> 200 MT/s, 266 MT/s, Custom and None	200 MT/s for LPDDR
	<b>LPDDR2:</b> 333 MT/s, 400 MT/s, 533 MT/s, 667 MT/s, 933 MT/s, 1066 MT/s, Custom and None	333 MT/s for LPDDR2
	<b>LPDDR3:</b> 333 MT/s, 800 MT/s, 1066 MT/s, 1200 MT/s, 1333 MT/s, 1466 MT/s, 1600 MT/s, Custom and None	333 MT/s for LPDDR3
	<b>LPDDR4:</b> 533 MT/s, 1066 MT/s, 1600 MT/s, 2133 MT/s, 2400 MT/s, 2667 MT/s, 3200 MT/s, 3733 MT/s, 4266 MT/s, Custom and None	533 MT/s for LPDDR4
	<b>GDDR3:</b> 500 MT/s, 600 MT/s, 700 MT/s, 800 MT/s, 900 MT/s, 1000 MT/s, Custom and None	500 MT/s for GDDR3
	<b>GDDR5:</b> 4000 MT/s, 4800 MT/s, 5000 MT/s, 5500 MT/s, Custom, and None	4000 MT/s for GDDR5
	Custom	800 MT/s
Vdd	JEDEC Default, User Defined	JEDEC Default
Vref	JEDEC Default, User Defined	JEDEC Default
Vcent DQ	<b>LPDDR4:</b> JEDEC Default, User Defined	201.5 mv

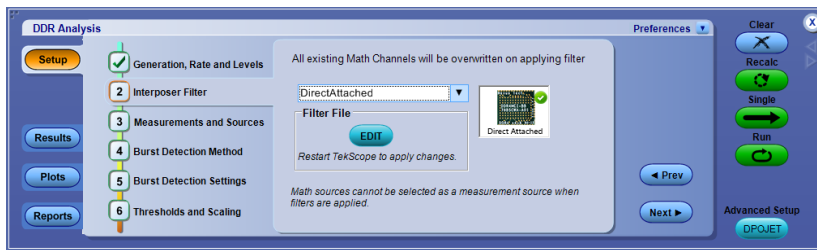
<sup>1</sup> Data rate varies for different DDR standards.

Option	Parameters	Default setting
	DDR4 : JEDEC Default, User Defined	850 mv
Vcent CA	LPDDR4:JEDEC Default, User Defined	191.5 mv
VrefCA	DDR4:JEDEC Default, User Defined	600 mv

## Step 2: Interposer filter parameters

Step2 includes the following parameters under Filter Type:

- None
- User Defined
- Direct Attached



## Step 3: Measurement and sources parameters

Step3 includes the following parameters under Measurement Type:

- Read Bursts
- Write Bursts
- WCK(Single Ended) <sup>2</sup>
- WCK(Diff) <sup>2</sup>
- Clock(Diff)
- Clock(Single Ended)
- Address/Command
- Refresh <sup>2</sup>
- Power Down <sup>2</sup>
- Active <sup>2</sup>
- Precharge <sup>2</sup>
- DQS(Single Ended)/DQS(Single Ended,Write)
- DQS(Single Ended, Read)

The sources parameters are as shown in the following table:

<sup>2</sup> These measurement types and parameters are available for GDDR5 generation.



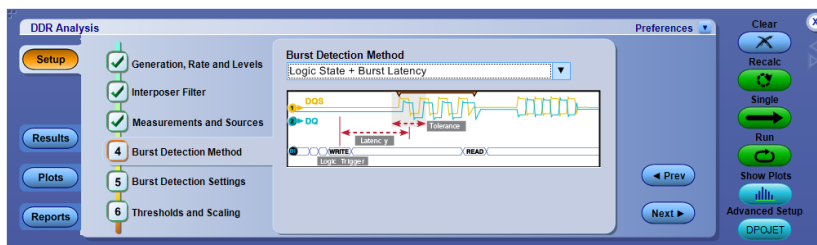
Table 13: Sources parameters

Option	Parameters	Default setting
DQS(Strobe)	Ch1-Ch4, Ref1-Ref4, Math1-Math4	Ch1
DQS#(Strobe)	Ch1-Ch4, Ref1-Ref4, Math1-Math4	Ch3
DQ(Data)	Ch1-Ch4, Ref1-Ref4, Math1-Math4	Ch2
Addr/Cmd	Ch1-Ch4, Ref1-Ref4, Math1-Math4	Ch4
Clock	Ch1-Ch4, Ref1-Ref4, Math1-Math4	Ch3
Clock#	Ch1-Ch4, Ref1-Ref4, Math1-Math4	Ch4
WCK	Ch1-Ch4, Ref1-Ref4, Math1-Math4	Ch1
WCK#	Ch1-Ch4, Ref1-Ref4, Math1-Math4	Ch4
WE, CS, CAS, RAS, CKE	D0-D15	None

## Step 4: Burst detection method parameters

Step 4 has the following parameters:

- [DQ/DQS Phase Alignment](#)
- [Chip Select, Latency + DQ/DQS Phase Alignment](#)
- [Logic State + Burst Latency](#)
- [Visual Search](#)



## Step 5: Burst detection settings parameters

Step5 has the following parameters:

**NOTE.** The DQ/DQS Phase Alignment settings are same for Chip Select and Logic State Burst Detection methods.

Table 14: Burst detection parameters

Option	Parameters	Default setting
<b>Chip Select, Latency + DQ/DQS Phase Alignment</b>		
CS Source	None, Ch1-Ch4, Ref1-Ref4, Math1-Math4	None
CS Mode <sup>3</sup>	Auto, Manual	Auto
CAS Min(Cyc) <sup>3</sup>	0–1k	2.0

Option	Parameters	Default setting
CS Active <sup>3</sup>	High, Low	Low
CS Level <sup>3</sup>	-50V to +50V	0.0 V
CAS Max(Cyc) <sup>3</sup>	0–1k	3.0
DQ/DQS Levels <sup>4</sup>	Auto, Manual	Auto
<b>DQ/DQS Phase Alignment</b>		
<b>Strobe</b>		
High	Auto, Manual	Auto
Mid	Auto, Manual	Auto
Low	Auto, Manual	Auto
<b>Data</b>		
High	Auto, Manual	Auto
Mid	Auto, Manual	Auto
Low	Auto, Manual	Auto
<b>Edge Detection Hysteresis</b>	Auto, Manual	Auto
<b>Termination Logic Margin</b>	Auto, Manual	Auto
<b>LogicState + Burst Latency DQ/DQS Phase Alignment <sup>5</sup></b>		
Bus	B1–B16	None
Tolerance <sup>4</sup>	0–50 G	1Cyc
Burst Latency <sup>4</sup>	0–50 G	2.5Cyc
Burst Length	0–50 G(ui)	8 UI
DQ/DQS Levels <sup>4</sup>	Auto, Manual	Auto
Logic Trigger <sup>4</sup>	MODE_REG, REFRESH, PRECHARGE, ACTIVATE, WRITE, READ, SRX, DESELECT, SRE, PDE	MODE_REG

<sup>3</sup> Available only when you select CS source.

<sup>4</sup> These measurement types and parameters are available for GDDR5 generation.

<sup>5</sup> Available only for the MSO series of oscilloscopes.

## Step 6: Thresholds and scaling parameters

Step6 has the following parameters:

**Table 15: Thresholds and scaling parameters**

Option	Parameters	Default setting
Measurement Thresholds	Auto, Manual	Auto
Vertical Scaling	Set, Clear	Clear
Horizontal Scaling	Set, Clear	Clear
Alternate Thresholds <sup>1</sup>	AC160, AC130, AC135, AC175 , AC150, AC125, AC220 , AC300,	AC175
<b>Measurement Levels</b>		
Rise High	-20 V to 20 V	Default varies depends upon DDR generation
Rise Mid	-20 V to 20 V	
Rise Low	-20 V to 20 V	
Fall High	-20 V to 20 V	
Fall Mid	-20 V to 20 V	
Fall Low	-20 V to 20 V	
Hysteresis	0 to 10 V	30 mV

<sup>1</sup> Available for DDR3,DDR3L generation.



# Reference

## DDR measurement sources

The sources required for analysis may include DQS(Strobe), DQ(Data), DQS# (Strobe), Clock, Clock#, and Addr/Cmd. Clock and DQS can be either Single-Ended (SE) or Differential (Diff). CS Source is available, as appropriate, as an optional qualifier.

The following table lists the sources required for each DDR measurement:

**Table 16: DDR measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
<b>Differential DQS</b>			
tDQSH	Pos Width	DQS and DQ	NA
tDQSL	Neg Width	DQS and DQ	NA
tDSH-Diff	Hold	DQS and Clock	DQ <sup>2</sup>
tDSS-Diff	Setup	DQS and Clock	DQ <sup>1</sup>
<b>Single Ended DQS</b>			
tDH-SE	DDR Hold-SE	DQS and DQ	NA
tDIPW-SE	Period	DQ	DQS <sup>1</sup>
tDSH-SE	Hold	DQS and Clock	DQ <sup>1</sup>
tDS-SE	DDR Setup-SE	DQS and DQ	NA
tDSS-SE	Setup	DQS and Clock	DQ <sup>1</sup>
tWPRE	DDR tRPRE	DQS	DQ <sup>1</sup>
tWPST	DDR tRPST	DQS	DQ <sup>1</sup>
<b>Read Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
<b>Differential DQS</b>			
tAC-Diff	DDR Setup-Diff	DQ and Clock	DQS <sup>1</sup>
tDQSCK-Diff	Skew	DQS and Clock	DQ <sup>1</sup>
tQH	Hold	DQS and DQ	NA
<b>Single Ended DQS</b>			
tDQSQ-SE	Setup	DQS and DQ	NA
tRPRE	DDR tRPRE	DQS	DQ <sup>1</sup>
tRPST	DDR tRPST	DQS	DQ <sup>1</sup>
<b>Clock (Diff)</b>			

<sup>2</sup> Required so that the Search-and-Mark feature can properly identify bursts

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tCH	Pos Width	Clock	NA
tCK	Period	Clock	NA
tCL	Neg Width	Clock	NA
tHP	Period	Clock	NA
VID(ac)	DDR VID(ac)	Clock	NA
<b>Clock (Single Ended)</b>			
AC-Overshoot(CK#)	Overshoot	Clock#	NA
AC-Overshoot(CK)	Overshoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock#	NA
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-Undershoot(CK#)	Undershoot	Clock#	NA
AC-Undershoot(CK)	Undershoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock#	NA
AC-UndershootArea(CK)	DDR Under Area	Clock	NA
Vix(ac)CK	V-Diff-Xovr	Clock and Clock#	NA
<b>DQS (Single Ended)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Overshoot(DQS)	Overshoot	DQS	DQ <sup>1</sup>
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>1</sup>
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
AC-Undershoot(DQS)	Undershoot	DQS	DQ <sup>1</sup>
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>1</sup>
Vix(ac)DQS	V-Diff-Xovr	DQS and DQS#	DQ <sup>1</sup>
<b>DQS (Single Ended, Read)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ
AC-Overshoot(DQS)	Overshoot	DQS	DQ
AC-Undershoot(DQS)	Undershoot	DQS	DQ

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
<b>Address/Command</b>			
AC-Overshoot	Overshoot	Addr/Cmd	NA
AC-OvershootArea	DDR Over Area	Addr/Cmd	NA
AC-Undershoot	Undershoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA
tIH(base)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIPW-High	Pos Width	Clock and Addr/Cmd	NA
tIPW-Low	Neg Width	Clock and Addr/Cmd	NA
tIS(base)	DDR Setup-Diff	Clock and Addr/Cmd	NA

## DDR2 measurement sources

The sources required for analysis may include DQS(Strobe), DQ(Data), DQS# (Strobe), Clock, Clock#, CS Source, and Addr/ Cmd. Clock and DQS can be either Single-Ended (SE) or Differential (Diff). Read and Write bursts have CS as an optional source.

The following table lists the sources required for each DDR2 measurement:

**Table 17: DDR2 measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
<b>Differential DQS</b>			
InputSlew-Diff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>3</sup>
InputSlew-Diff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>2</sup>
tDH-Diff(base)	DDR Hold-Diff	DQS and DQ	NA
tDH-Diff(derated)	DDR Hold-Diff	DQS	NA
tDQSH	Pos Width	DQS	DQ <sup>2</sup>
tDQSL	Neg Width	DQS and DQ	DQ <sup>2</sup>
tDQSS-Diff	Skew	DQS and Clock	DQ <sup>2</sup>
tDS-Diff(base)	DDR Setup-Diff	DQS and DQ	NA
tDS-Diff(derated)	DDR Setup-Diff	DQS and DQ	NA
tDSH-Diff	Hold	DQS and Clock	DQ <sup>2</sup>

<sup>3</sup> Required so that the Search-and-Mark feature can properly identify bursts

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tDSS-Diff	Setup	DQS and Clock	DQ <sup>2</sup>
tDVAC(DQS)	Time Outside Level	DQS	DQ
<b>Single Ended DQS</b>			
Slew Rate-Setup-SE-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>2</sup>
Slew Rate-Setup-SE-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>2</sup>
Slew Rate-Hold-SE-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>2</sup>
Slew Rate-Hold-SE-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>2</sup>
tDH-SE(base)	DDR Hold-SE	DQS and DQ	NA
tDH-SE(derated)	DDR Hold-SE	DQS and DQ	NA
tDIPW-SE	Period	DQ	DQS
tDQSS-SE	Skew	DQS and Clock	DQ <sup>2</sup>
tDSH-SE	Hold	DQS and Clock	DQ <sup>2</sup>
tDS-SE(base)	DDR Setup-SE	DQS and DQ	NA
tDS-SE(derated)	DDR Setup-SE	DQS and DQ	NA
tDSS-SE	Setup	DQS and Clock	DQ <sup>2</sup>
<b>Slew Rate DQ</b>			
Slew Rate-Setup-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>2</sup>
Slew Rate-Setup-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>2</sup>
Slew Rate-Hold-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>2</sup>
Slew Rate-Hold-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>2</sup>
tWPRE	DDR tRPRE	DQS	DQ <sup>2</sup>
tWPST	DDR tPST	DQS	DQ <sup>2</sup>
<b>Read Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
<b>Differential DQS</b>			
tAC-Diff	DDR Setup-Diff	DQ and Clock	DQS <sup>2</sup>
tDQSQ-Diff	Setup	DQS and DQ	NA
tQH	Hold	DQS and DQ	NA
tDVAC(DQS)	Time Outside Level	DQS	DQ
<b>Single Ended DQS</b>			
tDQSK-SE	Skew	DQS and Clock	NA
tDQSQ-SE	Setup	DQ and DQS	NA
tRPRE	DDR tRPRE	DQS	DQ <sup>2</sup>
tWPRE	DDR tPST	DQS	DQ <sup>2</sup>
Vox(ac)DQS	V-Diff-Xovr	DQS, DQS#	DQ
<b>Clock (Diff)</b>			



DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tCH(abs)	Pos Width	Clock	NA
tCH(avg)	DDR tCH(avg)	Clock	NA
tCK(abs)	Period	Clock	NA
tCK(avg)	DDR tCK(avg)	Clock	NA
tCL(abs)	Neg Width	Clock	NA
tCL(avg)	DDR tCL(avg)	Clock	NA
tDVAC(CK)	Time Outside Level	CK	NA
tERR(11–50per)	DDR tERR(m–n)	Clock	NA
tERR(2per)	DDR tERR(n)	Clock	NA
tERR(3per)	DDR tERR(n)	Clock	NA
tERR(4per)	DDR tERR(n)	Clock	NA
tERR(5per)	DDR tERR(n)	Clock	NA
tERR(6–10per)	DDR tERR(m–n)	Clock	NA
tHP	Period	Clock	NA
tJIT(cc)	CC–Period	Clock	NA
tJIT(duty)	DDR tJIT(duty)	Clock	NA
tJIT(per)	DDR tJIT(per)	Clock	NA
VID(ac)	DDR VID(ac)	Clock	NA
<b>Clock (Single Ended)</b>			
AC-Overshoot(CK#)	Overshoot	Clock#	NA
AC-Overshoot(CK)	Overshoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock	NA
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-Undershoot(CK#)	Undershoot	Clock#	NA
AC-Undershoot(CK)	Undershoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock	NA
AC-UndershootArea(CK)	DDR Under Area	Clock	NA
Vix(ac)CK	V–Diff–Xovr	Clock and Clock#	NA
Vox(ac)CK	V–Diff–Xovr	Clock and Clock#	NA
VSWING(MAX)CK	Cycle Pk-Pk	Clock	NA
VSWING(MAX)CK#	Cycle Pk-Pk	Clock	NA
<b>DQS (Single Ended)</b>			
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQS)	Overshoot	DQS	DQ
AC-Undershoot(DQS)	Undershoot	DQS	DQ

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
Vix(ac)DQS	V-Diff-Xovr	DQS and DQS#	DQ <sup>2</sup>
VSWING(MAX)DQS	Cycle Pk-Pk	DQS	DQ <sup>2</sup>
VSWING(MAX)DQS#	Cycle Pk-Pk	DQS#	DQ <sup>2</sup>
<b>DQS (Single Ended, Read)</b>			
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Overshoot(DQS)	Overshoot	DQS	DQ <sup>2</sup>
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>2</sup>
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
AC-Undershoot(DQS)	Undershoot	DQS	DQ <sup>2</sup>
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>2</sup>
Vox(ac)DQS	V-Diff-Xovr	DQS, DQS#	DQ
<b>Precharge</b>			
tRP(MRS)	tCMD-CMD	Bus, CK	NA
tRP(REF)	tCMD-CMD	Bus, CK	NA
<b>Address/Command Measurements</b>			
AC-Overshoot	Overshoot	Addr/Cmd	NA
AC-OvershootArea	DDR Over Area	Addr/Cmd	NA
AC-Undershoot	Undershoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA
InputSlew-Diff-Fall(CK)	Fall Slew Rate	Clock	NA
InputSlew-Diff-Rise(CK)	Rise Slew Rate	Clock	NA
Slew Rate-Hold-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Hold-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
Slew Rate-Setup-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
tIH(base)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(derated)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIPW-High	Pos Width	Clock and Addr/Cmd	NA
tIPW-Low	Neg Width	Clock and Addr/Cmd	NA
tIS(base)	DDR Setup-Diff	Clock and Addr/Cmd	NA
tIS(derated)	DDR Setup-Diff	Clock and Addr/Cmd	NA

## DDR3 measurement sources

The sources required for analysis may include DQS(Strobe), DQ(Data), DQS# (Strobe), Clock, Clock#, and Addr/Cmd. Clock and DQS can be either Single-Ended (SE) or Differential (Diff). CS Source is available, as appropriate, as an optional qualifier.

The following table lists the sources required for each DDR3 measurement:

**Table 18: DDR3 measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
<b>Differential DQS</b>			
InputSlew-Diff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>4</sup>
InputSlew-Diff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>3</sup>
tDH-Diff(base)	DDR Hold-Diff	DQS and DQ	NA
tDH-Diff(derated)	DDR Hold-Diff	DQS and DQ	NA
tDQSH	Pos Width	DQS	DQ <sup>3</sup>
tDQSL	Neg Width	DQS	DQ <sup>3</sup>
tDQSS-Diff	Skew	DQS and Clock	DQ <sup>3</sup>
tDS-Diff(base)	DDR Setup-Diff	DQS and DQ	NA
tDS-Diff(derated)	DDR Setup-Diff	DQ and DQS	NA
tDSH-Diff	Hold	DQS and Clock	DQ <sup>3</sup>
tDSS-Diff	Setup	DQS and Clock	DQ <sup>3</sup>
tDVAC(DQS)	Time Outside Level	DQS	DQ
<b>Single Ended DQS</b>			
tDIPW-SE	Period	DQ	DQS <sup>3</sup>
tDQSS-SE	Skew	DQS and Clock	DQ <sup>3</sup>
tDSH-SE	Hold	DQS and Clock	DQ <sup>3</sup>

<sup>4</sup> Required so that the Search-and-Mark feature can properly identify bursts

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tDSS-SE	Setup	DQS and Clock	DQ <sup>3</sup>
<b>Slew Rate DQ</b>			
Slew Rate-Hold-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>3</sup>
Slew Rate-Hold-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>3</sup>
Slew Rate-Setup-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>3</sup>
Slew Rate-Setup-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>3</sup>
tWPRE	DDR tWPRE	DQS	DQ <sup>3</sup>
tWPST	DDR tPST	DQS	DQ <sup>3</sup>
<b>Read Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
<b>Differential DQS</b>			
SRQdiff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>3</sup>
SRQdiff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>3</sup>
tDQSCK-Diff	Skew	DQS and Clock	DQ <sup>3</sup>
tDQSQ-Diff	Setup	DQS and DQ	NA
tQH	Hold	DQ and DQS	NA
tDVAC(DQS)	Time Outside Level	DQS	DQ
tRPRE	DDR tRPRE	DQS	DQ <sup>3</sup>
tRPST	DDR tPST	DQS	DQ <sup>3</sup>
tQSH	Pos Width	DQS	DQ <sup>3</sup>
tQSL	Neg Width	DQS	DQ <sup>3</sup>
<b>Clock (Diff)</b>			
tCH(abs)	Pos Width	Clock	NA
tCH(avg)	DDR tCH(avg)	Clock	NA
tCK(abs)	Period	Clock	NA
tCK(avg)	DDR tCK(avg)	Clock	NA
tCL(abs)	Neg Width	Clock	NA
tCL(avg)	DDR tCL(avg)	Clock	NA
tDVAC(CK)	Time Outside Level	CK	NA
tERR	DDR tERR	Clock	NA
tJIT(cc)	CC-Period	Clock	NA
tJIT(duty)	DDR tJIT(duty)	Clock	NA
tJIT(per)	DDR tJIT(per)	Clock	NA
<b>Clock (Single Ended)</b>			
AC-Overshoot(CK#)	Overshoot	Clock#	NA
AC-Overshoot(CK)	Overshoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock#	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-Undershoot(CK#)	Undershoot	Clock#	NA
AC-Undershoot(CK)	Undershoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock#	NA
AC-UndershootArea(CK)	DDR Under Area	Clock	NA
Vix(ac)CK	DDR3 Vix(ac)	Clock and Clock#	NA
VSEH(AC)CK#	Cycle Max	Clock#	NA
VSEH(AC)CK	Cycle Max	Clock	NA
VSEH(CK#)	Cycle Max	Clock#	NA
VSEH(CK)	Cycle Max	Clock	NA
VSEL(AC)CK#	Cycle Min	Clock#	NA
VSEL(AC)CK	Cycle Min	Clock	NA
VSEL(CK#)	Cycle Min	Clock#	NA
VSEL(CK)	Cycle Min	Clock	NA
<b>DQS (Single Ended)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	NA
AC-UndershootArea(DQ)	DDR Under Area	DQ	NA
AC-Overshoot(DQ)	Overshoot	DQ	NA
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Overshoot(DQS)	Overshoot	DQS	DQ <sup>3</sup>
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>3</sup>
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
AC-Undershoot(DQS)	Undershoot	DQS	DQ <sup>3</sup>
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>3</sup>
Vix(ac)DQS	DDR3 Vix(ac)	DQS and DQS#	DQ <sup>3</sup>
VSEH(DQS#)	Cycle Max	DQS#	DQ <sup>3</sup>
VSEH(DQS)	Cycle Max	DQS	DQ <sup>3</sup>
VSEL(DQS#)	Cycle Min	DQS#	DQ <sup>3</sup>
VSEL(DQS)	Cycle Min	DQS	DQ <sup>3</sup>
<b>DQS (Single Ended, Read)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ
AC-Overshoot(DQS)	Overshoot	DQS	DQ
AC-Undershoot(DQS)	Undershoot	DQS	DQ
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
<b>Precharge</b>			
tRP(ACT)	tCMD-CMD	Bus, CK	NA
tRP(MRS)	tCMD-CMD	Bus, CK	NA
<b>Address/Command Measurements</b>			
AC-Overshoot	Overshoot	Addr/Cmd	NA
AC-OvershootArea	DDR Over Area	Addr/Cmd	NA
AC-Undershoot	Undershoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA
Slew Rate-Hold-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Hold-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
tIH(base)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(derated)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIPW-High	Pos Width	Addr/Cmd	NA
tIPW-Low	Neg Width	Addr/Cmd	NA
tIS(base)	DDR Setup-Diff	Clock and Addr/Cmd	NA
tIS(derated)	DDR Setup-Diff	Clock and Addr/Cmd	NA

## DDR3L measurement sources

The sources required for analysis may include DQS (Strobe), DQS# (Strobe), DQ (Data), Clock, Clock #, and Addr/Cmd. Clock and DQS can be either Single-Ended (SE) or Differential (Diff). Read and Write bursts have CS as an optional source.

The following table lists the sources required for each DDR3L measurement:

**Table 19: DDR3L measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
tWPRE	DDR tRPRE	DQS	DQ <sup>5</sup>
tWPST	DDR tPST	DQS	DQ <sup>4</sup>
<b>Differential DQS</b>			
InputSlew-Diff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>4</sup>
InputSlew-Diff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>4</sup>
tDH-Diff(base)	DDR Hold-Diff	DQS and DQ	NA
tDH-Diff(derated)	DDR Hold-Diff	DQS and DQ	NA
tDQSH	Pos Width	DQS and DQ	NA
tDQSL	Neg Width	DQS and DQ	NA
tDQSS-Diff	Skew	DQS and Clock	DQ <sup>4</sup>
tDS-Diff(base)	DDR Setup-Diff	DQS and DQ	NA
tDS-Diff(derated)	DDR Setup-Diff	DQS and DQ	NA
tDSH-Diff	Hold	DQS and Clock	DQ <sup>4</sup>
tDSS-Diff	Setup	DQS and Clock	DQ <sup>4</sup>
tDVAC(DQS)	Time Outside Level	DQS	DQ <sup>4</sup>
<b>Single Ended DQS</b>			
tDIPW-SE	Period	DQ	DQS <sup>4</sup>
tDQSS-SE	Skew	DQS and Clock	DQ <sup>4</sup>
tDSH-SE	Hold	DQS and Clock	DQ <sup>4</sup>
tDSS-SE	Setup	DQS and Clock	DQ <sup>4</sup>
<b>Slew Rate DQ</b>			
Slew Rate-Hold-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>4</sup>
Slew Rate-Hold-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>4</sup>
Slew Rate-Setup-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>4</sup>
Slew Rate-Setup-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>4</sup>
<b>Read Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA

<sup>5</sup> Required so that the Search-and-Mark feature can properly identify bursts

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
Data Eye Height	Eye Height	DQS and DQ	NA
tRPRE	DDR tRPRE	DQS	DQS <sup>4</sup>
tRPST	DDR tRPST	DQS	DQS <sup>4</sup>
<b>Differential DQS</b>			
SRQdiff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>4</sup>
SRQdiff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>4</sup>
tDQSCK-Diff	Skew	DQS and Clock	DQ <sup>4</sup>
tDQSQ-Diff	Setup	DQS and DQ	NA
tQH	Hold	DQS and DQ	NA
tDVAC(DQS)	Time Outside Level	DQS	DQ <sup>4</sup>
tAC-Diff	DDR Setup-Diff	DQ and Clock	DQS <sup>4</sup>
tQSH	Pos Width	DQS	DQ <sup>4</sup>
tQSL	Neg Width	DQS	DQ <sup>4</sup>
<b>Slew Rate DQ</b>			
SRQse-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>4</sup>
SRQse-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>4</sup>
<b>Clock (Diff)</b>			
Clock Eye Height	Height	Clock	NA
Clock Eye Width	Width	Clock	NA
InputSlew-Diff-Fall(CK)	Fall Slew Rate	Clock	NA
InputSlew-Diff-Rise(CK)	Rise Slew Rate	Clock	NA
tCH(abs)	Pos Width	Clock	NA
tCH(avg)	DDR tCH(avg)	Clock	NA
tCK(abs)	Period	Clock	NA
tCK(avg)	DDR tCK(avg)	Clock	NA
tCL(abs)	Neg Width	Clock	NA
tCL(avg)	DDR tCL(avg)	Clock	NA
tDVAC(CK)	Time Outside Level	Clock	NA
tERR	DDR tERR	Clock	NA
tJIT(cc)	CC-Period	Clock	NA
tJIT(duty)	DDR tJIT(duty)	Clock	NA
tJIT(per)	DDR tJIT(per)	Clock	NA
<b>Clock (Single Ended)</b>			
AC-Overshoot(CK#)	Overshoot	Clock#	NA
AC-Overshoot(CK)	Overshoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock#	NA
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-Undershoot(CK#)	Undershoot	Clock#	NA



DDR measurements	DPOJET base measurement	Performed on	Additional required sources
AC-Undershoot(CK)	Undershoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock#	NA
AC-UndershootArea(CK)	DDR Under Area	Clock	NA
Vix(ac)CK	DDR3 Vix(ac)	Clock and Clock#	NA
VSEH(AC)CK#	Cycle Max	Clock#	NA
VSEH(AC)CK	Cycle Max	Clock	NA
VSEH(CK#)	Cycle Max	Clock#	NA
VSEH(CK)	Cycle Max	Clock	NA
VSEL(AC)CK#	Cycle Min	Clock#	NA
VSEL(AC)CK	Cycle Min	Clock	NA
VSEL(CK#)	Cycle Min	Clock#	NA
VSEL(CK)	Cycle Min	Clock	NA
<b>DQS (Single Ended)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Overshoot(DQS)	Overshoot	DQS	DQ <sup>4</sup>
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>4</sup>
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
AC-Undershoot(DQS)	Undershoot	DQS	DQ <sup>4</sup>
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>4</sup>
Vix(ac)DQS	DDR3 Vix(ac)	DQS and DQS#	DQ <sup>4</sup>
VSEH(DQS#)	Cycle Max	DQS#	DQ, DQS
VSEH(DQS)	Cycle Max	DQS	DQ <sup>4</sup>
VSEL(DQS#)	Cycle Min	DQS#	DQ, DQS
VSEL(DQS)	Cycle Min	DQS	DQ <sup>4</sup>
<b>DQS (Single Ended, Read)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ
AC-Overshoot(DQS)	Overshoot	DQS	DQ

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
AC-Undershoot(DQS)	Undershoot	DQS	DQ
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
<b>Address/Command Measurements</b>			
AC-Overshoot	Overshoot	Addr/Cmd	NA
AC-OvershootArea	DDR Over Area	Addr/Cmd	NA
AC-Undershoot	Undershoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA
Slew Rate-Hold-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Hold-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
tIH(base)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(derated)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIPW-High	Pos Width	Clock and Addr/Cmd	NA
tIPW-Low	Neg Width	Clock and Addr/Cmd	NA
tIS(base)	DDR Setup-Diff	Clock and Addr/Cmd	NA
tIS(derated)	DDR Setup-Diff	Clock and Addr/Cmd	NA

## DDR4 measurement sources

The sources required for analysis may include DQS (Strobe), DQS# (Strobe), DQ (Data) , Clock, Clock #, and Addr/Cmd. Clock and DQS can be either Single-Ended (SE) or Differential (Diff). Read and Write bursts have CS as an optional source.

The following table lists the sources required for each DDR4 measurement:

**Table 20: DDR4 measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
DDRARX Mask	Mask Hits	DQS and DQ	NA
tWPRE	DDR tRPRE	DQS	DQ <sup>6</sup>
tWPST	DDR tPST	DQS	DQ <sup>5</sup>
VIHL_AC	Cycle Pk-Pk	DQ	DQS <sup>5</sup>
<b>Differential DQS</b>			
srf1	Fall Slew Rate1	DQ	DQS <sup>5</sup>
srr1	Rise Slew Rate1	DQ	DQS <sup>5</sup>
TdIPW-High	Pos Width	DQ	DQS <sup>5</sup>
TdIPW-Low	Neg Width	DQ	DQS <sup>5</sup>
tDQSH	Pos Width	DQS	DQ <sup>5</sup>
tDQSL	Neg Width	DQS	DQ <sup>5</sup>
tDQSS-Diff	Skew	Clock and DQS	DQ <sup>5</sup>
tDSH-Diff	Hold	Clock and DQS	DQ <sup>5</sup>
tDSS-Diff	Setup	Clock and DQS	DQ <sup>5</sup>
tDVAC(DQS)	Time Outside Level	DQS	DQ <sup>5</sup>
<b>Read Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
tRPRE	DDR tRPRE	DQS	DQ <sup>5</sup>
tRPST	DDR tRPST	DQS	DQ <sup>5</sup>
<b>Differential DQS</b>			
SRQdiff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>5</sup>
SRQdiff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>5</sup>
tDQSCK-Diff	Skew	DQS and Clock	DQ <sup>5</sup>
tDQSQ-Diff	Setup	DQS and DQ	NA
tDVAC(DQS)	Time Outside Level	DQS	DQ <sup>5</sup>
tHZ(DQ)	DDR tHZDQ	Clock and DQ	DQS <sup>5</sup>

<sup>6</sup> Required so that the Search-and-Mark feature can properly identify bursts

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tLZ(DQ)	DDR tLZDQ	Clock and DQ	DQS <sup>5</sup>
tQH	Hold	DQS and DQ	NA
tQSH	Pos Width	DQS	DQ <sup>5</sup>
tQSL	Neg Width	DQS	DQ <sup>5</sup>
<b>Single Ended DQS</b>			
tHZ(DQS)	DDR tHZDQ	DQS and Clock	DQ <sup>5</sup>
tLZ(DQS)	DDR tLZDQ	DQS and Clock	DQ <sup>5</sup>
<b>Slew Rate DQ</b>			
SRQse-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>5</sup>
SRQse-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>5</sup>
<b>Clock (Diff)</b>			
Clock Eye Height	Eye Height	Clock	NA
Clock Eye Width	Eye Width	Clock	NA
InputSlew-Diff-Fall(CK)	Fall Slew Rate	Clock	NA
InputSlew-Diff-Rise(CK)	Rise Slew Rate	Clock	NA
tCH(abs)	Pos Width	Clock	NA
tCH(avg)	DDR tCH(avg)	Clock	NA
tCK(abs)	Period	Clock	NA
tCK(avg)	DDR tCK(avg)	Clock	NA
tCL(abs)	Neg Width	Clock	NA
tCL(avg)	DDR tCL(avg)	Clock	NA
tDVAC(CK)	Time Outside Level	Clock	NA
tERR	DDR tERR(n)	Clock	NA
tJIT(cc)	CC-Period	Clock	NA
tJIT(duty)	DDR tJIT(duty)	Clock	NA
tJIT(per)	DDR tJIT(per)	Clock	NA
<b>Clock (Single Ended)</b>			
AC-Overshoot(CK#)	Overshoot	Clock#	NA
AC-Overshoot(CK)	Overshoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock#	NA
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-Undershoot(CK#)	Undershoot	Clock#	NA
AC-Undershoot(CK)	Undershoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock#	NA
AC-UndershootArea(CK)	DDR Under Area	Clock	NA
Vix(ac)CK	DDR3 Vix(ac)	Clock and Clock#	NA
VSEH(CK#)	Cycle Max	Clock#	NA
VSEH(CK)	Cycle Max	Clock	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
VSEL(CK#)	Cycle Min	Clock#	NA
VSEL(CK)	Cycle Min	Clock	NA
<b>DQS (Single Ended)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Overshoot(DQS)	Overshoot	DQS	DQ <sup>5</sup>
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>5</sup>
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
AC-Undershoot(DQS)	Undershoot	DQS	DQ <sup>5</sup>
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>5</sup>
Vix(ac)DQS	DDR3 Vix(ac)	DQS and DQS#	DQ <sup>5</sup>
VSEH(DQS#)	Cycle Max	DQS#	DQ, DQS
VSEH(DQS)	Cycle Max	DQS	DQ <sup>5</sup>
VSEL(DQS#)	Cycle Min	DQS#	DQ, DQS
VSEL(DQS)	Cycle Min	DQS	DQ <sup>5</sup>
<b>Address/Command Measurements</b>			
AC-Overshoot	Overshoot	Addr/Cmd	NA
AC-Overshoot(AbsMax)	Overshoot	Addr/Cmd	NA
AC-OvershootArea	DDR Over Area	Addr/Cmd	NA
AC-OvershootArea(AbsMax)	DDR Over Area	Addr/Cmd	NA
AC-Undershoot	Undershoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA
SRIN_c VW_Fall	Fall Slew Rate	Addr/Cmd	NA
SRIN_c VW-Rise	Rise Slew Rate	Addr/Cmd	NA
tIH(base) <sup>7</sup>	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(Vref) <sup>8</sup>	DDR Hold-Diff(Vref)	Clock and Addr/Cmd	NA
tIPW-High	Pos Width	Addr/Cmd	NA
tIPW-Low	Neg Width	Addr/Cmd	NA
tIS(base) <sup>9</sup>	DDR Setup-Diff	Clock and Addr/Cmd	NA
tIS(Vref) <sup>10</sup>	DDR Setup-Diff(Vref)	Clock and Addr/Cmd	NA

<sup>7</sup> tIH(base) : Command and Address hold time to CK\_t, CK\_c referenced to Vih(ac) / Vil(ac) levels. It uses the DPOJET measurement DDR Hold-Diff.

<sup>8</sup> tIH(Vref) : Command and Address hold time to CK\_t, CK\_c referenced to Vref levels. It uses the DPOJET measurement DDR Hold-Diff(Vref).

<sup>9</sup> tIS(base) : Command and Address setup time to CK\_t, CK\_c referenced to Vih(ac) / Vil(ac) levels. It uses the DPOJET measurement DDR Setup-Diff.

<sup>10</sup> tIS(Vref) : Command and Address setup time to CK\_t, CK\_c referenced to Vref levels. It uses the DPOJET measurement DDR Setup-Diff(Vref).

## GDDR5 measurement sources

The sources required for analysis may include DQ, WCK, WCK#, CK, CK#, WE, CS, CAS, RAS, CKE, and Addr/Cmd.

The following table lists the sources required for each GDDR5 measurement:

**Table 21: GDDR5 measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQ and WCK	NA
Data Eye Height	Eye Height	DQ and WCK	NA
tWRPDE	tBurstToCMD	Clock	WE, CS, CAS, RAS, CKE
tWRSRE	tBurstToCMD	Clock	WE, CS, CAS, RAS, CKE
<b>Read Bursts</b>			
Data Eye Height	Eye Height	DQ and WCK	NA
Data Eye Width	Eye Width	DQ and WCK	NA
tRDPDE	tBurstToCMD	Clock	WE, CS, CAS, RAS, CKE
tRDSRE	tBurstToCMD	Clock	WE, CS, CAS, RAS, CKE
<b>WCK (Single Ended)</b>			
Vin(WCK#)	High-Low	WCK#	NA
VIN(WCK)	High-Low	WCK	NA
Vix(ac)WCK	V-Diff-Xovr	WCK, WCK#	NA
VOH(WCK#)	High	WCK#	NA
VOH(WCK)	High	WCK	NA
VOL(WCK#)	Low	WCK#	NA
VOL(WCK)	Low	WCK	NA
WCK Slew-Fall(WCK#)	Fall Slew Rate	WCK#	NA
WCK Slew-Fall(WCK)	Fall Slew Rate	WCK	NA
WCK Slew-Rise(WCK#)	Rise Slew Rate	WCK#	NA
WCK Slew-Rise(WCK)	Rise Slew Rate	WCK	NA
<b>WCK (Diff)</b>			
SSC Downspread(WCK)	SSC-Freq-DEV	WCK	NA
SSC Mod Freq(WCK)	SSC-MOD-FREQ	WCK	NA
SSC Profile(WCK)	SSC-PROFILE	WCK	NA
tDVAC(WCK)	Time Outside Level	WCK	NA
tJIT(cc)	CC-Period	WCK	NA
tJIT(per)	DDR tJIT(per)	WCK	NA
tWCK	Period	WCK	NA
tWCK-DJ	TJ@BER	WCK	NA
tWCK-Fall-Slew	Fall Slew Rate	WCK	NA
tWCKH	Pos and Neg Width	WCK	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tWCKHP	Period	WCK	NA
tWCKL	Pos and Neg Width	WCK	NA
tWCK-Rise-Slew	Rise Slew Rate	WCK	NA
tWCK-RJ	RJ	WCK	NA
tWCK-TJ	TJ@BER	WCK	NA
VWCK-SWING	High-Low	WCK	NA
<b>Clock(Diff)</b>			
SSC Downspread(CK)	SSC-FREQ-DEV	Clock	NA
SSC Mod Freq(CK)	SSC-MOD-FREQ	Clock	NA
SSC Profile(CK)	SSC-PROFILE	Clock	NA
tCH	Pos Width	Clock	NA
tCK	Period	Clock	NA
tCL	Neg Width	Clock	NA
tDVAC(CK)	Time Outside Level	Clock	NA
tHP	Period	Clock	NA
tJIT(cc)	CC-Period	Clock	NA
tJIT(per)	DDR tJIT(per)	Clock	NA
<b>Clock(Single Ended)</b>			
CKslew-Fall(CK#)	Fall Slew Rate	Clock#	NA
CKslew-Fall(CK)	Fall Slew Rate	Clock	NA
CKslew-Rise(CK#)	Rise Slew Rate	Clock#	NA
CKslew-Rise(CK)	Rise Slew Rate	Clock	NA
VIN(CK#)	High-Low	Clock#	NA
VIN(CK)	High-Low	Clock	NA
Vix(ac)CK	V-Diff-Xovr	Clock and Clock#	NA
<b>Address/Command Measurements</b>			
tAH	Hold	Clock, Addr./Cmd	NA
tAPW	Period	Addr/Cmd	NA
tAS	Setup	Clock, Addr./Cmd	NA
tCMDH	Hole	Clock, Addr./Cmd	NA
tCMDPW	Period	Clock, Addr./Cmd	NA
tCMDS	Setup	Clock, Addr./Cmd	NA
<b>Refresh</b>			
tCKSRE	tCKSRE	Clock	WE, CS, CAS, RAS, CKE
tCKSRX	tCKSRX	Clock	WE, CS, CAS, RAS, CKE
tREFTR(Read)	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tREFTR(Write)	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRFC	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tXSNRW	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
<b>Power Down</b>			
tPD	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
<b>Active</b>			
tRAS	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRC	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRCDRD	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRCDWR	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
<b>Precharge</b>			
tPPD	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRP(ACT)	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRP(MRS)	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRP(REP)	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRP(SRE)	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE
tRTPL	tCMD-CMD	Clock	WE, CS, CAS, RAS, CKE

## LPDDR measurement sources

The sources required for analysis may include DQS (Strobe), DQS# (Strobe), DQ (Data) , Clock, Clock #, and Addr/Cmd. Clock and DQS can be either Single-Ended (SE) or Differential (Diff). Read and Write bursts have CS as an optional source.

The following table lists the sources required for each LPDDR measurement:

**Table 22: LPDDR measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
tWPRE	DDR tRPRE	DQS	DQ <sup>10</sup>
tWPST	DDR tPST	DQS	DQ <sup>10</sup>
<b>Differential DQS</b>			
tDH-Diff(base)	DDR Hold-Diff	DQS and DQ	NA
tDQSH	Pos Width	DQS and DQ	NA
tDQSL	Neg Width	DQS and DQ	NA
tDS-Diff(base)	DDR Setup-Diff	DQS and DQ	NA
tDSH-Diff	Hold	DQS and Clock	DQ <sup>11</sup>
tDSS-Diff	Setup	DQS and Clock	DQ <sup>10</sup>
<b>Single Ended DQS</b>			

<sup>11</sup> Required so that the Search-and-Mark feature can properly identify bursts



DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tDH-SE	DDR Hold-SE	DQ and DQS	NA
tDIPW-SE	Period	DQ	DQS <sup>10</sup>
tDSH-SE	Hold	DQS and Clock	DQ <sup>10</sup>
tDSS-SE	Setup	DQS and Clock	DQ <sup>10</sup>
tDS-SE	DDR Setup-SE	DQS and DQ	NA
<b>Read Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
tRPRE	DDR tRPRE	DQS	DQ <sup>10</sup>
tRPST	DDR tRPST	DQS	DQ <sup>10</sup>
Differential DQS			
tAC-Diff	DDR Setup-Diff	DQ and Clock	DQS <sup>10</sup>
tDQSCK-Diff	Skew	DQS and Clock	DQ <sup>10</sup>
tQH	Hold	DQS and DQ	NA
Single Ended DQS			
tDQSQ-SE	Setup	DQS and DQ	NA
<b>Clock (Diff)</b>			
Clock Eye Height	Height	Clock	NA
Clock Eye Width	Width	Clock	NA
tCH	Pos Width	Clock	NA
tCK	Period	Clock	NA
tCL	Neg Width	Clock	NA
tHP	Period	Clock	NA
VID(ac)	DDR VID(ac)	Clock	NA
<b>Clock (Single Ended)</b>			
AC-Overshoot(CK#)	Overshoot	Clock#	NA
AC-Overshoot(CK)	Overshoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock#	NA
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-Undershoot(CK#)	Undershoot	Clock#	NA
AC-Undershoot(CK)	Undershoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock#	NA
AC-Undershoot Area(CK)	DDR Under Area	Clock	NA
Vix(ac)CK	V-Diff-Xovr	Clock and Clock#	NA
<b>DQS (Single Ended, Write)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-Overshoot(DQS)	Overshoot	DQS	DQ <sup>10</sup>
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>10</sup>
AC-Undershoot(DQS)	Undershoot	DQS	DQ <sup>10</sup>
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>10</sup>
<b>DQS (Single Ended, Read)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ
AC-Overshoot(DQS)	Overshoot	DQS	DQ
AC-Undershoot(DQS)	Undershoot	DQS	DQ
<b>Address/Command</b>			
AC-Overshoot	Overshoot	Addr/Cmd	NA
AC-Overshoot	DDR Over Area	Addr/Cmd	NA
AC-Undershoot	Undershoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA
tIH(base)	DDR Hold–Diff	Clock and Addr/Cmd	NA
tIPW-High	Pos Width	Clock and Addr/Cmd	NA
tIPW-Low	Neg Width	Clock and Addr/Cmd	NA
tIS(base)	DDR Setup–Diff	Clock and Addr/Cmd	NA

## LPDDR2 measurement sources

The sources required for analysis may include DQS (Strobe), DQS# (Strobe), DQ (Data), Clock, Clock #, and Addr/Cmd. DQS and Clock can be either Single-Ended (SE) or Differential (Diff). Read and Write bursts have CS as an optional source.

The following table lists the sources required for each LPDDR2 measurement:

**Table 23: LPDDR2 measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
tDQSS		DQS and Bus (B1)	DQ
<b>Single Ended DQS</b>			
tDIPW-SE	Period	DQ	DQS
<b>Differential DQS</b>			

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
InputSlew-Diff-Fall(DQS)	Fall Slew Rate	DQS and DQ	NA
InputSlew-Diff-Rise(DQS)	Rise Slew Rate	DQ and DQS	NA
tDH-Diff(base)	DDR Hold-Diff	DQ	DQS <sup>12</sup>
tDH-Diff(derated)	DDR Hold-Diff	DQS and DQ	NA
tDH-Diff(Vref-based)	Hold	DQS and DQ	NA
tDQSH	Pos Width	DQS	DQ <sup>11</sup>
tDQSL	Neg Width	DQS	DQ <sup>11</sup>
tDS-Diff(base)	DDR Setup-Diff	DQS and DQ	NA
tDS-Diff(derated)	DDR Setup-Diff	DQS and Clock	DQ <sup>11</sup>
tDS-Diff(Vref-based)	Setup	DQS	DQ <sup>11</sup>
tDSH-Diff	Hold	DQS and Clock	DQ <sup>11</sup>
tDSS-Diff	Setup	DQS and Clock	DQ <sup>11</sup>
tDVAC(DQS)	Time Outside Level	DQS	DQ
<b>Slew Rate DQ</b>			
Slew Rate-Hold-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>11</sup>
Slew Rate-Hold-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>11</sup>
Slew Rate-Setup-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>11</sup>
Slew Rate-Setup-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>11</sup>
tWPRE	DDR tRPRE	DQS	DQ <sup>11</sup>
tWPST	DDRTpST	DQS	DQ <sup>11</sup>
<b>Read Bursts</b>			
<b>Differential DQS</b>			
SRQdiff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>11</sup>
SRQdiff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>11</sup>
tDQSQ-Diff	Setup	DQS and DQ	NA
tDVAC(DQS)	Time Outside Level	DQS	DQ
tQH	Hold	DQS and DQ	NA
<b>Slew Rate DQ</b>			
SRQse-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>11</sup>
SRQse-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>11</sup>
tRPRE	DDR tRPRE	DQS	DQ <sup>11</sup>
tRPST	DDRTpST	DQS	DQ <sup>11</sup>
<b>Clock (Diff)</b>			
tCH(abs)	Pos Width	Clock	NA
tCH(avg)	DDR tCH(avg)	Clock	NA
tCK(abs)	Period	Clock	NA

<sup>12</sup> Required so that the Search-and-Mark feature can properly identify bursts

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tCK(avg)	DDR tCK(avg)	Clock	NA
tCL(abs)	Neg Width	Clock	NA
tCL(avg)	DDR tCL(avg)	Clock	NA
tDVAC(CK)	Time Outside Level	Clock	NA
tERR	DDR tERR	Clock	NA
tJIT(cc)	CC-Period	Clock	NA
tJIT(duty)	DDR tJIT(duty)	Clock	NA
tJIT(per)	DDR tJIT(per)	Clock	NA
tHP	Period	Clock	NA
<b>Clock (Single Ended)</b>			
AC-OverShoot(CK#)	OverShoot	Clock#	NA
AC-OverShoot(CK)	OverShoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock#	NA
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-UnderShoot(CK#)	UnderShoot	Clock#	NA
AC-UnderShoot(CK)	UnderShoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock#	NA
AC-UndershootArea(CK)	DDR Under Area	Clock	NA
VIXCA	DDR3 Vix(ac)	Clock and Clock#	NA
VSEH(AC)CK	Cycle Max	Clock	NA
VSEH(AC)CK#	Cycle Max	Clock#	NA
VSEL(AC)CK	Cycle Min	Clock	NA
VSEL(AC)CK#	Cycle Min	Clock#	NA
<b>DQS (Single Ended)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-OverShoot(DQ)	OverShoot	DQ	DQS
AC-UnderShoot(DQ)	UnderShoot	DQ	DQS
AC-OverShoot(DQS#)	OverShoot	DQS#	DQ, DQS
AC-OverShoot(DQS)	OverShoot	DQS	DQ <sup>11</sup>
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>11</sup>
AC-UnderShoot(DQS#)	UnderShoot	DQS#	DQ, DQS
AC-UnderShoot(DQS)	UnderShoot	DQS	DQ <sup>11</sup>
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>11</sup>
VIXDQ	DDR3 Vix(ac)	DQS, DQS#	DQ
VSEH(AC)DQS	Cycle Max	DQS	DQ <sup>11</sup>

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
VSEH(AC)DQS#	Cycle Max	DQS#	DQ <sup>11</sup>
VSEL(AC)DQS	Cycle Min	DQS	DQ <sup>11</sup>
VSEL(AC)DQS#	Cycle Min	DQS#	DQ <sup>11</sup>
<b>DQS (Single Ended, Read)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ
AC-Overshoot(DQS)	Overshoot	DQS	DQ
AC-Undershoot(DQS)	Undershoot	DQS	DQ
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
<b>Precharge</b>			
tRTP	tCMD-CMD	Bus, Clock	NA
tRP	tCMD-CMD	Bus, Clock	NA
<b>Active</b>			
tRAS	tCMD-CMD	Bus, Clock	NA
tRC	tCMD-CMD	Bus, Clock	NA
tRCDRD	tCMD-CMD	Bus, Clock	NA
tRCDWR	tCMD-CMD	Bus, Clock	NA
<b>Address/Command</b>			
AC-OverShoot	OverShoot	Addr/Cmd	NA
AC-OvershootArea	DDR Over Area	Addr/Cmd	NA
AC-UnderShoot	UnderShoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA
InputSlew-Diff-Fall(CK)	Fall Slew Rate	Clock	NA
InputSlew-Diff-Rise(CK)	Rise Slew Rate	Clock	NA
Slew Rate-Hold-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Hold-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tIH(base)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(derated)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIPW-High	Pos Width	Clock and Addr/Cmd	NA
tIPW-Low	Neg Width	Clock and Addr/Cmd	NA
tIS(base)	DDR Setup-Diff	Clock and Addr/Cmd	NA
tIS(derated)	DDR Setup-Diff	Clock and Addr/Cmd	NA

## LPDDR3 measurement sources

The sources required for analysis may include DQS (Strobe), DQS# (Strobe), DQ (Data) , Clock, Clock #, and Addr/Cmd. Clock and DQS can be either Single-Ended (SE) or Differential (Diff). Read and Write bursts have CS as an optional source.

The following table lists the sources required for each LPDDR3 measurement:

**Table 24: LPDDR3 measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
tDQSS	DDR tDQSS	DQS and Bus (B1)	DQ
tWPRE	DDR tRPRE	DQS	DQ <sup>13</sup>
tWPST	DDR tPST	DQS	DQ <sup>12</sup>
<b>Differential DQS</b>			
InputSlew-Diff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>12</sup>
InputSlew-Diff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>12</sup>
tDH-Diff(base)	DDR Hold-Diff	DQS and DQ	NA
tDH-Diff(derated)	DDR Hold-Diff	DQS and DQ	NA
tDH-Diff(Vref-based)	Hold	DQS and DQ	NA
tDQSH	Pos Width	DQS and DQ	NA
tDQSL	Neg Width	DQS and DQ	NA
tDS-Diff(base)	DDR Setup-Diff	DQS and DQ	NA
tDS-Diff(derated)	DDR Setup-Diff	DQS and DQ	NA
tDS-Diff(Vref-based)	Setup	DQS and DQ	NA
tDSH-Diff	Hold	DQS and Clock	DQ <sup>12</sup>
tDSS-Diff	Setup	DQS and Clock	DQ <sup>12</sup>
tDVAC(DQS)	Time Outside Level	DQS	DQ <sup>12</sup>
TdIPW-High	Pos Width	DQ	DQS <sup>12</sup>
TdIPW-Low	Neg Width	DQ	DQS <sup>12</sup>

<sup>13</sup> Required so that the Search-and-Mark feature can properly identify bursts

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Slew Rate DQS</b>			
Slew Rate-Hold-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>12</sup>
Slew Rate-Hold-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>12</sup>
Slew Rate-Setup-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>12</sup>
Slew Rate-Setup-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>12</sup>
<b>Read Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
tRPRE	DDR tRPRE	DQS	DQ <sup>12</sup>
tRPST	DDR tRPST	DQS	DQ <sup>12</sup>
tDQCK	DDR2tDQCK	DQS and Clock	DQ <sup>12</sup>
<b>Differential DQS</b>			
SRQdiff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>12</sup>
SRQdiff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>12</sup>
tDQSQ-Diff	Setup	DQS and DQ	NA
tDVAC(DQS)	Time Outside Level	DQS	DQ <sup>12</sup>
tAC-Diff	DDR Setup-Diff	DQ and Clock	DQS <sup>12</sup>
tDQCK-Diff	Skew	DQS and Clock	DQ <sup>12</sup>
tQH	Hold	DQS and DQ	NA
tQSH	Pos Width	DQS	DQ <sup>12</sup>
tQSL	Neg Width	DQS	DQ <sup>12</sup>
<b>Slew Rate DQ</b>			
SRQse-Fall(DQ)	Fall Slew Rate	DQ	DQS <sup>12</sup>
SRQse-Rise(DQ)	Rise Slew Rate	DQ	DQS <sup>12</sup>
<b>Clock (Diff)</b>			
tCH(abs)	Pos Width	Clock	NA
tCH(avg)	DDR tCH(avg)	Clock	NA
tCK(abs)	Period	Clock	NA
tCK(avg)	DDR tCK(avg)	Clock	NA
tCL(abs)	Neg Width	Clock	NA
tCL(avg)	DDR tCL(avg)	Clock	NA
tDVAC(CK)	Time Outside Level	Clock	NA
tERR	DDR tERR	Clock	NA
tJIT(cc)	CC-Period	Clock	NA
tJIT(duty)	DDR tJIT(duty)	Clock	NA
tJIT(per)	DDR tJIT(per)	Clock	NA
InputSlew-Diff-Fall(CK)	Fall Slew Rate	Clock	NA
InputSlew-Diff-Rise(CK)	Rise Slew Rate	Clock	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Clock (Single Ended)</b>			
AC-OverShoot(CK#)	OverShoot	Clock#	NA
AC-OverShoot(CK)	OverShoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock#	NA
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-UnderShoot(CK#)	UnderShoot	Clock#	NA
AC-UnderShoot(CK)	UnderShoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock#	NA
AC-UndershootArea(CK)	DDR Under Area	Clock	NA
Vix(ac)CK	V-Diff-Xovr	Clock and Clock#	NA
VSEH(AC)CK#	Cycle Max	Clock#	NA
VSEH(AC)CK	Cycle Max	Clock	NA
VSEL(AC)CK#	Cycle Min	Clock#	NA
VSEL(AC)CK	Cycle Min	Clock	NA
<b>DQS (Single Ended)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-OverShoot(DQ)	OverShoot	DQ	DQS
AC-UnderShoot(DQ)	UnderShoot	DQ	DQS
AC-OverShoot(DQS#)	OverShoot	DQS#	DQ, DQS
AC-OverShoot(DQS)	OverShoot	DQS	DQ <sup>12</sup>
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>12</sup>
AC-UnderShoot(DQS#)	UnderShoot	DQS#	DQ, DQS
AC-UnderShoot(DQS)	UnderShoot	DQS	DQ <sup>12</sup>
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>12</sup>
Vix(ac)DQS	V-Diff-Xovr	DQS and DQS#	DQ <sup>12</sup>
VSEH(AC)DQS#	Cycle Max	DQS#	DQ <sup>12</sup>
VSEH(AC)DQS	Cycle Max	DQS	DQ <sup>12</sup>
VSEL(AC)DQS#	Cycle Min	DQS#	DQ <sup>12</sup>
VSEL(AC)DQS	Cycle Min	DQS	DQ <sup>12</sup>
<b>DQS (Single Ended, Read)</b>			
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ



DDR measurements	DPOJET base measurement	Performed on	Additional required sources
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ
AC-Overshoot(DQS)	Overshoot	DQS	DQ
AC-Undershoot(DQS)	Undershoot	DQS	DQ
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
<b>Address/Command</b>			
AC-OverShoot	OverShoot	Addr/Cmd	NA
AC-OvershootArea	DDR Over Area	Addr/Cmd	NA
AC-UnderShoot	UnderShoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA
Slew Rate-Hold-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Hold-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Fall(Addr/Cmd)	Fall Slew Rate	Addr/Cmd	NA
Slew Rate-Setup-Rise(Addr/Cmd)	Rise Slew Rate	Addr/Cmd	NA
tIH(base)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(base)CA	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(base)CS	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(derated)	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(derated)CA	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIH(derated)CS	DDR Hold-Diff	Clock and Addr/Cmd	NA
tIPW-High	Pos Width	Clock and Addr/Cmd	NA
tIPW-High(CA)	High Time	Addr/Cmd	NA
tIPW-High(CS)	High Time	Addr/Cmd	NA
tIPW-Low	Neg Width	Clock and Addr/Cmd	NA
tIPW-Low(CA)	Low Time	Addr/Cmd	NA
tIPW-Low(CS)	Low Time	Addr/Cmd	NA
tIS(base)CA	DDR Setup-Diff	Clock and Addr/Cmd	NA
tIS(base)CS	DDR Setup-Diff	Clock and Addr/Cmd	NA
tIH(derated)CA	DDR Setup-Diff	Clock and Addr/Cmd	NA
tIH(derated)CS	DDR Setup-Diff	Clock and Addr/Cmd	NA

## LPDDR4 measurement sources

The sources required for analysis may include DQS (Strobe), DQS# (Strobe), DQ (Data), Clock, Clock #, and Addr/Cmd. DQ and DQS can be either Single-Ended (SE) or Differential (Diff). Read and Write bursts have CS as an optional source.

The following table lists the sources required for each LPDDR4 measurement:

**Table 25: LPDDR4 measurement sources**

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>Write Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
DDRARXMask	Mask Hit	DQ and DQS	NA
SRIN_dIVW_Fall	Fall Slew Rate	DQ	DQS
SRIN_dIVW_Rise	Rise Slew Rate	DQ	DQS
TdIPW-High	Pos Width	DQ	DQS
TdIPW-Low	Neg Width	DQ	DQS
tDQS2DQ	DDR tDQS2DQ	DQS and DQ	NA
tDQSS	DDR tDQSS	DQS and Bus (B1)	DQ
tWPRE	LPDDR4tWPRE	DQS	DQ
tWPST	DDR tPST	DQS	DQ <sup>12</sup>
VIHL_AC	DDR VIHLAC	DQS and DQ	NA
<b>Differential DQS</b>			
InputSlew-Diff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>12</sup>
InputSlew-Diff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>12</sup>
tDQSH	Pos Width	DQS	DQ <sup>12</sup>
tDQSL	Neg Width	DQS	DQ <sup>12</sup>
tDSH-Diff	Hold	Clock and DQS	DQ <sup>12</sup>
tDSS-Diff	Setup	Clock and DQS	DQ <sup>12</sup>
<b>Read Bursts</b>			
Data Eye Width	Eye Width	DQS and DQ	NA
Data Eye Height	Eye Height	DQS and DQ	NA
tDQSCK	DDR2tDQSCK	DQS and Clock	DQ <sup>12</sup>
tQW_Total	Width	DQ and DQS	NA
tQW_Total-DBI	Width	DQ and DQS	NA
tRPRE	DDR tRPRE	DQS	DQ <sup>12</sup>
tRPST	DDR tRPST	DQS	DQ <sup>12</sup>
<b>Differential DQS</b>			
SRQdiff-Fall(DQS)	Fall Slew Rate	DQS	DQ <sup>12</sup>
SRQdiff-Rise(DQS)	Rise Slew Rate	DQS	DQ <sup>12</sup>
tDQSQ-DBI	Setup	DQ and DQS	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
tDQSQ-Diff	Setup	DQS and DQ	NA
tQH	Hold	DQS and DQ	NA
tQH_DBI	Hold	DQS and DQ	NA
tQSH	Pos Width	DQS	DQ <sup>12</sup>
tQSH_DBI	Pos Width	DQS	DQ <sup>12</sup>
tQSL	Neg Width	DQS	DQ <sup>12</sup>
tQSL_DBI	Neg Width	DQS	DQ <sup>12</sup>
Slew Rate DQ			
SRQse-Fall(DQ)	Fall Slew Rate	DQS	DQ <sup>12</sup>
SRQse-Rise(DQ)	Rise Slew Rate	DQS	DQ <sup>12</sup>
<b>Clock (Diff)</b>			
Clock Eye Height	Height	Clock	NA
Clock Eye Width	Width	Clock	NA
InputSlew_Diff_Fall(CK)	Fall Slew Rate	Clock	NA
InputSlew_Diff_Rise(CK)	Rise Slew Rate	Clock	NA
tCH(abs)	Pos Width	Clock	NA
tCH(avg)	DDR tCH(avg)	Clock	NA
tCK(abs)	Period	Clock	NA
tCK(avg)	DDR tCK(avg)	Clock	NA
tCL(abs)	Neg Width	Clock	NA
tCL(avg)	DDR tCL(avg)	Clock	NA
tJIT(cc)	CC-Period	Clock	NA
tJIT(duty)	DDR tJIT(duty)	Clock	NA
tJIT(per)	DDR tJIT(per)	Clock	NA
<b>Clock (Single Ended)</b>			
AC-OverShoot(CK#)	OverShoot	Clock#	NA
AC-OverShoot(CK)	OverShoot	Clock	NA
AC-OvershootArea(CK#)	DDR Over Area	Clock#	NA
AC-OvershootArea(CK)	DDR Over Area	Clock	NA
AC-UnderShoot(CK#)	Undershoot	Clock#	NA
AC-UnderShoot(CK)	Undershoot	Clock	NA
AC-UndershootArea(CK#)	DDR Under Area	Clock#	NA
AC-UndershootArea(CK)	DDR Under Area	Clock	NA
Vix(ac)CK	DDRVix	Clock and Clock#	NA
VSEH(CK#)	Cycle Max	Clock#	NA
VSEH(CK)	Cycle Max	Clock	NA
VSEL(CK#)	Cycle Min	Clock#	NA
VSEL(CK)	Cycle Min	Clock	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
<b>DQS (Single Ended, Write)</b>			
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQS , DQ
AC-Overshoot(DQS)	OverShoot	DQS	DQ
AC-Undershoot(DQ)	UnderShoot	DQ	DQS
AC-Overshoot(DQS#)	OverShoot	DQS#	DQ, DQS
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ <sup>12</sup>
AC-Undershoot(DQ)	UnderShoot	DQ	DQS
AC-Undershoot(DQS#)	UnderShoot	DQS#	DQ, DQS
AC-Undershoot(DQS)	Undershoot	DQS	DQ <sup>12</sup>
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQS, DQ
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>12</sup>
Vix(ac)DQS	DDRVix	DQS and DQS#	DQ <sup>12</sup>
VSEH(AC)DQS	Cycle Max	DQS	DQ <sup>12</sup>
VSEH(AC)DQS#	Cycle Max	DQS#	DQ, DQS
VSEL(AC)DQS	Cycle Min	DQS	DQ <sup>12</sup>
VSEL(AC)DQS#	Cycle Min	DQS#	DQ, DQS
<b>DQS (Single Ended, Read)</b>			
AC-Overshoot(DQ)	Overshoot	DQ	DQS
AC-Overshoot(DQS#)	Overshoot	DQS#	DQ, DQS
AC-Overshoot(DQS)	Overshoot	DQS	DQ <sup>12</sup>
AC-OvershootArea(DQ)	DDR Over Area	DQ	DQS
AC-Undershoot(DQ)	Undershoot	DQ	DQS
AC-OvershootArea(DQS#)	DDR Over Area	DQS#	DQ, DQS
AC-OvershootArea(DQS)	DDR Over Area	DQS	DQ
AC-Undershoot(DQS#)	Undershoot	DQS#	DQ, DQS
AC-Undershoot(DQS)	Undershoot	DQS	DQ <sup>12</sup>
AC-UndershootArea(DQ)	DDR Under Area	DQ	DQS
AC-UndershootArea(DQS#)	DDR Under Area	DQS#	DQ, DQS
AC-UndershootArea(DQS)	DDR Under Area	DQS	DQ <sup>12</sup>
<b>Address/Command</b>			
AC-OverShoot	OverShoot	Addr/Cmd	NA
AC-OvershootArea	DDR Over Area	Addr/Cmd	NA
AC-UnderShoot	UnderShoot	Addr/Cmd	NA
AC-UndershootArea	DDR Under Area	Addr/Cmd	NA

DDR measurements	DPOJET base measurement	Performed on	Additional required sources
DDRARXMask	Mask Hits	Addr/Cmd and Clock	NA
SRIN_cIVW_Fall	Fall Slew Rate	Addr/Cmd	NA
SRIN_cIVW_Rise	Rise Slew Rate	Addr/Cmd	NA
TCIPW-High	Pos Width	Addr/Cmd	NA
TCIPW-Low	Neg Width	Addr/Cmd	NA
VIHL_AC(CA)	DDR VIHLAC	Addr/Cmd	NA

## Measurement range limits

The following tables lists the measurement range limits of DDR measurements for different data rates:

**NOTE.** Measurement Range Limits are provided for each measurement under the General configure tab of the DPOJET application. These range limits are always ON (OFF is disabled) for two source measurements such as Skew, Setup, Hold and others. The range limits are used by the algorithms to associate valid edge of first source to the valid edge of the second source.

Data Rate	1 UI	2 UI
200 MT/s	5 ns	10 ns
266 MT/s	3.7594 ns	7.5188 ns
333 MT/s	3.003 ns	6.006 ns
370 MT/s	2.702 ns	5.404 ns
400 MT/s	2.5 ns	5 ns
533 MT/s	1.875 ns	3.75 ns
667 MT/s	1.4995 ns	2.999 ns
800 MT/s	1.25 ns	2.5 ns
1333 MT/s	0.75 ns	1.5 ns
1600 MT/s	0.625 ns	1.25 ns
1866 MT/s	0.535 ns	1.071 ns
2133 MT/s	0.468 ns	0.937 ns
2400 MT/s	416.66 ps	833.33 ps
3200 MT/s	312.5 ps	625 ps
4266 MT/s	234.41 ps	468.82 ps

The following measurements have different range limits as shown:

**Table 26: Measurement range limits**

Measurement	Maximum	Minimum
tDQSCK-Diff	UI	-UI
tDQSQ-Diff	UI / 2	-UI / 2
tAC-Diff	UI / 2	-UI / 2
tDQSCK-SE	UI	-UI

Measurement	Maximum	Minimum
tDQSQ-SE	UI / 2	-UI / 2
tDH-Diff(base)	UI	0
tDH-Diff(derated)	UI	0
tDQSS-Diff e	UI	-UI
tDS-Diff(base)	UI	0
tDS-Diff(derated)	UI	0
tDSH-Diff	2 UI	0
tDSS-Diff	2 UI	0
tDQSS-SE	UI	- UI
tDSH-SE	2 UI	0
tDSS-SE	2 UI	0
tDH-SE(base)	UI	0
tDH-SE(derated)	UI	0
tDS-SE(base)	UI	0
tDS-SE(derated)	UI	0
tIH(base)	2 UI	0
tIH(derated)	2 UI	0
tIS(base)	2 UI	0
tIS(derated)	2 UI	0
tQH	1.5 UI	UI / 2

## Dynamic limits for DDR measurements

The following table lists the dynamic limits for DDR measurements, which are common for all DDR data rates. For more details, refer to the DDR JEDEC standard specification.

**NOTE.** Dynamic limits are the same for all DDR data rates.

**Table 27: Dynamic limits for DDR**

Measurement	Dynamic limits		
	Min	Max	Units
tCH	0.45	0.55	tCK
tCL	0.45	0.55	tCK
Vix(ac)CK	$0.5 \cdot V_{dd} - 0.2$	$0.5 \cdot V_{dd} + 0.2$	-
Vix(ac)DQS	$0.5 \cdot V_{dd} - 0.2$	$0.5 \cdot V_{dd} + 0.2$	-
Vid(ac)	0.7	$V_{dd} + 0.6$	-

## Dynamic limits for DDR2 measurements

The following table lists the dynamic limits for DDR2 measurements. For more details, refer to the DDR2 JEDEC standard specification.

**NOTE.** Dynamic limits are the same for all DDR2 data rates except for those data rates specifically mentioned in the table.

**Table 28: Dynamic limits for DDR2**

Measurement	Data rate (MT/s)	Dynamic limits		
		Min	Max	Units
tCH(avg)	667, 800	0.48	0.52	tCK(avg)
tCL(avg)	667, 800	0.48	0.52	tCK(avg)
tCH(abs)	NA	0.45	0.55	-
tCL(abs)	NA	0.45	0.55	-
tIPW	NA	0.6	NA	-
Vix(ac)CK	NA	$0.5 \times V_{dd} - 0.175$	$0.5 \times V_{dd} + 0.175$	-
Vix(ac)DQS	NA	$0.5 \times V_{dd} - 0.175$	$0.5 \times V_{dd} + 0.175$	-
Vox(ac)CK	NA	$0.5 \times V_{dd} - 0.125$	$0.5 \times V_{dd} + 0.125$	-
Vox(ac)DQS	NA	$0.5 \times V_{dd} - 0.125$	$0.5 \times V_{dd} + 0.125$	-
Vid(ac)	NA	0.5	V <sub>dd</sub>	-

## Dynamic limits for DDR3 measurements

The following table lists the dynamic limits for DDR3 measurements. For more details, refer to the DDR3 JEDEC standard specification.

**NOTE.** Dynamic limits are the same for all DDR3 data rates.

**Table 29: Dynamic limits for DDR3**

Measurement	Dynamic limits		
	Min	Max	Units
tCH(avg)	$0.47 \times t_{CK}(avg)$	$0.53 \times t_{CK}(avg)$	tCK(avg)
tCL(avg)	$0.47 \times t_{CK}(avg)$	$0.53 \times t_{CK}(avg)$	tCK(avg)
tCH(abs)	$0.43 \times t_{CK}(avg)$	NA	tCK(avg)
tCL(abs)	$0.43 \times t_{CK}(avg)$	NA	tCK(avg)
VSEH(DQS)	$(V_{DDQ} / 2) + 0.175$	-	V
VSEH (DQS#)	$(V_{DDQ} / 2) + 0.175$	-	V
VSEH(CK)	$(V_{DDQ} / 2) + 0.175$	-	V
VSEH(CK#)	$(V_{DDQ} / 2) + 0.175$	-	V
VSEL(DQS)	-	$(V_{DDQ} / 2) - 0.175$	V
VSEL(DQS#)	-	$(V_{DDQ} / 2) - 0.175$	V

Measurement	Dynamic limits		
	Min	Max	Units
VSEL(CK)	-	$(VDDQ / 2) - 0.175$	V
VSEL(CK#)	-	$(VDDQ / 2) - 0.175$	V
VSEH(AC)DQS	$(VDDQ / 2) + 0.175$	-	V
VSEH(AC)DQS#	$(VDDQ / 2) + 0.175$	-	V
VSEH(AC)CK	$(VDDQ / 2) + 0.175$	-	V
VSEH(AC)CK#	$(VDDQ / 2) + 0.175$	-	V
VSEL(AC)DQS	-	$(VDDQ / 2) - 0.175$	V
VSEL(AC)DQS#	-	$(VDDQ / 2) - 0.175$	V
VSEL(AC)CK	-	$(VDDQ / 2) - 0.175$	V
VSEL(AC)CK#	-	$(VDDQ / 2) - 0.175$	V

## Dynamic limits for DDR3L measurements

The following table lists the dynamic limits for DDR3L measurements.

**NOTE.** Dynamic limits are the same for all DDR3L data rates.

**Table 30: Dynamic limits for DDR3L**

Measurement	Dynamic limits		
	Min	Max	Units
tCH(avg) <sup>14</sup>	$0.47 * tCK(avg)$	$0.53 * tCK(avg)$	tCK(avg)
tCL(avg) <sup>13</sup>	$0.47 * tCK(avg)$	$0.53 * tCK(avg)$	tCK(avg)
tCH(abs) <sup>13</sup>	$0.43 * tCK(avg)$	NA	tCK(avg)
tCL(abs) <sup>13</sup>	$0.43 * tCK(avg)$	NA	tCK(avg)
VSEH(DQS) <sup>13</sup>	$(VDDQ / 2) + 0.175$	-	V
VSEH(DQS#) <sup>13</sup>	$(VDDQ / 2) + 0.175$	-	V
VSEH(CK) <sup>13</sup>	$(VDDQ / 2) + 0.175$	-	V
VSEH(CK#) <sup>13</sup>	$(VDDQ / 2) + 0.175$	-	V
VSEL(DQS) <sup>13</sup>	-	$(VDDQ / 2) - 0.175$	V
VSEL(DQS#) <sup>13</sup>	-	$(VDDQ / 2) - 0.175$	V
VSEL(CK) <sup>13</sup>	-	$(VDDQ / 2) - 0.175$	V
VSEL(CK#) <sup>13</sup>	-	$(VDDQ / 2) - 0.175$	V
VSEH(AC)DQS <sup>13</sup>	$(VDDQ / 2) + 0.175$	-	V
VSEH(AC)DQS# <sup>13</sup>	$(VDDQ / 2) + 0.175$	-	V
VSEH(AC)CK <sup>13</sup>	$(VDDQ / 2) + 0.175$	-	V

<sup>14</sup> Supported in DDRA application but not called out JEDEC.



Measurement	Dynamic limits		
	Min	Max	Units
VSEH(AC)CK#	$(VDDQ / 2) + 0.175$	-	V
VSEL(AC)DQS	-	$(VDDQ / 2) - 0.175$	V
VSEL(AC)DQS#	-	$(VDDQ / 2) - 0.175$	V
VSEL(AC)CK	-	$(VDDQ / 2) - 0.175$	V
VSEL(AC)CK#	-	$(VDDQ / 2) - 0.175$	V

## Dynamic limits for DDR4 measurements

The following table lists the dynamic limits for DDR4 measurements. For more details, refer to the DDR4 JEDEC standard specification.

**NOTE.** Dynamic limits are the same for all DDR4 data rates.

**Table 31: Dynamic limits for DDR4**

Measurement	Dynamic limits		
	Min	Max	Units
tCH(avg)	$0.48 * tCK(avg)$	$0.52 * tCK(avg)$	tCK(avg)
tCL(avg)	$0.48 * tCK(avg)$	$0.52 * tCK(avg)$	tCK(avg)
tCH(abs)	$0.45 * tCK(avg)$	NA	tCK(avg)
tCL(abs)	$0.45 * tCK(avg)$	NA	tCK(avg)
VSEH(DQS)	$(VDDQ / 2) + 0.175$	-	V
VSEH (DQS#)	$(VDDQ / 2) + 0.175$	-	V
VSEH(CK)	$(VDDQ / 2) + 0.175$	-	V
VSEH(CK#)	$(VDDQ / 2) + 0.175$	-	V
VSEL(DQS)	-	$(VDDQ / 2) - 0.175$	V
VSEL(DQS#)	-	$(VDDQ / 2) - 0.175$	V
VSEL(CK)	-	$(VDDQ / 2) - 0.175$	V
VSEL(CK#)	-	$(VDDQ / 2) - 0.175$	V

## Dynamic limits for LPDDR measurements

The following table lists the dynamic limits for LPDDR measurements, which are common for all LPDDR data rates. For more details, refer to the LPDDR JEDEC standard specification.

**NOTE.** Dynamic limits are the same for all LPDDR data rates.

**Table 32: Dynamic limits for LPDDR**

Measurement	Dynamic limits		
	Min	Max	Units
tCH	0.45	0.55	tCK
tCL	0.45	0.55	tCK
Vix(ac)CK	0.4 * Vdd	0.6 * Vdd	-
Vix(ac)DQS	0.4 * Vdd	0.6 * Vdd	-
Vid(ac)	0.6 * Vdd	*Vdd+0.6	-

## Dynamic limits for LPDDR2 measurements

The following table lists the dynamic limits for LPDDR2 measurements. For more details, refer to the LPDDR2 JEDEC standard specification.

**NOTE.** Refer to the standard specific JEDEC document for derated measurements such as *tIS(derated)*, *tIH(derated)*, *tDS-Diff(derated)*, and *tDH-Diff(derated)* for calculating dynamic limits.

**Table 33: Dynamic limits for LPDDR2**

Measurement	Data rate (MT/s)	Dynamic limits		
		Min	Max	Units
tCH(avg)	NA	0.45	0.55	tCK(avg)
tCL(avg)	NA	0.45	0.55	tCK(avg)
tCH(abs)	NA	0.43	0.57	tCK(avg)
tCL(abs)	NA	0.43	0.57	tCK(avg)
tERR(13–50) <sup>15</sup>		(1 + 0.68ln(n)) * tJIT(per)min	(1 + 0.68ln(n)) * tJIT(per)max	ps
VSEH(AC)DQS	1066 to 466 MT/s	(VDDQ / 2) + 0.220	-	V
	400 to 200 MT/s	(VDDQ / 2) + 0.300	-	V
VSEH(AC)DQS#	1066 to 466 MT/s	(VDDQ / 2) + 0.220	-	V
	400 to 200 MT/s	(VDDQ / 2) + 0.300	-	V
VSEH(AC)CK	1066 to 466 MT/s	(VDDQ / 2) + 0.220	-	V
	400 to 200 MT/s	(VDDQ / 2) + 0.300	-	V

<sup>15</sup> Includes measurements from tERR13per to tERR50per

Measurement	Data rate (MT/s)	Dynamic limits		
		Min	Max	Units
VSEH(AC)CK#	1066 to 466 MT/s	$(VDDQ / 2) + 0.220$	-	V
	400 to 200 MT/s	$(VDDQ / 2) + 0.300$	-	V
VSEL(AC)DQS	1066 to 466 MT/s	-	$(VDDQ / 2) - 0.220$	V
	400 to 200 MT/s	-	$(VDDQ / 2) - 0.300$	V
VSEL(AC)DQS#	1066 to 466 MT/s	-	$(VDDQ / 2) - 0.220$	V
	400 to 200 MT/s	-	$(VDDQ / 2) - 0.300$	V
VSEL(AC)CK	1066 to 466 MT/s	-	$(VDDQ / 2) - 0.220$	V
	400 to 200 MT/s	-	$(VDDQ / 2) - 0.300$	V
VSEL(AC)CK#	1066 to 466 MT/s	-	$(VDDQ / 2) - 0.220$	V
	400 to 200 MT/s	-	$(VDDQ / 2) - 0.300$	V

## Dynamic limits for LPDDR3 measurements

The following table lists the dynamic limits for LPDDR3 measurements. For more details, refer to the LPDDR3 JEDEC standard specification.

**NOTE.** Refer to the standard specific JEDEC document for derated measurements such as  $tIS(\text{derated})$ ,  $tIH(\text{derated})$ ,  $tDS\text{-Diff}(\text{derated})$ , and  $tDH\text{-Diff}(\text{derated})$  for calculating dynamic limits.

**Table 34: Dynamic limits for LPDDR3**

Measurement	Data rate (MT/s)	Dynamic limits		
		Min	Max	Units
tCH(avg)	NA	0.45	0.55	tCK(avg)
tCL(avg)	NA	0.45	0.55	tCK(avg)
tCH(abs)	NA	0.43	0.57	tCK(avg)
tCL(abs)	NA	0.43	0.57	tCK(avg)
tERR(13–50) <sup>16</sup>	NA	$(1 + 0.68\ln(n)) * tJIT(\text{per})\text{min}$	$(1 + 0.68\ln(n)) * tJIT(\text{per})\text{max}$	ps
VSEH(DQS)	NA	$(VDDQ / 2) + 0.150$	-	V
VSEH (DQS#)	NA	$(VDDQ / 2) + 0.150$	-	V
VSEH(CK)	NA	$(VDDQ / 2) + 0.150$	-	V
VSEH(CK#)	NA	$(VDDQ / 2) + 0.150$	-	V
VSEL(DQS)	NA	-	$(VDDQ / 2) + 0.150$	V
VSEL(DQS#)	NA	-	$(VDDQ / 2) + 0.150$	V
VSEL(CK)	NA	-	$(VDDQ / 2) + 0.150$	V
VSEL(CK#)	NA	-	$(VDDQ / 2) + 0.150$	V

<sup>16</sup> Includes measurements from tERR13per to tERR50per

Measurement	Data rate (MT/s)	Dynamic limits		
		Min	Max	Units
VSEH(AC)DQS	NA	$(VDDQ / 2) + 0.150$	–	V
VSEH(AC)DQS#	NA	$(VDDQ / 2) + 0.150$	–	V
VSEH(AC)CK	NA	$(VDDQ / 2) + 0.150$	–	V
VSEH(AC)CK#	NA	$(VDDQ / 2) + 0.150$	–	V
VSEL(AC)DQS	NA	-	$(VDDQ / 2) - 0.150$	V
VSEL(AC)DQS#	NA	-	$(VDDQ / 2) - 0.150$	V
VSEL(AC)CK	NA	-	$(VDDQ / 2) - 0.150$	V
VSEL(AC)CK#	NA	-	$(VDDQ / 2) - 0.150$	V

## Dynamic limits for LPDDR4 measurements

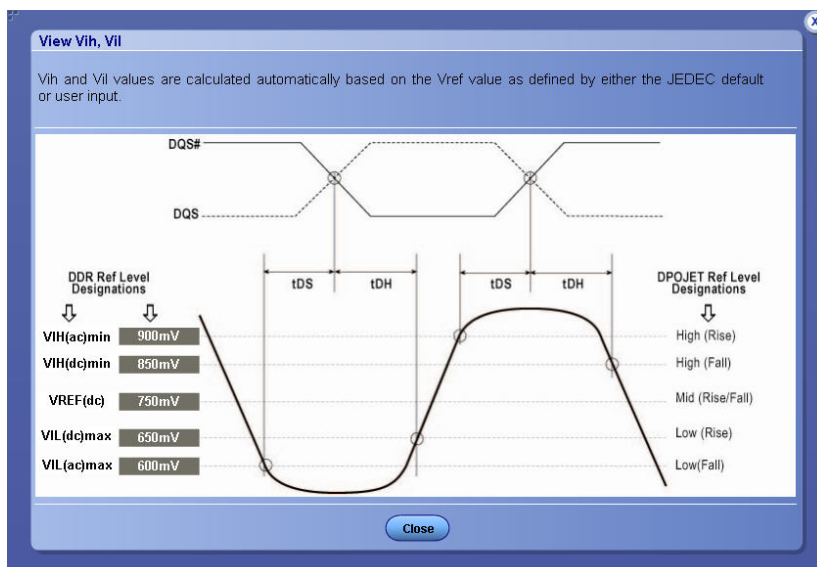
The following table lists the dynamic limits for LPDDR4 measurements. For more details, refer to the LPDDR4 JEDEC standard.

**Table 35: Dynamic limits for LPDDR4**

Measurement	Dynamic limits		
	Min	Max	Units
tCH (abs)	0.43	0.57	tCK (avg)
tCL (abs)	0.43	0.57	tCK (avg)
tCH (avg)	0.46	0.54	tCK (avg)
tCL (avg)	0.46	0.54	tCK (avg)
tQH	(tQSH, tQSL)	NA	UI
tQH_DBI	(tQSH_DBI, tQSL_DBI)	NA	UI
Vix(ac)CK	NA	25%	UI
Vix(ac)DQS	NA	20%	UI

## Vih-Vil reference levels

On clicking the View button, the VIH(ac)min, VIH(dc)min, VIL(ac)max, VIL(dc)max and VREF(dc) values are as shown based on the Vref voltage.



The following table lists the Vih and Vil values for all the DDR generations except GDDR3, LPDDR4 and data rate:

**Table 36: VIH and VIL values for DDR generations**

Generation	Data rate	VIH(ac)min	VIH(dc)min	VREF(dc)	VIL(dc) max	VIL(ac)max
DDR	200 MT/s	1.56 V	1.4 V	1.25 V	1.1 V	940 mV
	266 MT/s	1.56 V	1.4 V	1.25 V	1.1 V	940 mV
	333 MT/s	1.56 V	1.4 V	1.25 V	1.1 V	940 mV
	400 MT/s	1.61 V	1.45 V	1.3 V	1.15 V	990 mV
DDR2	400 MT/s	1.15 V	1.025 V	900 mV	775 mV	650 mV
	533 MT/s	1.15 V	1.025 V	900 mV	775 mV	650 mV
	667 MT/s	1.1 V	1.025 V	900 mV	775 mV	700 mV
	800 MT/s	1.1 V	1.025 V	900 mV	775 mV	700 mV
DDR3	800 MT/s	925 mV	850 mV	750 mV	650 mV	575 mV
	1066 MT/s	925 mV	850 mV	750 mV	650 mV	575 mV
	1333 MT/s	925 mV	850 mV	750 mV	650 mV	575 mV
	1600 MT/s	925 mV	850 mV	750 mV	650 mV	575 mV
	1866 MT/s	885 mV	850 mV	750 mV	650 mV	615 mV
	2133 MT/s	885 mV	850 mV	750 mV	650 mV	615 mV

Generation	Data rate	VIH(ac)min	VIH(dc)min	VREF(dc)	VIL(dc) max	VIL(ac)max
DDR3L	800 MT/s	835 mV	765 mV	675 mV	585 mV	515 mV
	1066 MT/s	835 mV	765 mV	675 mV	585 mV	515 mV
	1333 MT/s	835 mV	765 mV	675 mV	585 mV	515 mV
	1600 MT/s	835 mV	765 mV	675 mV	585 mV	515 mV
	1866 MT/s	805 mV	765 mV	675 mV	585 mV	545 mV
DDR4	1600 MT/s	735 mV	700 mV	600 mV	500 mV	465 mV
	1866 MT/s	735 mV	700 mV	600 mV	500 mV	465 mV
	2133 MT/s	735 mV	700 mV	600 mV	500 mV	465 mV
	2400 MT/s	735 mV	700 mV	600 mV	500 mV	465 mV
	2666 MT/s	735 mV	700 mV	600 mV	500 mV	465 mV
	3200 MT/s	735 mV	700 mV	600 mV	500 mV	465 mV
GDDR5	4000 MT/s	900 mV	850 mV	750 mV	650 mV	600 mV
	4800 MT/s	900 mV	850 mV	750 mV	650 mV	600 mV
	5000 MT/s	900 mV	850 mV	750 mV	650 mV	600 mV
	5500 MT/s	900 mV	850 mV	750 mV	650 mV	600 mV
LPDDR	200 MT/s	1.44 V	1.26 V	900 mV	540 mv	360 mV
	266 MT/s	1.44 V	1.26 V	900 mV	540 mv	360 mV
	333 MT/s	1.44 V	1.26 V	900 mV	540 mv	360 mV
	370 MT/s	1.44 V	1.26 V	900 mV	540 mv	360 mV
	400 MT/s	1.44 V	1.26 V	900 mV	540 mv	360 mV
LPDDR2	333 MT/s	900 mV	800 mV	600 mV	400 mV	300 mV
	400 MT/s	900 mV	800 mV	600 mV	400 mV	300 mV
	533 MT/s	820 mV	730 mV	600 mV	470 mV	380 mV
	667 MT/s	820 mV	730 mV	600 mV	470 mV	380 mV
	800 MT/s	820 mV	730 mV	600 mV	470 mV	380 mV
	933 MT/s	900 mV	800 mV	600 mV	400 mV	300 mV
	1066 MT/s	820 mV	730 mV	600 mV	470 mV	380 mV
LPDDR3	333 MT/s	750 mV	700 mV	600 mV	500 mV	450 mV
	800 MT/s	750 mV	700 mV	600 mV	500 mV	450 mV
	1066 MT/s	750 mV	700 mV	600 mV	500 mV	450 mV
	1200 MT/s	750 mV	700 mV	600 mV	500 mV	450 mV
	1333 MT/s	750 mV	700 mV	600 mV	500 mV	450 mV
	1466 MT/s	750 mV	700 mV	600 mV	500 mV	450 mV
	1600 MT/s	750 mV	700 mV	600 mV	500 mV	450 mV

## Using digital channels

You must do the following steps when you select Logic State+DQ/DQS Phase Alignment burst detection method in an MSO oscilloscope. The DDR3 signal is an example here, but a few settings must be changed for other DDR standards. Using appropriate label names for digital signals (such as RS, CAS, CS and WE) helps in defining the sources in a bus.



**NOTE.** Refer *Setting Up Digital Channels* in your oscilloscope user manual for more details on how to set up digital channels.

### Calculating Digital Channel Threshold

Follow the steps to calculate the digital channel threshold:

1. View the analog equivalent of the input digital signal (refer Viewing Analog Characteristics of Digital Waveforms in the MSO oscilloscope user manual).



2. Measure the thresholds for the CS signal as shown in an example:

- Measure the Min, and Pk-Pk on the analog waveform and calculate the threshold value approximately as follows:  
Threshold Value = Min + 50% of Pk-Pk.
- For example: If the measured Min value is 450 mV and Pk-Pk is 666 mV, using the above formula, the threshold value is set to 750 mV.



- Enter the calculated threshold value in the Digital setup dialog box under Threshold.



**NOTE.** Thresholds are DUT specific. Carry out the same procedure for every DUT under test.

## Configuring Sources for a Bus

The steps to configure source for a bus are:

1. Set up the bus (refer to Set Up a Parallel Bus in your MSO oscilloscope user manual)
2. Add sources to the bus. Ensure that the order of sources (MSB to LSB) is in sync with the sources mentioned in the corresponding symbol file.

For example: DDR3 symbol file specifies the following:

SYMBOL	MSB -> LSB
READ	0101
WRITE	0100

Set up the sources for these symbols as shown in the following figure:



## Configuring Burst Latency and Tolerance

The following example shows how Burst Latency and Tolerance values are calculated using DDR3 1066 READ burst signal:

**NOTE.** Burst Latency and Tolerance values are specific to a DUT and should be computed for each DUT under test.

1. [Set up digital channels](#) and [configure the bus](#). Connect DQ/DQS to Ch1/Ch2 sources. Press **Single** on the oscilloscope front panel for signal acquisition.
2. Locate the READ burst and place the cursor in the centre of the burst. Place the second cursor on the first rising edge of the DQS signal as shown in the following figure:



3. Note the time difference between the two cursors. In this example, it is 10.24 ns (called t1) as shown in the following figure.

4. Place the cursors on two consecutive rising/falling edges of the DQS signal as shown:



5. Note the time difference between the two cursors. It is 1.92 ns (called  $t_2$ ) as shown in the above figure.
6. Calculate CAS Min using the equation:  

$$\text{CAS Min} = t_1/t_2 - 0.5$$
 In the above example, CAS Min =  $(10.24/1.92) - 0.5 \sim 5$  (approximately)
7. Calculate CAS Max using the equation:  

$$\text{CAS Min} = t_1/t_2 + 0.5$$
 In the above example, CAS Min =  $(10.24/1.92) + 0.5 \sim 6$  (approximately)

8. Configure CAS Min and Max values in DDRA as shown:



Providing inaccurate CAS Min and MAX values can result in an offset in Mark start/end calculations which in turn provides inaccurate measurement results. An example of incorrect CAS Min/Max values. is as follows:



**NOTE.** You can perform the above steps once and then save the setup. Setup files help to recall the settings corresponding to a particular DUT.

## Error codes and warnings

Code	Description
E102	File does not exist.
E103	DPOJET is not able to open the help file. In order to use the help file, please reinstall DPOJET.
E104	Mask Hits measurement requires an Eye diagram plot but no more plots can be assigned. Please remove a plot before adding a Mask Hits measurement.
E105	The maximum number of plots you can select is 4.
E106	No Spectrum plot data is available.
E202	The upper range must be greater than the lower range.
E400	A measurement failed to complete successfully.
W410	Number of edges are not sufficient for a measurement.
E411	In at least one zone, there are too few edges to complete a measurement.
E424	No edges or UI of the required type were found in the waveform. If this is not a clock signal, check the Vref threshold and record length.
E425	No transitions of the selected Bit Type were found in the waveform.
E500	The record lengths of the source waveforms differ. Please configure for sources with equivalent record lengths.
E1001	Vertical Autoset Failed: Signal on Source x has extreme offset.
E1002	Vertical Autoset Failed: Amplitude of Source x is too small.
E1003	Vertical Autoset Failed: Amplitude or DC offset of Source x is too high.
E1004	Vertical Autoset Failed: No signal on Source x.
E1005	Vertical Autoset Failed: Signal on Source x exceeds top of scale.
E1006	Vertical Autoset Failed: Signal on Source x exceeds bottom of scale.
E1007	Vertical Autoset Failed: Signal on Source x is clipped on top.
E1008	Vertical Autoset Failed: Signal on Source x is clipped on bottom.
E1009	Vertical Autoset Failed: Measurement error ( ISDB error code = 6 ) on Source x.
E1010	Vertical Autoset Failed: Measurement error ( ISDB error code = 7 ) on Source x.
W1011	A change to Source x vertical settings caused overload disconnect. Original settings are restored and Source x is reconnected. Ignore oscilloscope message.
E1012	Vertical Autoset Failed: None of the selected measurements use live sources (Ch1-Ch4). Horizontal autoset works for live sources only.
E1013	Vertical Autoset Failed: Invalid signal on Source x.
E1020	Horizontal Autoset Failed: None of the selected measurements use live sources (Ch1-Ch4). Horizontal autoset works for live sources only.
E1021	Horizontal Autoset Failed: On Source x, cannot determine resolution of rising/falling edges.
E1022	Horizontal Autoset Failed: Horizontal resolution is at the maximum.
E1026	Horizontal Autoset Failed: Source amplitude too low.
E1027	Horizontal Autoset Failed: Signal is clipped at the top - positive clipping.
E1028	Horizontal Autoset Failed: Signal is clipped at the bottom - negative clipping.
E1029	Horizontal Autoset Failed: Signal frequency is extremely low.

Code	Description
E1035	Oscilloscope has gone into invalid state. Please restart the system.
E1040	Autoset Failed: None of the live sources (Ch1-Ch4) selected.
W1051	Ref Level Autoset: Waveform for the source x is clipped.
W1053	Ref Level Autoset: Source amplitude is extremely low.
E1054	Ref Level Autoset: Error in setting reference levels.
E1055	Ref Level Autoset Failed: No waveform to measure.
E1056	Ref Level Autoset: Unstable Histogram for waveform on source x.
E1057	Ref Level Autoset: No selected source.
E1058	Ref Level Autoset Failed: Invalid signal on source x.
E1059	Ref Level Autoset Error: Source x is not defined.
E1061	Since Digital Filters (DSP) are enabled, maximum sampling rate has been retained. To enable adaptive use of lower sampling rate, please choose Analog Only under Vertical . Bandwidth Enhanced.
E1062	The maximum Record Length (RL) in autoset is restricted to 25M, set the RL manually for >25M.
E1063	The minimum Record Length (RL) in autoset is restricted to 500K, set the RL manually for <500K.
E2001	The maximum number of measurements has been reached.
E2002	All the refs are used as sources by the measurements. Export to Ref is not possible.
E2003	Ref 'x' is already used as a measurement source.
E2004	Ref 'x' is already used as a destination for other measurement.
E2005	No measurement(s) are selected. Export to Ref is not possible.
E2006	No results available to export to ref.
E2007	There are no time trend results for the selected measurement(s).
E2008	No ref destination is selected. Results will not be exported to ref.
E3001	Could not open or create a log file. Please ensure that you have read/write permission to access log folders and files.
E3002	The specified path is invalid (for example: The specified path is not mapped to a drive).
E3003	The specified path, file name or both exceed the system defined length. For Example: On Windows-based platforms, the path name must be less than 248 characters and file names less than 260 characters.
E3004	The specified path directory is read-only or is not empty.
E3005	Please ensure that the file is currently not in use by other process and/or has not exceeded the file size limit.
E3006	Invalid filename: Check whether the file name contains a colon (:) in the middle of the string.
E3007	Select at least one measurement from the table before you save.
E3008	There are currently no results to save. Please run a measurement.
E3009	Current statistics is successfully saved at C:\TekApplications\DPOJET\Log\Statistics.
E3010	Access to file/directory denied. Please ensure that the file/directory has read/write permissions.
E3011	Mask Hits Measurements will not be selected as this feature is not available for Mask Hits measurement.
E3012	Folder does not exist.

Code	Description
E4000	Not enough data points. Unable to render plot(s).
E4001	Internal measurement error. Please remove a measurement and try again.
E4002	Not enough data points for spectrum computation.
E4003	Due to high memory usage, only a portion of the waveform could be processed. Please reduce your record length or the number of measurements.
E4004	An error occurred in the edge extraction process.
E4005	Qualifier: The record length and sample interval must match across the waveforms.
E4006	A maximum of 4096 qualifier zones is supported. The entire waveform will not be processed and hence partial measurement results are available.
E4007	Logic Qualifier enabled and no qualifier zones found.
W4008	The configured Ref voltage for Overshoot must be greater than or equal to the mid autoset ref levels.
W4009	The configured Ref voltage for Undershoot must be lesser than or equal to the mid autoset ref levels.
E4013	The configured Ref voltage must be greater than or equal to the mid autoset ref levels.
E4014	The configured Ref voltage must be lesser than or equal to the mid autoset ref levels.
E4015 <sup>1</sup> OMING	One or more qualifier zones had too few edges for measurement calculation.
E4016	Not enough edges in the waveform for measurement calculation.
E4017	Qualifier not enabled and hence no qualifier zones found. Please enable the qualifier.
E4018	The preamble is incomplete in all the qualifier zones.
E4019 <sup>16</sup>	The preamble is incomplete in one or more qualifier zones.
E4020	The postamble is incomplete in all the qualifier zones.
E4021	The postamble is incomplete in one or more qualifier zones. Displays the zone number (x) for which the preamble/postamble fails.
E4022 <sup>16</sup>	Not enough samples present in the qualifier zones. Please increase the sampling rate and reacquire the waveform.
E4023	The configured ref levels are not correct. The high ref level should be $\geq$ Mid and Mid should be $\geq$ Low for both Rise and Fall slopes. Reconfigure the ref levels and run the measurement.
E4024	Could not compute proper High and Low values.
W4025	The signal does not cross the configured Ref Voltage and hence the result shows zero population. Please adjust the Ref voltage value.
E4027	From Symbol not found in the acquisition.
E4028	To Symbol not found in the acquisition.
E4029	The configured High Ref voltage must be $\geq$ to the mid autoset ref levels.
E4030	The configured Low Ref voltage must be $\leq$ to the mid autoset ref levels.
E4031	The configured High Ref voltage must be $\geq$ to the mid autoset ref levels and the configured Low Ref voltage must be $\leq$ to the mid autoset ref levels.
E5005 <sup>2</sup>	Occurs while running setup. Please make sure you have finished any previous setup and closed other applications

<sup>1</sup> Displays the zone number (x) for which the preamble/postamble fails.

<sup>2</sup> This error occurs during DPOJET installation on a DPO/MSO series of oscilloscopes. Delete the Installshield folder under C:\Program files\Common Files and delete all files and folders under C:\Windows\Temp folder. Restart the installation again.



Code	Description
W5005	The path or file name exceeds the system limit of 260 characters.
E9004	Derating will not be applied to the limits as Slew Rate measurements failed.
W9005	Derating value calculated using single Slew Rate measurement value.
W9006	Derating value cannot be computed since the calculated Slew Rate is not present in the derating table <sup>3</sup> .
E9007	Derating Error <sup>4</sup> .

<sup>3</sup> Signal Slew Rate value is outside the derating table (Ex: If DDR2-800 MT/s tDS derating with a differential probe has a DQS differential slew rate of 0.65 V/ns, this warning message is displayed as the derating table definition starts from 0.8 V/ns).

Derating value is not supported (TBD) in the specification (Ex: If the DQS differential slew rate is 2.0 V/ns and the DQ slew rate is 0.7 V/ns, then the value is "-"(TBD).

Derating will not be applied for the above cases and the base limit will be displayed in the results table.

<sup>4</sup> Slew Rate measurements used to calculate the derated value failed to Run as there are no sufficient edges on the Rise and Fall slopes of the waveform.

Base measurement limits are not defined as per the specification.



---

# Algorithms

## About algorithms

The DDRA application can take measurements by selecting either Clock, Strobe, Data or CS Source as sources. The number of waveforms used by the application depends on the type of measurement being taken.

### Oscilloscope Setup Guidelines

For all measurements, use the following guidelines to set up the oscilloscope:

- The signal is any channel, reference, or math waveform.
- The vertical scale for the waveform must be set so that the waveform does not exceed the vertical range of the oscilloscope.
- The sample rate must be set to capture sufficient waveform detail and avoid aliasing.
- Longer record lengths increase measurement accuracy but the oscilloscope takes longer to measure each waveform.

### Search and Mark Algorithms

DDR search algorithm uses a moving average filter (FIR) to determine start and end of bursts. Filter length is decided based on the configured data rate and minimum burst length for each of the generations.

Once the bursts are marked, the min, max and mid voltage levels are calculated for each of the bursts. The mid-level detected on DQS is then used with a 10% hysteresis band to extract the edges from the DQS signal. These edges are stored and are then used for bit rate estimation.

The algorithm computes phase difference between DQ and DQS edges. This phase difference along with the preamble and postamble information will be used to differentiate between READ and WRITE bursts. In addition to these, the LPDDR4 generation, also compare the strobe preamble with the ideal patterns to differentiate READ and WRITE bursts.

The application will scan for first the start of any burst, followed by that burst's termination condition. Once a start condition has been found, only the termination condition will be searched for until the end-of-record.

## Write measurements

### Data eye height

Data Eye Height is common for both Read and Write bursts. The type of burst is determined by the ASM settings. If a waveform contains multiple bursts of the same kind, the Data Eye Height is calculated and the Eye Diagram rendered for all bursts within one acquisition. Set DQ to Data signal and DQS to explicit clock edge.

By default, the DQS eye will be rendered under the DQ eye in orange monochrome color. The DQS eye can be turned off from the Eye diagram plot configuration panel. For Write bursts, the DQS eye is offset from the Data eye (crossing in the center), whereas eye diagrams overlap for Read bursts. The relative positions of the eye diagrams might be controlled using the Ref Clock alignment property on the Eye diagram plot configuration panel. The left and center options indicate where the DQS crossing shall be located so that Data Eye will maintain its normal position. Left is suitable for Read bursts and center for Write bursts. Use Auto to automatically determine the offset property.

---

**NOTE.** When you select Vertical Scale to Data in the eye diagram plot configuration, it is possible that the DQS signal can be clipped both at the top and bottom of the eye diagram. The Eye diagram is enabled only when you select the Eye Width measurement along with Eye Height. The Eye diagram plot is disabled when you select only Eye Height.

---

For more details, refer to Eye Height in the DPOJET help.

## Data eye width

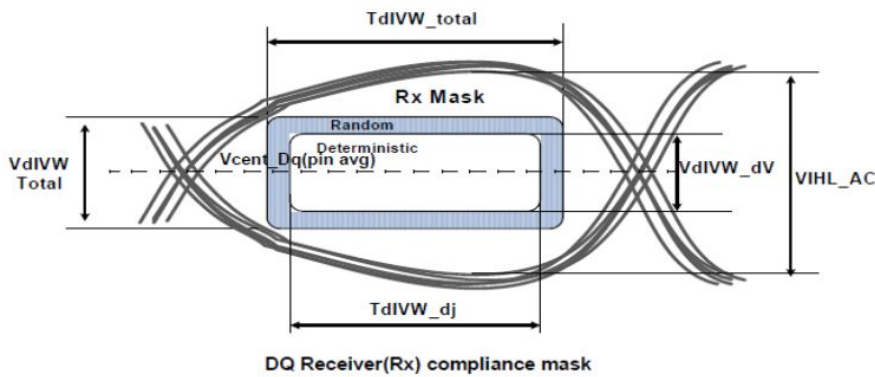
Data Eye Width is common for both Read and Write bursts. The type of burst is determined by the ASM settings. If a waveform contains multiple bursts of the same kind, the Data Eye Width is calculated and respective Eye Diagram rendered for all bursts within one acquisition. It uses the DPOJET measurement, Eye width with eye diagram plot enabled. Set DQ to Data signal and DQS to explicit clock edge.

By default, the DQS eye will be rendered under the DQ eye in an orange monochrome color. The DQS eye can be turned off from the Eye diagram plot configuration panel. For Write bursts, the DQS eye is offset from the Data eye (crossing in the center), whereas eye diagrams overlap for Read bursts. The relative positions of the eye diagrams can be controlled using the Ref Clock alignment property on the Eye diagram plot configuration panel. The left and center options indicate where the DQS crossing shall be located so that Data Eye will maintain its normal position. Left is suitable for Read bursts and center for Write bursts. Use Auto to automatically determine the offset property.

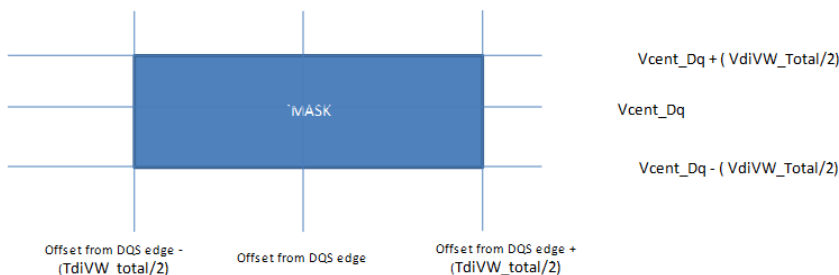
For more details, refer to Eye Width in the DPOJET help.

## DDRARXMask

The receiver mask (Rx Mask) defines the area input signal must not encroach in order for the DRAM input receiver to be expected to be able to successfully capture a valid input signal. The DQ input receiver compliance mask for voltage and timing is shown as below



Depending on the data rate,  $tck(avg)$  min and  $V_{cent\_DQ}$ , masks are dynamically created as below:



Rx Mask measurement uses the DPOJET measurement, Mask Hits.

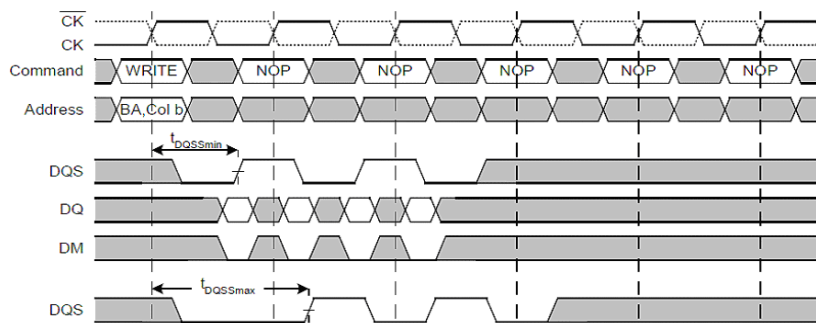
**NOTE.** DDRA application provides a single mask which combines both Random and Deterministic jitter.

## tDQSS

tDQSS is different from the tDQSS-Diff supported for other generations like DDR2, DDR3. tDQSS measures the time taken from the WRITE event in the DDR bus to the first DQS latching transition. This measurement has two sources. One bus source (B1) and a DQS source (analog). Additionally we need a DQ source for DDR Write burst detection.

Measurement internally sets up a Bus search to look for WRITE events. For every WRITE event in the bus search output, the algorithm finds and associates the first rising edge of DQS within the DDR Write burst.

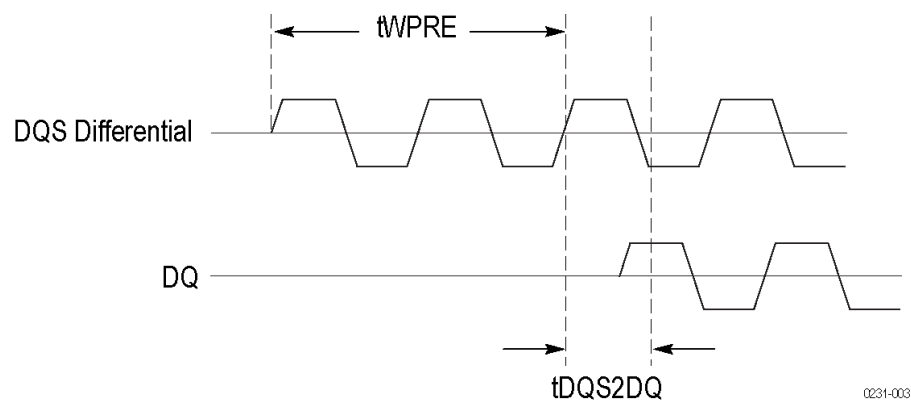
This measurement is available only on 64-bit MSO instruments. Measurement gets selected only if there is a bus source configured.



## tDQS2DQ

tDQS2DQ is defined as the time skew between the driving edge of the strobe to the center of the first data eye.

tDQS2DQ



tDQS2DQ can vary from 200pS to 800pS.

tDQS2DQ uses the DPOJET measurement, DDR tDQS2DQ.

### NOTE.

*In the entire acquisition, at least in one burst, DQ should have a transition during the first bit; otherwise, the measured value may not be accurate.*

## VIHL\_AC

VIHL\_AC measures the AC input Pk-Pk amplitude of the DQ signal.

In DDR4 generation, VIHL\_AC uses the DPOJET measurement, Cycle Pk-Pk, whereas LPDDR4 generation uses the DDR VIHLAC measurement.

## SRIN\_dIVW\_Rise

SRIN\_dIVW\_Rise measures the slew rate on the DQ signal between the rising edge from  $(0.5 \cdot V_{dIVW})$  to  $(-0.5 \cdot V_{dIVW})$ .

SRIN\_dIVW\_Rise uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to Rise Slew Rate in the DPOJET help.

---

**NOTE.** For DDR4, the SRIN\_dIVW\_Rise measurement is renamed as "srr1" measurement.

---

## SRIN\_dIVW\_Fall

SRIN\_dIVW\_Fall measures the slew rate on the DQ signal between the falling edge from  $(0.5 \cdot V_{dIVW})$  to  $(-0.5 \cdot V_{dIVW})$ .

SRIN\_dIVW\_Fall uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

---

**NOTE.** For DDR4, the SRIN\_dIVW\_Fall measurement is renamed as "srf1" measurement.

---

## TdIPW-High

tDIPW-High is defined as the positive input pulse width on the DQ signal. This is measured at vCent-DQ level

tDIPW-High uses the DPOJET measurement Pos Width.

## TdIPW-Low

tDIPW-Low is defined as the negative input pulse width on the DQ signal. This is measured at vCent-DQ level

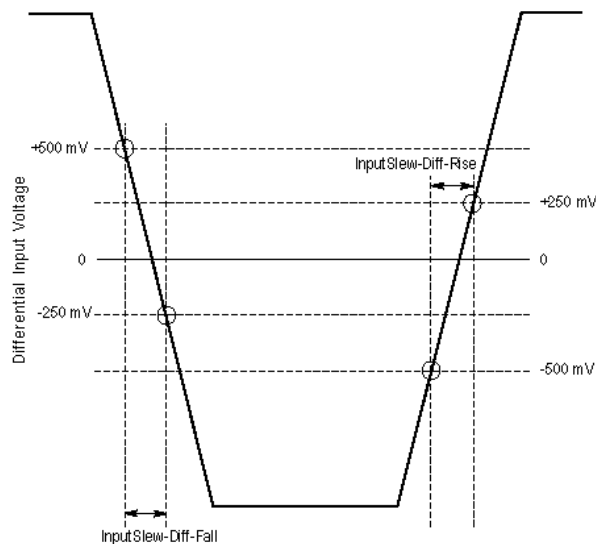
tDIPW-Low uses the DPOJET measurement Neg Width.

## Differential DQS measurements

### Input Slew-Diff-Rise(DQS)

Input Slew-Diff-Rise(DQS) measures slew rate on differential DQS signals between the rising edges from low to high.

Input Slew-Diff-Rise(DQS) uses the DPOJET measurement, Rise Slew Rate.



**NOTE.** The above figure is applicable for all DDR2 Slew Rate(Diff) measurements.

For more details, refer to Rise Slew Rate in the DPOJET help.

### Input Slew-Diff-Fall(DQS)

Input Slew-Diff-Fall(DQS) measures slew rate on differential DQS signals between the falling edges from high to low.

Input Slew-Diff-Fall(DQS) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

### tDH-Diff(base)

tDH-Diff(base) is defined as the input hold time between Data (DQ) and Differential Strobe (DQS) signal. It is the elapsed time taken from the mid-level of the DQS signal to the specific level (VIH(dc) and VIL(dc), where VIH(dc) is on a falling slope of DQ signal and VIL(dc) is on a rising slope of the DQ signal). This measurement requires you to set up correct reference levels for DQS and DQ signals for different speeds. The DDRA application will set up these levels automatically when JEDEC Default mode is selected. When User Defined mode is selected, then these reference levels are calculated based on your input for Vref and Vdd.

tDH-Diff(base) uses the DPOJET measurement, DDR-Hold-Diff.

For more details, refer to DDR-Hold-Diff in the DPOJET help.

### tDH-Diff(derated)

Derating limits are calculated by adding the tDH(base) limit and  $\Delta t_{DH}(\text{derating})$  value.  $\Delta t_{DH}$  for a rising signal is defined as the slew rate between the last crossing of  $V_{IL(dc)max}$  and the first crossing of  $V_{REF(dc)}$ , and for a falling signal is defined as the slew rate between the last crossing of  $V_{IH(dc)min}$  and the first crossing of  $V_{REF(dc)}$ .

tDH-Diff(derated) uses the DPOJET measurement, DDR-Hold-Diff, to calculate the base value.

For more details, refer to DDR-Hold-Diff in the DPOJET help.

### tDH-Diff(Vref-based)

tDH-Diff(Vref-based) is defined as the elapsed time from Vref of the DQS signal to the Vref of the DQ signal. This is the only tDH measurement that does not use the Vih and Vil thresholds.

tDH-Diff(derated) uses the DPOJET measurement, Hold.

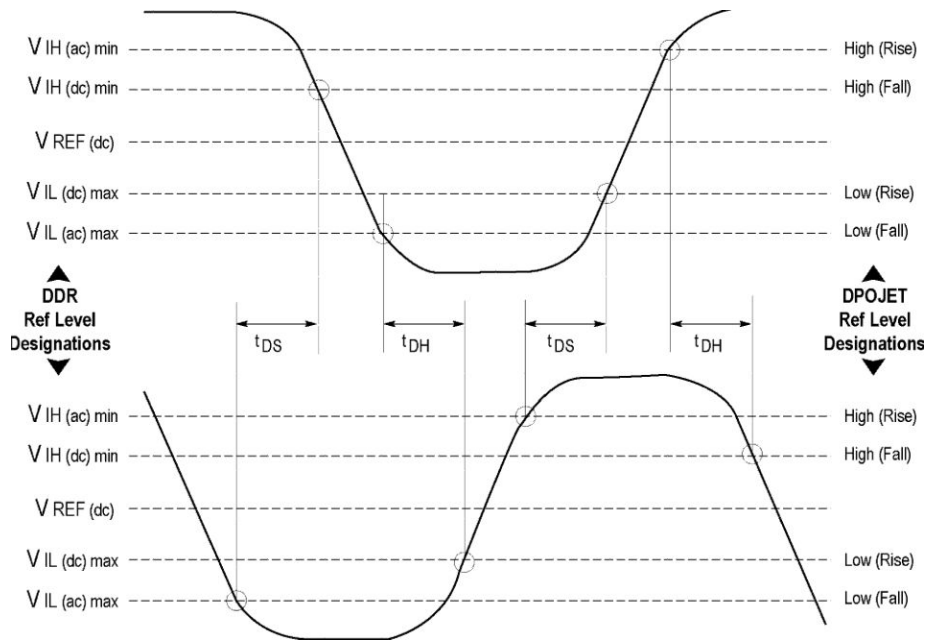
For more details, refer to Hold in the DPOJET help.

### tDS-Diff(base)

tDS-Diff(base) is defined as the input setup time between DQ and differential DQS signal. It is the elapsed time taken from the mid-level of the DQS signal to the specific level ( $V_{IH(ac)}$  and  $V_{IL(ac)}$ , where  $V_{IH(ac)}$  is on a falling slope of DQ signal and  $V_{IL(ac)}$  is on a rising slope of the DQ signal).

tDS-Diff(base) uses the DPOJET measurement, DDR Setup-Diff.

For more details, refer to DDR-Setup-Diff in the DPOJET help.



The configured values of Vdd and Vref are used to calculate  $V_{IH(ac)min}$ ,  $V_{IH(dc)min}$ ,  $V_{IL(dc)max}$  and  $V_{IL(ac)max}$ , which are applied on the input signal. These levels are further used for calculating Setup and Hold measurements.

The relationship between Vdd and Vref for DDR2 standard is as shown in the following tables. For other DDR standards, please refer to their JEDEC specifications.



**Table 37: Input DC logic Level**

Symbol	Parameter	Min	Max	Units
$V_{IH(dc)}$	DC input logic high	$V_{ref}+0.125$	–	V
$V_{IL(dc)}$	DC input logic low	–0.3	$V_{ref}-0.125$	V

**Table 38: Input AC logic Level**

Symbol	Parameter	DDR2–400, DDR2–533		DDR2–667,DDR2–800		Units
		Min	Max	Min	Max	
$V_{IH(ac)}$	AC input logic high	$V_{ref}+0.250$	x	$V_{ref}+0.200$	–	V
$V_{IL(ac)}$	AC input logic low	–	$V_{ref}-0.250$	–	$V_{ref}+0.200$	V

**tDS-Diff(derated)**

Derating limits are calculated by adding the  $tDS(base)$  limit and  $\Delta tDS(derating)$  value..  $\Delta tDS$  for a rising signal is defined as the slew rate between the last crossing of  $V_{REF(dc)}$  and the first crossing of  $V_{IH(ac)min}$ , and for a falling signal is defined as the slew rate between the last crossing of  $V_{REF(dc)}$  and the first crossing of  $V_{IL(ac)max}$  and the first crossing of  $V_{IL(ac)max}$ .

$tDS-Diff(derated)$  uses the DPOJET measurement, DDR-Setup-Diff, to calculate the base value.

For more details, refer to DDR-Setup-Diff in the DPOJET help.

**tDS-Diff(Vref-based)**

$tDS-Diff(Vref-based)$  is defined as the elapsed time from  $V_{ref}$  of the DQ signal to the  $V_{ref}$  of the DQS signal. This is the only  $tDS$  measurement that does not use  $V_{ih}$  and  $V_{il}$  thresholds.

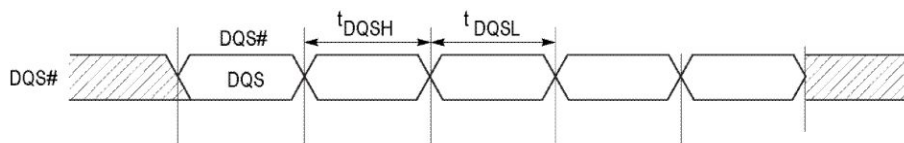
$tDS-Diff(Vref-based)$  uses the DPOJET measurement, Setup.

For more details, refer to Setup in the DPOJET help.

**tDQSH**

$tDQSH$  is the high pulse width on the DQS(Strobe) input. Amount of time the waveform remains above the mid reference voltage level.

$tDQSH$  uses the DPOJET measurement, Pos Width.

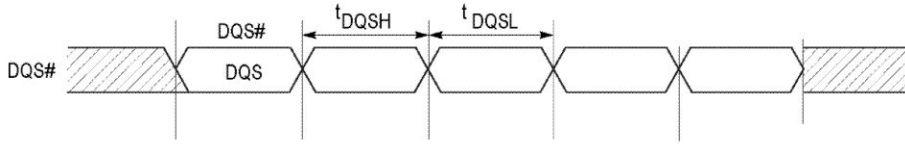


For more details, refer to Positive and Negative Width in the DPOJET help.

## tDQSL

tDQSL is the low pulse width on the DQS(Strobe) input. Amount of time the waveform remains below the mid reference voltage level.

tDQSL uses the DPOJET measurement, Neg Width.



For more details, refer to Positive and Negative Width in the DPOJET help.

## tDSS-Diff

tDSS-Diff is defined as the elapsed setup time from the DQS falling edge to the clock rising edge.

tDSS-Diff uses the DPOJET measurement, Setup.

For more details, refer to Setup in the DPOJET help.

## tDSH-Diff

tDSH-Diff is defined as the elapsed time from the clock rising edge to the DQS falling edge.

tDSH-Diff uses the DPOJET measurement, Hold.

For more details, refer to Hold in the DPOJET help.

## tDQSS-Diff

tDQSS-Diff is defined as the elapsed time from the DQS rising edge to the clock rising edge.

tDQSS-Diff uses the DPOJET measurement, Skew.

For more details, refer to Skew in the DPOJET help.

## Single ended DQS

### Slew Rate-Hold-SE-Fall(DQS)

Slew Rate-Hold-SE-Fall(DQS) measures the slew rate on the DQS-SE signal between the falling edge from  $V_{REF}$  to  $V_{IL(ac)max}$ .

Slew Rate-Hold-SE-Fall(DQS) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

### **Slew Rate-Hold-SE-Rise(DQS)**

Slew Rate-Hold-SE-Rise(DQS) measures the slew rate on the DQS-SE signal between the rising edge from  $V_{REF}$  to  $V_{IH(ac)min}$ .

Slew Rate-Hold-SE-Rise(DQS) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to the topic Rise Slew Rate of the DPOJET help.

### **Slew Rate-Setup-SE-Fall(DQS)**

Slew Rate-Setup-SE-Fall(DQS) measures the slew rate on the DQS-SE signal between the falling edge from  $V_{REF}$  to  $V_{IL(ac)max}$ .

Slew Rate-Setup-SE-Fall(DQS) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to the topic Fall Slew Rate of the DPOJET help.

### **Slew Rate-Setup-SE-Rise(DQS)**

Slew Rate-Setup-SE-Rise(DQS) measures the slew rate on the DQS-SE signal between the rising edge from  $V_{REF}$  to  $V_{IH(ac)min}$ .

Slew Rate-Setup-SE-Rise(DQS) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to the topic Rise Slew Rate of the DPOJET help.

### **tDS-SE(base)**

tDS-SE(base) is the input setup time between DQ and single-ended DQS signal. It is the elapsed time between  $V_{IH(dc)min}$  of DQS and  $V_{IL(ac)max}$  of DQ.

tDS-SE(base) uses the DPOJET measurement, DDR-Setup-SE.

For more details, refer to the topic DDR-Setup-SE of the DPOJET help.

### **tDIPW-SE**

tDIPW-SE is defined as the input pulse width on the DQ or DBI# signal.

tDIPW-SE uses the DPOJET measurement, High Time.

For more details, refer to the topic High Time of the DPOJET help.

### **tDSS-SE**

tDSS-SE is defined as the elapsed setup time from the DQS falling edge to the clock rising edge.

tDSS-SE uses the DPOJET measurement, Setup.

For more details, refer to the topic Setup of the DPOJET help.

### **tDSH-SE**

tDSH-SE is defined as the elapsed time from the clock rising edge to the DQS falling edge.

tDSH-SE uses the DPOJET measurement, Hold.

For more details, refer to the topic Hold of the DPOJET help.

### tDQSS-SE

tDQSS-SE is defined as the elapsed time from the DQS rising edge to the clock rising edge.

tDQSS-SE uses the DPOJET measurement, Skew.

For more details, refer to the topic Skew of the DPOJET help.

### tDH-SE(base)

tDH-SE(base) is defined as the input hold time between DQ and single-ended DQS signal.

tDH-SE(base) uses the DPOJET measurement, DDR-Hold-SE.

For more details, refer to the topic DDR-Hold-SE of the DPOJET help.

### tDVAC(CK)

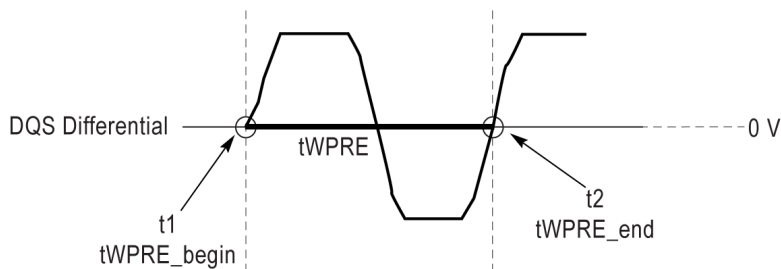
tDVAC(CK) is defined as the allowed time before ring back of CK below VIDCK/WCK (AC) reference levels.

tDVAC(CK) uses the DPOJET measurement, Time Outside Level. tDVAC(CK) is used for GDDR5 generation.

For more details, refer to the topic Time Outside Level of the DPOJET help.

### tWPRE

tWPRE is defined as the elapsed time on a DQS signal between tWPRE\_begin and tWPRE\_end.

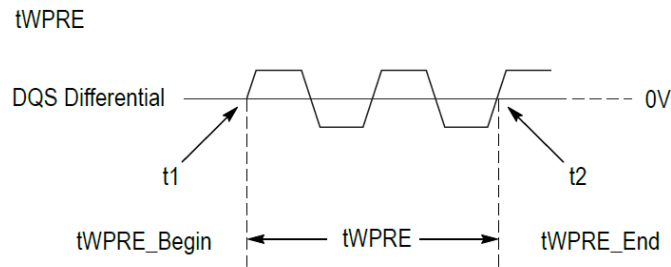


For DDR3 generation, tWPRE is based on the DPOJET measurement, DDR tWPRE.

For more details, refer to DDR tWPRE in the DPOJET help.

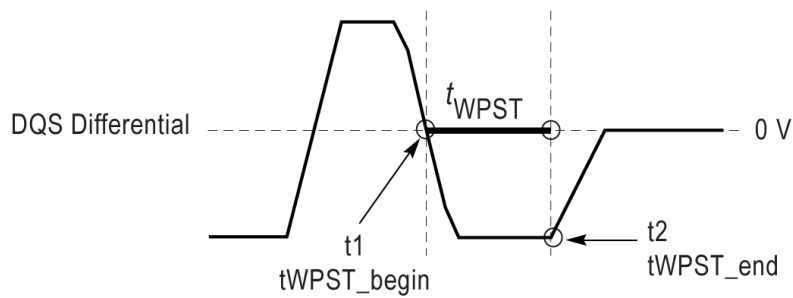
For LPDDR4, the Write preamble is a two clock cycle.

For LPDDR4 generation, tWPRE is based on the DPOJET measurement, LPDDR4 tWPRE.



## tWPST

tWPST is defined as the elapsed time between tWPST\_begin and tWPST\_end.



tWPST uses the DPOJET measurement, DDR tPST.

This application calculates this measurement using the following equation:

$$tWPST = t2(n) - t1(n)$$

tWPST uses the DPOJET measurement, DDR tWPST.

For more details, refer to DDR tPST in the DPOJET help.

## tWRPDE

tWRPDE measures the elapsed time between the WRITE and POWERDOWN ENTRY commands.

This measurement is available for GDDR5 generation.

tWRPDE uses the DPOJET measurement, tBurstToCMD. This measurement will appear under WRITE measurement type.

For more details, refer to tBurstToCMD in the DPOJET help.

## tWRSRE

tWRSRE measures the elapsed time between the WRITE and SELF REFRESH commands.. This measurement is available for both DDR2 and DDR3 generation.

tWRSRE uses the DPOJET measurement, tBurstToCMD. This measurement will appear under WRITE measurement type.

For more details, refer to tBurstToCMD in the DPOJET help.

## Differential DQS read measurements

### tDQSCK-Diff

tDQSCK-Diff is the DQS output access time from CK or CK#.

tDQSCK-Diff uses the DPOJET measurement, Skew.

The application calculates this measurement using the following equation:

$$Skew = T_n - T_{DQS(n)}$$

for mid level

Where:

$T_n$  specifies the clock edges.

$T_{DQS(n)}$  specifies the DQS edges.

The edge locations are determined by the mid-reference voltage levels. This is a skew measurement between the rising edge of DQS and the rising edge of clock.

For more details, refer to Skew in the DPOJET help.

---

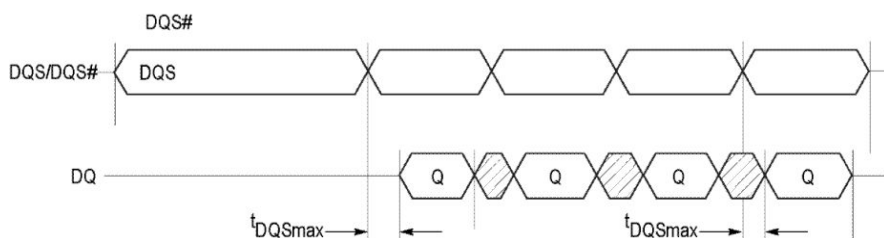
**NOTE.** The JEDEC standard specifies that tDQSCK is the actual position of a rising strobe edge relative to CK, CK#. Hence, DQS should be in phase with CK. When DQS and CK are not in phase, there could be possibility of probe polarity interchange. You can overcome this by changing the edge direction to Opposite as From under edges configure tab for Skew measurements. For more details, refer to Configuring Edges for Skew Measurement in the DPOJET help.

---

### tDQSQ-DBI

tDQSQ-DBI is the skew between DQS and DQ signal when Data Bus Inversion (DBI) is enabled.

tDQSQ-DBI uses the DPOJET measurement, Setup.

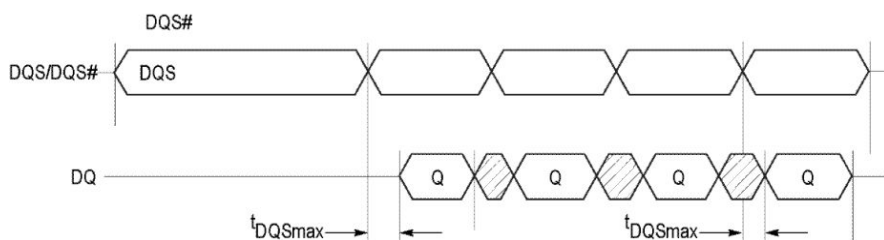


For more details, refer to Setup in the DPOJET help.

### tDQSQ-Diff

tDQSQ-Diff is the DQS-DQ skew for DQS and associated DQ signals. Set JEDEC standard reference levels for DQ.

tDQSQ-Diff uses the DPOJET measurement, Setup.



For more details, refer to Setup in the DPOJET help.

### tAC-Diff

tAC-Diff is the DQ output access time from CK or CK#. Set DQ as the clock source and DQS as the differential source. Set appropriate reference levels for DQ.

tAC-Diff uses the DPOJET measurement, DDR-Setup-Diff.

For more details, refer to DDR-Setup-Diff in the DPOJET help.

### tQH

tQH is the elapsed time between when the clock waveform crosses its own voltage reference level and the designated edge of a data waveform.

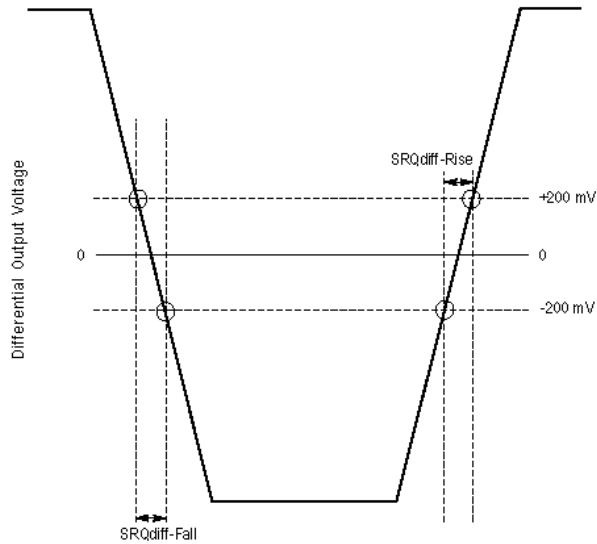
tQH uses the DPOJET measurement, Hold.

For more details, refer to Hold in the DPOJET help.

### SRQdiff-Rise(DQS)

SRQdiff-Rise(DQS) measures slew rate on differential DQS signals between the rising edges from low to high.

SRQdiff-Rise(DQS) uses the DPOJET measurement, Rise Slew Rate.



---

**NOTE.** The above figure is applicable for all DDR3 Slew Rate(Diff) measurements.

---

For more details, refer to Rise Slew Rate in the DPOJET help.

### SRQdiff-Fall(DQS)

SRQdiff-Fall(DQS) measures slew rate on differential DQS signals between the falling edges from high to low.

SRQdiff-Fall(DQS) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.



## Single-ended DQS read measurements

### tDQSQ-SE

vtDQSQ-SE is the skew measured between DQS and DQ single-ended signals.

tDQSQ-SE uses the DPOJET measurement, Setup.

For more details, refer to Setup in the DPOJET help.

### tDQSCK-SE

tDQSCK-SE is the DQS output access time from CK or CK#. DQS is a single-ended source and special [reference levels](#) are available. Clock is a differential source.

tDQSCK-SE uses the DPOJET measurement, Skew.

The application calculates this measurement using the following equation:

$$Skew = T_n - T_{DQS(n)}$$

for mid level

Where:

$T_n$  specifies the clock edges.

$T_{DQS(n)}$  specifies the DQS edges.

The edge locations are determined by the mid-reference voltage levels. This is a skew measurement between the rising edge of DQS and the rising edge of clock.

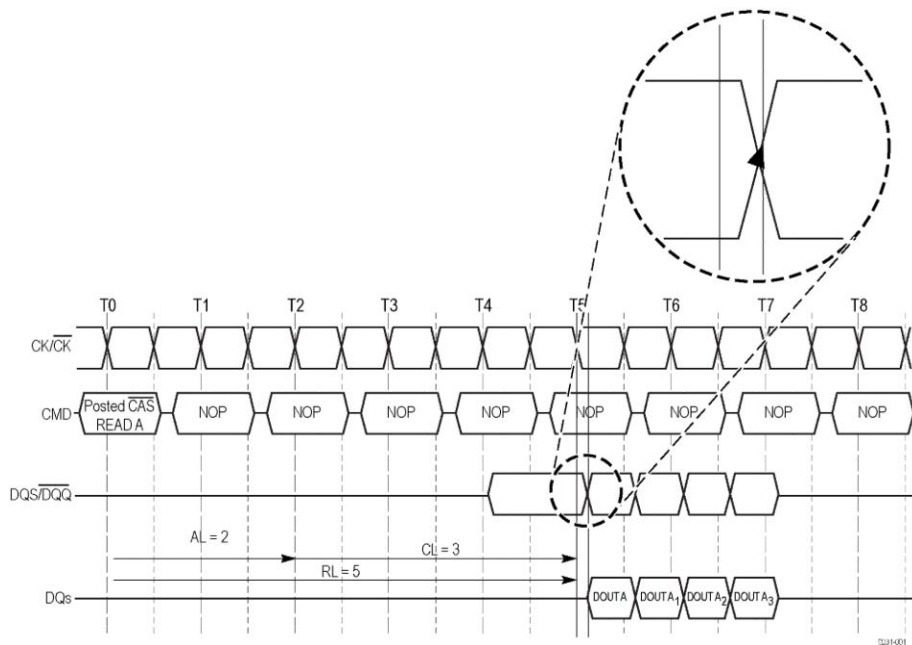
For more details, refer to Skew in the DPOJET help.

### DDR2-tDQSCK

tDQSCK is measured between the rising edge of clock before or after DQS Preamble time.

For more details, refer to DDR2-tDQSCK in the DPOJET help.

In the following screen capture, only DQS edge is considered after preamble region for all the respective ( READ or WRITE ) bursts in the acquisitions.



## Slew rate DQ

### SRQse-Fall(DQ)

SRQse-Fall(DQ) is defined as the single-ended output slew rate for falling edge and is measured between  $V_{OL(AC)}$  to  $V_{OH(AC)}$ .

The application calculates this measurement using the following equation:

$$SlewRate = (V_{OH(AC)} - V_{OL(AC)}) / \Delta t_{Fse}$$

Where:

$V_{OH(AC)}$  is the AC output high measurement level for output slew rate.

$V_{OL(AC)}$  is the AC output low measurement level for output slew rate.

### SRQse-Rise(DQ)

SRQse-Rise(DQ) is defined as the single-ended output slew rate for rising edge and is measured between  $V_{OH(AC)}$  to  $V_{OL(AC)}$ .

$$SlewRate = (V_{OL(AC)} - V_{OH(AC)}) / \Delta t_{Rse}$$

Where:

$V_{OH(AC)}$  is the AC output high measurement level for output slew rate.

$V_{OL(AC)}$  is the AC output low measurement level for output slew rate.

## tRDPDE

tRDPDE measures the elapsed time between the READ and POWERDOWN ENTRY commands.

tRDPDE uses the DPOJET measurement, tBurstToCMD. This measurement will appear under READ measurement type and available for GDDR5 generation only.

For more details, refer to tBurstToCMD in the DPOJET help.

## tRDSRE

tRDSRE measures the elapsed time between the READ and SELF REFRESH commands.

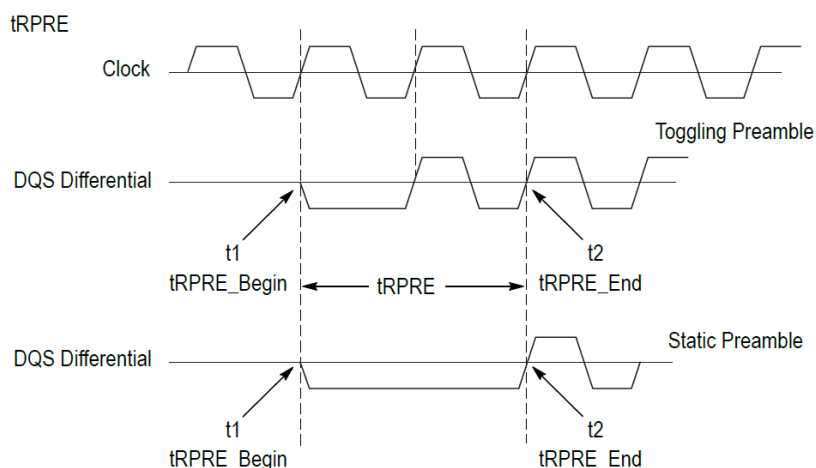
tRDSRE uses the DPOJET measurement, tBurstToCMD. This measurement will be available for GDDR5 generation only.

For more details, refer to tBurstToCMD in the DPOJET help.

## tRPRE

tRPRE is defined as the elapsed time on a DQS signal between tRPRE\_begin and tRPRE\_end. Normally the read preamble varies between 0.5 strobe cycles to 2 strobe cycles. The preamble length varies from DDR generation to generation. The following schematic shows two different types of Read preambles defined in the LPDDR4 spec.

tRPRE uses the DPOJET measurement, DDR tRPRE.



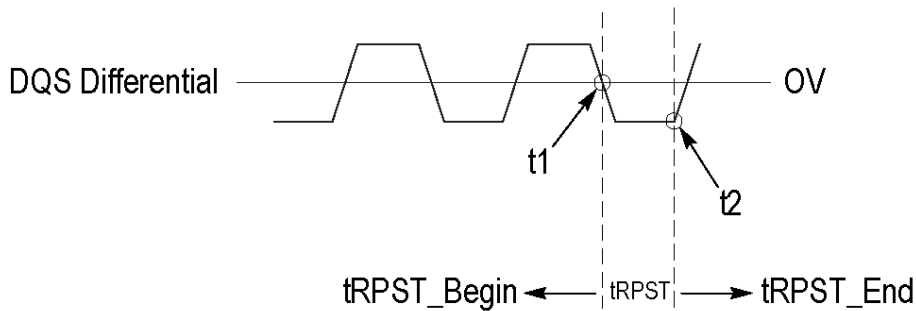
For more details, refer to DDR tRPRE in the DPOJET help.

## tRPST

tRPST is defined as the elapsed time on a DQS signal between tRPST\_begin and tRPST\_end.

Normally the length of the Read postamble is 0.5 tCK except for LPDDR4, which specifies two different types of Read postambles - 0.5 tCK and 1.5 tCK (also known as extended postamble).

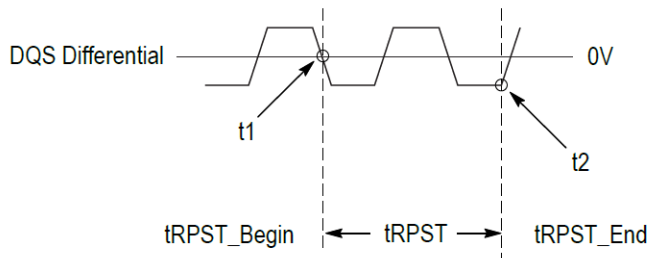
### tRPST



0231-008

The following schematic shows extended Read postamble for LPDDR4 generation.

### tRPST



tRPST uses the DPOJET measurement, DDR tRPST.

The application calculates this measurement using the following equation:

$$tRPST = t2(n) - t1(n)$$

For more details, refer to DDR tRPST in the DPOJET help.

## DQ measurements

### Slew Rate-Hold-Fall(DQ)

Slew Rate-Hold-Fall(DQ) measures the slew rate on the DQ signal between the falling edge from  $V_{REF}$  to  $V_{IL(ac)max}$ . This measurement is available for both DDR2 and DDR3 generation.

Slew Rate-Hold-Fall(DQ) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

### Slew Rate-Hold-Rise(DQ)

Slew Rate-Hold-Rise(DQ) measures the slew rate on the DQ signal between the rising edge from  $V_{REF}$  to  $V_{IH(ac)min}$ . This measurement is available for both DDR2 and DDR3 generation.

Slew Rate-Hold-Rise(DQ) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to Rise Slew Rate in the DPOJET help.

### Slew Rate-Setup-Fall(DQ)

Slew Rate-Setup-Fall(DQ) measures the slew rate on the DQ signal between the falling edge from  $V_{REF}$  to  $V_{IL(ac)max}$ . This measurement is available for both DDR2 and DDR3 generation.

Slew Rate-Setup-Fall(DQ) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

### Slew Rate-Setup-Rise(DQ)

Slew Rate-Setup-Rise(DQ) measures the slew rate on the DQ signal between the rising edge from  $V_{REF}$  to  $V_{IH(ac)min}$ . This measurement is available for both DDR2 and DDR3 generation.

Slew Rate-Setup-Rise(DQ) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to Rise Slew Rate in the DPOJET help.

## Clock(Diff) measurements

### SSC Downspread(CK)

SSC Downspread(CK) measures the SSC downspread for the clock.

SSC Downspread(CK) uses the DPOJET measurement, SSC-FREQ-DEV.

For more details, refer to SSC-FREQ-DEV in the DPOJET help.

### **SSC mod Freq(CK)**

SSC Mod Freq(CK) measures the SSC modulation frequency for the clock.

SSC Mod Freq(CK) uses the DPOJET measurement, SSC-MOD-FREQ.

For more details, refer to SSC-MOD-FREQ in the DPOJET help.

### **SSC Profile(CK)**

SSC Profile(CK) measures the SSC profile.

SSC Profile(CK) uses the DPOJET measurement, SSC-PROFILE.

For more details, refer to SSC-PROFILE in the DPOJET help.

### **tCH**

tCH is the high pulse width on the clock signal. It is the amount of time the waveform remains above the mid reference voltage level.

tCH uses the DPOJET measurement, Pos Width.

For more details, refer to Positive and Negative Width in the DPOJET help.

### **tCK**

tCK is the absolute clock period. It is the elapsed time between consecutive rising crossings of the mid reference CK voltage level.

tCK uses the DPOJET measurement, Period.

For more details, refer to Period in the DPOJET help.

### **tCL**

tCL is the low pulse width on the clock signal. It is the amount of time the waveform remains below the mid reference voltage level.

tCL uses the DPOJET measurement, Neg Width.

For more details, refer to Positive and Negative Width in the DPOJET help.

### **tCH(abs)**

tCH(abs) is the high pulse width on the clock signal. It is the amount of time the waveform remains above the mid reference voltage level.

tCH(abs) uses the DPOJET measurement, Pos Width.

For more details, refer to Positive and Negative Width in the DPOJET help.

**tCH(avg)**

tCH(avg) is the average width of the high-half cycle calculated across a sliding 200-cycle window of clock cycles.

tCH(avg) uses the DPOJET measurement, DDR tCH(avg).

The application calculates this measurement using the following equation:

$$tCH(avg) = \left( \sum_{j=1}^N tCH_j \right) / (N \times tCK(avg))$$

Where:

N=200, which is configurable.

**tCK(abs)**

tCK(abs) is the absolute clock period. It is the elapsed time between consecutive rising crossings of the mid reference CK voltage level.

tCK(abs) uses the DPOJET measurement, Period.

For more details, refer to Period in the DPOJET help.

**tCK(avg)**

tCK(avg) is calculated as the average clock period across a sliding 200-cycle window of low pulses.

tCK(avg) uses the DPOJET measurement, DDR tCK(avg).

The application calculates this measurement using the following equation:

$$tCK(avg) = \left( \sum_{j=1}^{200} tCK_j \right) / N$$

Where:

N=200, which is configurable.

Range: 200 ≤ N ≤ 1M

**tCL(abs)**

tCL(abs) is the low pulse width on the clock signal. It is the amount of time the waveform remains below the mid reference voltage level.

tCL(abs) uses the DPOJET measurement, Neg Width.

For more details, refer to Positive and Negative Width in the DPOJET help.

**tCL(avg)**

tCL(avg) is defined as the average low pulse width calculated across 200-cycle window of consecutive low pulses.

tCL(avg) uses the DPOJET measurement, DDR tCL(avg).

The application calculates this measurement using the following equation:

$$tCL(avg) = \left( \frac{N}{\sum_{j=1}^N tCL_j} \right) / (N \times tCK(avg))$$

Where:

$N=200$ , which is configurable.

Range:  $200 \leq N \leq 1M$

**tHP**

tHP is the minimum of the absolute half period of the actual input clock. It is similar to DPOJET's Period measurement where the edge type is clock with edges selection set to both. Only the minimum result statistics will be compared with the limit values for PASS/FAIL status.

The application calculates this measurement using the following equation:

$$tHP = \text{Min}(tCH(abs), tCL(abs))$$

Where:

$tCH(abs)$  is the minimum of the actual instantaneous clock high time.

$tCL(abs)$  is the minimum of the actual instantaneous clock low time.

**tERR**

✓ tERR (Timing error) is the time difference between the sum of tCK transitions for a 200-cycle window to  $n$  times tCK(avg). The calculated value represents the accumulated error across many cycles ( $n$ ). The number of cycles to be used is defined by  $n$ , which is configurable.

The application calculates this measurement using the following equation:

$$tERR(nper) = \left( \sum_{j=1}^{i+n-1} tCK_j \right) - n \times tCK(avg)$$

Where:

**For tERR(nper):**

$n=2$  for tERR(2 per)

$n=3$  for tERR(3 per)

$n=4$  for tERR(4 per)

$n=5$  for tERR(5 per)



$n=6$  for  $tERR(6\ per)$

.

.

.

.

$n=49$  for  $tERR(49\ per)$

**For  $tERR(m\ nper)$ :**

$6 \leq n \leq 10$  for  $tERR(6-10\ per)$

$11 \leq n \leq 50$  for  $tERR(11-50\ per)$

$13 \leq n \leq 50$  for  $tERR(13-50\ per)$

### **tJIT(cc)**

tJIT(cc) is the difference in period measurements from one cycle to the next; that is, the first difference of the Period measurement.

tJIT(cc) uses the DPOJET measurement, CC-Period.

The application calculates this measurement using the following equation:

$$tJIT(cc) = \text{Max of } |tCK_{i+1} - tCK_i|$$

### **tJIT(duty)**

tJIT(duty) is the largest elapsed time between the tCH from tCH(avg) or tCL from tCL(avg) for a 200-cycle window. This value represents the maximum of the accumulated value across a 200-cycle moving window.

tJIT(duty) uses the DPOJET measurement, DDR tJIT(duty).

The application calculates this measurement using the following equation:

$$tJIT(duty) = \text{Min/max of } \{tJIT(CH), tJIT(CL)\}$$

Where:

$$tJIT(CH) = \{tCH_i - tCH(avg)\}$$

$$tJIT(CL) = \{tCL_i - tCL(avg)\}$$

Where:

$i=1$  to 200

### tJIT(per)

tJIT(per) is the largest elapsed time between the tCK from tCK(avg) for a 200-cycle window. This value represents the maximum of the accumulated value across a 200-cycle moving window.

tJIT(per) uses the DPOJET measurement, DDR tJIT(per).

The application calculates this measurement using the following equation:

$$tJIT(per) = \text{Min/max of } \{tCK_i - tCK(avg)\}$$

Where:

i=1 to 200

### VID(ac)

VID(ac) is defined as the magnitude of the difference between the input voltage on CK and the input voltage on CK#.

VID(ac) uses the DPOJET measurement, DDR VID(ac).

For more details, refer to DDR VID(ac) in the DPOJET help.

### Input Slew-Diff-Rise(CK)

Input Slew-Diff-Rise(CK) measures slew rate on differential CK signals between the rising edges from low to high. The clock differential voltage varies from 500 mV to -250 mV.

Input Slew-Diff-Rise(CK) uses the DPOJET measurement, Rise Slew Rate.

---

**NOTE.** This measurements is common for both Clock(Diff) and Address/Command measurement types.

---

For more details, refer to Rise Slew Rate in the DPOJET help.

### Input Slew-Diff-Fall(CK)

Input Slew-Diff-Fall(CK) measures slew rate on differential CK signals between falling edges from clock high to low. The clock differential voltage varies from +500 mV to -250 mV.

Input Slew-Diff-Fall(CK) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

## Clock (Single ended)

### AC-Overshoot(CK#)

AC-Overshoot(CK#) is the positive-going amplitude, for each waveform event that exceeds the Vdd reference level on the CK# signal.

AC-Overshoot(CK#) uses the DPOJET measurement, Overshoot.

---

**NOTE.** If the input waveform never exceeds Vdd, the measurement will return a population of 0 events.

---

For more details, refer to Overshoot in the DPOJET help.

### AC-Overshoot(CK)

AC-Overshoot(CK) is the positive-going amplitude, for each waveform event that exceeds the Vdd reference level on the CK signal.

AC-Overshoot(CK) uses the DPOJET measurement, Overshoot.

---

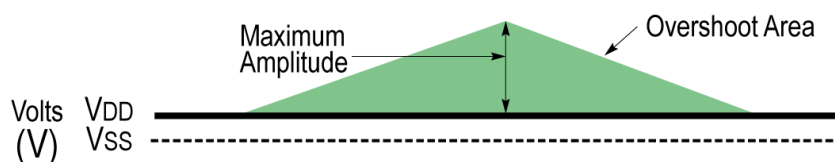
**NOTE.** If the input waveform never exceeds Vdd, the measurement will return a population of 0 events.

---

For more details, refer to Overshoot in the DPOJET help.

### AC-OvershootArea(CK#)

AC-OvershootArea(CK#) is defined as the triangular area obtained by considering the voltage value closest to the maximum peak point on the CK# signal. The triangular area is obtained using the Overshoot width and the amplitude. The units for OvershootArea is V-ns.



AC-OvershootArea(CK#) uses the DPOJET measurement, DDR Over Area.

$$\text{OvershootArea} = 0.5 * \text{Base} * \text{Height}$$

Where:

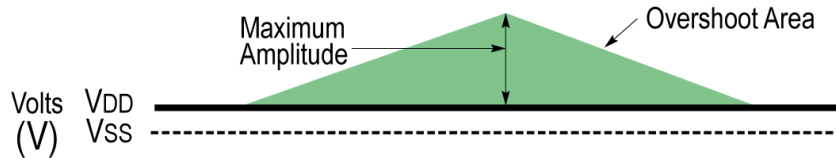
*Base* is the overshoot width.

*Height* is the overshoot amplitude.

For more details, refer to DDR Over Area in the DPOJET help.

## AC-OvershootArea(CK)

AC-OvershootArea(CK) is defined as the triangular area obtained by considering the voltage value closest to the maximum peak point on the CK signal. The triangular area is obtained using the Overshoot width and the amplitude. The units for OvershootArea is V-ns.



AC-OvershootArea(CK) uses the DPOJET measurement, DDR Over Area.

$$\text{OvershootArea} = 0.5 * \text{Base} * \text{Height}$$

Where:

*Base* is the overshoot width.

*Height* is the overshoot amplitude.

AC-Overshoot(CK) uses the DPOJET measurement, DDR Over Area.

For more details, refer to DDR Over Area in the DPOJET help.

## AC-Undershoot(CK#)

AC-Undershoot(CK#) is the negative-going amplitude (expressed as a positive number), for each waveform event that goes below the Vss reference level on the CK# signal.

AC-Undershoot(CK#) uses the DPOJET measurement, Undershoot.

---

**NOTE.** If the input waveform never goes below Vss, the measurement will return a population of 0 events.

---

For more details, refer to Undershoot in the DPOJET help.

## AC-Undershoot(CK)

AC-Undershoot(CK) is the negative-going amplitude (expressed as a positive number), for each waveform event that goes below the Vss reference level on the CK signal.

AC-Undershoot(CK) uses the DPOJET measurement, Undershoot.

---

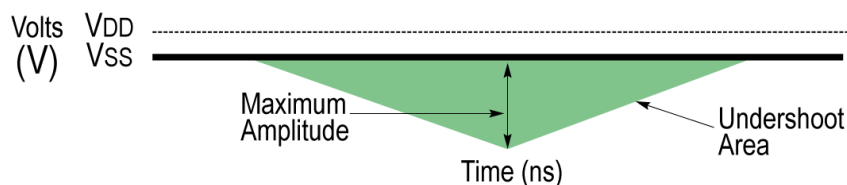
**NOTE.** If the input waveform never goes below Vss, the measurement will return a population of 0 events.

---

For more details, refer to Undershoot in the DPOJET help.

### AC-UndershootArea(CK#)

AC-UndershootArea(CK#) is defined as the inverted triangular area obtained by considering the voltage value closest to the maximum peak point on the CK# signal. The triangular area is obtained using the undershoot width and the amplitude. The units for UndershootArea is V-ns.



AC-UndershootArea(CK#) uses the DPOJET measurement, DDR Under Area.

$$\text{UndershootArea} = 0.5 * \text{Base} * \text{Height}$$

Where:

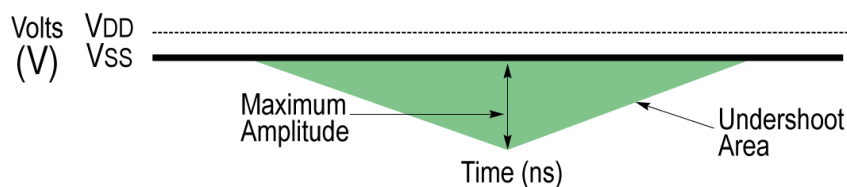
*Base* is the undershoot width.

*Height* is the undershoot amplitude.

For more details, refer to DDR Under Area in the DPOJET help.

### AC-UndershootArea(CK)

AC-UndershootArea(CK) is defined as the inverted triangular area obtained by considering the voltage value closest to the maximum peak point on the CK signal. The triangular area is obtained using the undershoot width and the amplitude. The units for UndershootArea is V-ns.



AC-UndershootArea(CK) uses the DPOJET measurement, DDR Under Area.

$$\text{UndershootArea} = 0.5 * \text{Base} * \text{Height}$$

Where:

*Base* is the undershoot width.

*Height* is the undershoot amplitude.

For more details, refer to DDR Under Area in the DPOJET help.

**CKslew-Fall(CK)**

CKslew-Fall(CK) measures the single ended CD fall slew rate.

CKslew-Fall(CK) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

**CKslew-Fall(CK#)**

CKslew-Fall(CK#) measures the single ended CD fall slew rate.

CKslew-Fall(CK#) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

**CKslew-Rise(CK)**

CKslew-Rise(CK) measures the single ended CK rise slew rate.

CKslew-Rise(CK) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to Rise Slew Rate in the DPOJET help.

**CKslew-Rise(CK#)**

CKslew-Rise(CK#) measures the single ended CK# rise slew rate.

CKslew-Rise(CK#) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to Rise Slew Rate in the DPOJET help.

**VIN(CK)**

VIN(CK) measures the single ended CK clock input voltage level.

VIN(CK) uses the DPOJET measurement, High-Low.

For more details, refer to High-Low in the DPOJET help.

**VIN(CK#)**

VIN(CK#) measures the single ended CK# clock input voltage level.

VIN(CK#) uses the DPOJET measurement, High-Low.

For more details, refer to High-Low in the DPOJET help.

**Vix(ac)CK**

Vix(ac)CK is defined as the cross-point voltage for differential input signals measured across the clock signal.

Vix(ac)CK uses the DPOJET measurement, V-Diff-Xovr.

For more details, refer to V-Diff-Xovr in the DPOJET help.

For DDR3 generation, the measurement uses DPOJET measurement, DDR3 Vix(ac).

For more details, refer to DDR3 Vix(ac) in the DPOJET help.

## Vox(ac)CK

Vox(ac)CK is defined as the cross-point voltage for differential input signals measured across the clock signal.

Vox(ac)CK uses the DPOJET measurement, V-Diff-Xovr.

For more details, refer to V-Diff-Xovr in the DPOJET help.

## VSWING(MAX)CK#

VSWING(MAX)CK# is defined as the maximum input voltage on the clock signal (CK#). Available only for DDR2 generation.



VSWING(MAX)CK# uses the DPOJET measurement, Cycle Pk-Pk.

For more details, refer to Cycle Pk-Pk in the DPOJET help.

## VSWING(MAX)CK

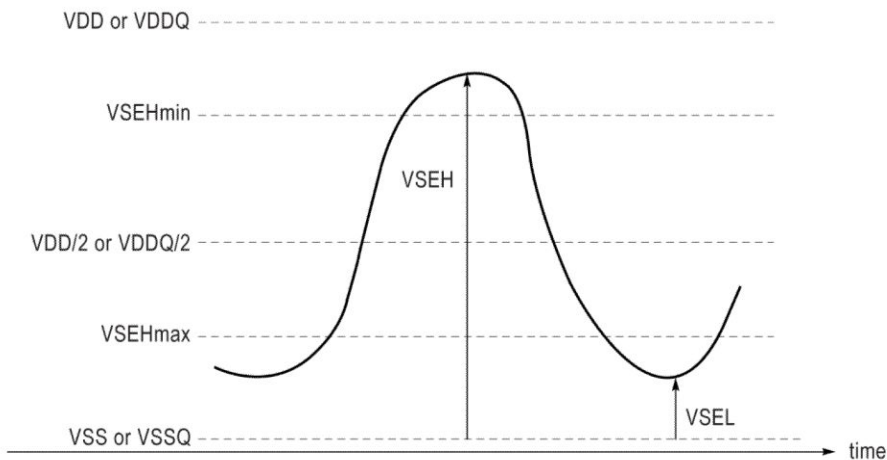
VSWING(MAX)CK is defined as the maximum input voltage on the clock signal (CK). Available only for DDR2 generation.

VSWING(MAX)CK uses the DPOJET measurement, Cycle Pk-Pk.

For more details, refer to Cycle Pk-Pk in the DPOJET help.

## VSEH(AC)CK

VSEH(AC)CK is defined as the single-ended high level voltage for the CK signal. Available only for LPDDR2 and DDR3 generation.




---

**NOTE.** The same illustration is applicable for other measurements such as  $VSEH(AC)CK\#$ ,  $VSEH(CK\#)$ ,  $VSEH(CK)$ ,  $VSEL(AC)CK\#$ ,  $VSEL(AC)CK\#$ ,  $VSEL(AC)CK$ ,  $VSEL(CK\#)$ , and  $VSEL(CK)$ .

---

$VSEH(AC)CK$  uses the DPOJET measurement, Cycle Max.

For more details, refer to Cycle Max in the DPOJET help.

### **$VSEH(AC)CK\#$**

$VSEH(AC)CK\#$  is defined as the single-ended high level voltage for the  $CK\#$  signal. Available only for LPDDR2 and DDR3 generation.

$VSEH(AC)CK\#$  uses the DPOJET measurement, Cycle Max.

For more details, refer to Cycle Max in the DPOJET help.

### **$VSEH(CK\#)$**

$VSEH(CK\#)$  is defined as the single-ended high level voltage for the  $CK\#$  signal. Available only for DDR3 generation.

$VSEH(CK\#)$  uses the DPOJET measurement, Cycle Max.

For more details, refer to Cycle Max in the DPOJET help.

### **$VSEH(CK)$**

$VSEH(CK)$  is defined as the single-ended high level voltage for the  $CK$  signal. Available only for DDR3 generation.

$VSEH(CK)$  uses the DPOJET measurement, Cycle Max.

For more details, refer to Cycle Max in the DPOJET help.



### **VSEL(AC)CK#**

VSEL(AC)CK is defined as the single-ended low level voltage for the CK# signal. Available only for LPDDR2 and DDR3 generation.

VSEL(AC)CK# uses the DPOJET measurement, Cycle Min.

For more details, refer to Cycle Min in the DPOJET help.

### **VSEL(AC)CK**

VSEL(AC)CK is defined as the single-ended low level voltage for the CK signal. Available only for LPDDR2 and DDR3 generation.

VSEL(AC)CK uses the DPOJET measurement, Cycle Min.

For more details, refer to Cycle Min in the DPOJET help.

### **VSEL(CK#)**

VSEL(CK#) is defined as the single-ended low level voltage for the CK# signal. Available only for DDR3 generation.

VSEH(CK) uses the DPOJET measurement, Cycle Min.

For more details, refer to Cycle Min in the DPOJET help.

### **VSEL(CK)**

VSEL(CK) is defined as the single-ended low level voltage for the CK signal. Available only for DDR3 generation.

VSEH(CK) uses the DPOJET measurement, Cycle Min.

For more details, refer to Cycle Min in the DPOJET help.

## **DQS(Single ended) measurements**

### **Vix(ac)DQS**

Vix(ac)DQS is defined as the cross-point voltage for differential input signals measured across the DQS signal.

Vix(ac)DQS uses the DPOJET measurement, V-Diff-Xovr.

For more details, refer to V-Diff-Xovr in the DPOJET help.

For DDR3 generation, the measurement uses DPOJET measurement, DDR3 Vix(ac).

For more details, refer to DDR3 Vix(ac) in the DPOJET help.

### **Vox(ac)DQS**

Vox(ac)DQS is defined as the cross-point voltage for differential input signals measured across the DQS signal.

Vox(ac)DQS uses the DPOJET measurement, V-Diff-Xovr.

For more details, refer to V-Diff-Xovr in the DPOJET help.

### AC-Overshoot(DQS)

AC-Overshoot(DQS) is the positive-going amplitude, for each waveform event that exceeds the Vdd reference voltage level on the DQS signal.

AC-Overshoot(DQS) uses the DPOJET measurement, Overshoot.

---

**NOTE.** If the input waveform never exceeds the specified reference level, the measurement will return a population of 0 events.

---

For more details, refer to Overshoot in the DPOJET help.

### AC-Overshoot(DQS#)

AC-Overshoot(DQS#) is the positive-going amplitude, for each waveform event that exceeds the Vdd reference level on the DQS# signal.

AC-Overshoot(DQS#) uses the DPOJET measurement, Overshoot.

---

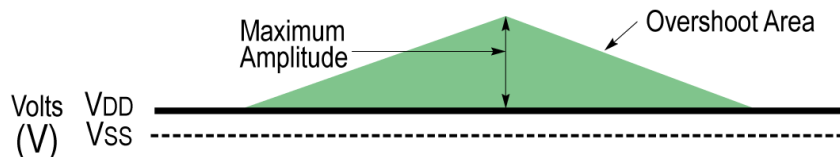
**NOTE.** If the input waveform never exceeds the specified reference level, the measurement will return a population of 0 events.

---

For more details, refer to Overshoot in the DPOJET help.

### AC-OvershootArea(DQS#)

AC-OvershootArea(DQS#) is defined as the triangular area obtained by considering the voltage value closest to the maximum peak point on the DQS# signal. The triangular area is obtained using the overshoot width and the amplitude. The units for OvershootArea is V-ns.



AC-OvershootArea(DQS#) uses the DPOJET measurement, DDR Over Area.

$$\text{OvershootArea} = 0.5 * \text{Base} * \text{Height}$$

Where:

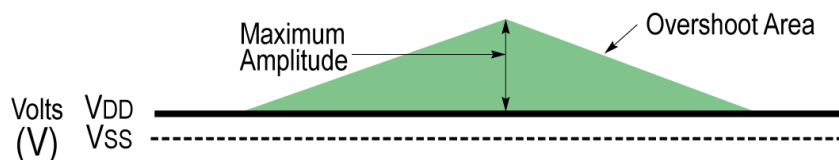
*Base* is the overshoot width.

*Height* is the overshoot amplitude.

For more details, refer to DDR Over Area in the DPOJET help.

### AC-OvershootArea(DQS)

AC-OvershootArea(DQS) is defined as the triangular area obtained by considering the voltage value closest to the maximum peak point on the CK# signal. The triangular area is obtained using the overshoot width and the amplitude. The units for OvershootArea is V-ns.



AC-OvershootArea(DQS) uses the DPOJET measurement, DDR Over Area.

$$\text{OvershootArea} = 0.5 * \text{Base} * \text{Height}$$

Where:

*Base* is the overshoot width.

*Height* is the overshoot amplitude.

For more details, refer to DDR Over Area in the DPOJET help.

### AC-Undershoot(DQS)

AC-Undershoot(DQS) is the negative-going amplitude (expressed as a positive number), for each waveform event that goes below the Vss reference level on the DQS signal.

AC-Undershoot(DQS) uses the DPOJET measurement, Undershoot.

---

**NOTE.** If the input waveform never goes below the specified reference level, the measurement will return a population of 0 events.

---

For more details, refer to Undershoot in the DPOJET help.

### AC-Undershoot(DQS#)

AC-Undershoot(DQS#) is the negative-going amplitude (expressed as a positive number), for each waveform event that goes below the reference level on the DQS# signal.

AC-Undershoot(DQS#) uses the DPOJET measurement, Undershoot.

---

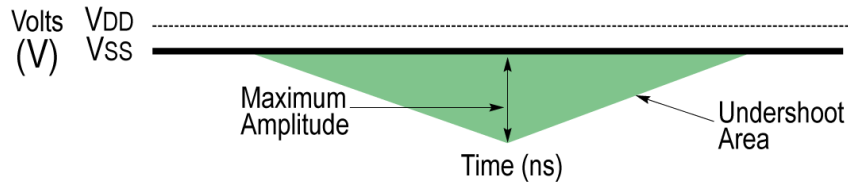
**NOTE.** If the input waveform never goes below the specified reference level, the measurement will return a population of 0 events.

---

For more details, refer to Undershoot in the DPOJET help.

### AC-UndershootArea(DQS#)

AC-UndershootArea(DQS#) is defined as the inverted triangular area obtained by considering the voltage value closest to the maximum peak point on the DQS# signal. The triangular area is obtained using the undershoot width and the amplitude. The units for UndershootArea is V-ns.



AC-UndershootArea(DQS#) uses the DPOJET measurement, DDR Under Area.

$$\text{UndershootArea} = 0.5 * \text{Base} * \text{Height}$$

Where:

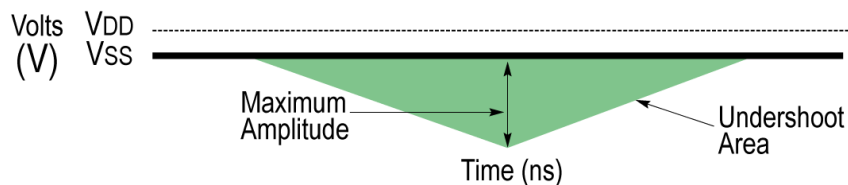
*Base* is the undershoot width.

*Height* is the undershoot amplitude.

For more details, refer to DDR Under Area in the DPOJET help.

### AC-UndershootArea(DQS)

AC-UndershootArea(DQS) is defined as the inverted triangular area obtained by considering the voltage value closest to the maximum peak point on the DQS signal. The triangular area is obtained using the undershoot width and the amplitude. The units for UndershootArea is V-ns.



AC-UndershootArea(DQS) uses the DPOJET measurement, DDR Under Area.

$$\text{UndershootArea} = 0.5 * \text{Base} * \text{Height}$$

Where:

*Base* is the undershoot width.

*Height* is the undershoot amplitude.

For more details, refer to DDR Under Area in the DPOJET help.

## WCK (Diff)

### SSC Downspread(WCK)

SSC Downspread(WCK) measures the SSC downspread for WCK.

SSC Downspread(WCK) uses the DPOJET measurement, SSC-FREQ-DEV.

For more details, refer to SSC-FREQ-DEV in the DPOJET help.

### SSC mod Freq(WCK)

SSC Mod Freq(WCK) measures the SSC modulation frequency for WCK.

SSC Mod Freq(WCK) uses the DPOJET measurement, SSC-MOD-FREQ.

For more details, refer to SSC-MOD-FREQ in the DPOJET help.

### SSC Profile(WCK)

SSC Profile(WCK) measures the SSC profile.

SSC Profile(WCK) uses the DPOJET measurement, SSC-PROFILE.

For more details, refer to SSC-PROFILE in the DPOJET help.

### tDVAC(WCK)

tDVAC(WCK) is defined as the allowed time before ring back of WCK below VIDCK/WCK (AC) reference levels.

tDVAC(WCK) uses the DPOJET measurement, Time Outside Level.

For more details, refer to Time Outside Level in the DPOJET help. tDVAC(WCK) is used for GDDR5 generation.

### tWCK

tWCK measures the WCK clock cycle time.

tWCK uses the DPOJET measurement, Period.

For more details, refer to Period in the DPOJET help.

### tWCK-DJ

tWCK-DJ is defined as the WCK diff deterministic jitter.

tWCK-DJ uses the DPOJET measurement, DJ.

For more details, refer to DJ in the DPOJET help.

### **tWCKH**

tWCKH measures the WCK clock high-level width.

tWCKH uses the DPOJET measurement, Positive and Negative Width.

For more details, refer to Positive and Negative Width in the DPOJET help.

### **tWCKHP**

tWCKHP measures the minimum WCK clock half period.

tWCKHP uses the DPOJET measurement, Period.

For more details, refer to Period in the DPOJET help.

### **tWCKL**

tWCKL measures the WCK clock low-level width.

tWCKL uses the DPOJET measurement, Positive and Negative Width.

For more details, refer to Positive and Negative Width in the DPOJET help.

### **tWCK-Rise-Slew**

tWCK-Rise-Slew measures the WCK diff rise slew rate.

tWCK-Rise-Slew uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to Rise Slew Rate in the DPOJET help.

### **tWCK-Fall-Slew**

tWCK-Fall-Slew measures the WCK diff fall slew rate.

tWCK-Fall-Slew uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

### **tWCK-RJ**

tWCK-RJ is defined as the WCK diff random jitter.

tWCK-RJ uses the DPOJET measurement, RJ.

For more details, refer to RJ in the DPOJET help.

### **tWCK-TJ**

tWCK-TJ is defined as the WCK diff total jitter.

tWCK-TJ uses the DPOJET measurement, TJ@BER.

For more details, refer to TJ@BER in the DPOJET help.

### **VWCK-Swing**

VWCK-Swing is defined as the WCK differential logic high voltage.

VWCK-Swing uses the DPOJET measurement, High-Low.

For more details, refer to High-Low in the DPOJET help.

## **WCK (Single ended)**

### **VIN(WCK)**

VIN(WCK) measures the single ended WCK clock input voltage level.

VIN(WCK) uses the DPOJET measurement, High-Low.

For more details, refer to High-Low in the DPOJET help.

### **VIN(WCK#)**

VIN(WCK#) measures the single ended WCK clock input voltage level.

VIN(WCK#) uses the DPOJET measurement, High-Low.

For more details, refer to High-Low in the DPOJET help.

### **Vix(ac)WCK**

Vix(ac)WCK is defined as the cross-point voltage for differential input signals measured across the clock signal.

Vix(ac)WCK uses the DPOJET measurement, V-Diff-Xovr.

For more details, refer to V-Diff-Xovr in the DPOJET help.

For DDR3 generation, the measurement uses DPOJET measurement, DDR3 Vix(ac).

For more details, refer to DDR3 Vix(ac) in the DPOJET help.

### **VOL(WCK)**

VOL(WCK) measures the single ended logic low voltage of the WCK signal.

VOL(WCK) uses the DPOJET measurement, Low.

For more details, refer to Low in the DPOJET help.

### **VOH(WCK)**

VOH(WCK) measures the single ended logic high voltage of the WCK signal.

VOH(WCK) uses the DPOJET measurement, High.

For more details, refer to High in the DPOJET help.

### **VOL(WCK#)**

VOL measures the single ended logic low voltage of the WCK# signal.

VOL uses the DPOJET measurement, Low.

For more details, refer to topic Low in the DPOJET help.

### **VOH(WCK#)**

VOH measures the single ended logic high voltage of the WCK# signal.

VOH uses the DPOJET measurement, High.

For more details, refer to High in the DPOJET help.

### **WCKslew-Fall(WCK)**

WCKslew-Fall(WCK) measures the single ended WCK fall slew rate.

WCKslew-Fall(WCK) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

### **WCKslew-Fall(WCK#)**

WCKslew-Fall(WCK#) measures the single ended WCK# fall slew rate.

WCKslew-Fall(WCK#) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

### **WCKslew-Rise(WCK)**

WCKslew-Rise(WCK) measures the single ended WCK rise slew rate.

WCKslew-Rise(WCK) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to the topic Rise Slew Rate in the DPOJET help.

### **WCKslew-Rise(WCK#)**

WCKslew-Rise(WCK#) measures the single ended WCK rise slew rate.

WCKslew-Rise(WCK#) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to Rise Slew Rate in the DPOJET help.

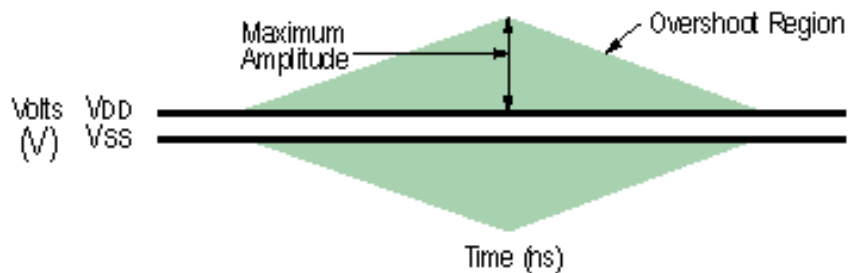


## Address-Command measurements

### AC-Overshoot

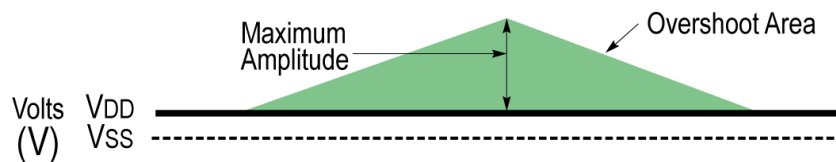
AC-Overshoot is the maximum positive-going amplitude relative to Vdd, for each waveform event that exceeds the Vdd reference voltage level.

AC-Overshoot uses the DPOJET measurement, Overshoot.



### AC-OvershootArea

AC-OvershootArea is defined as the triangular area obtained by considering the voltage value closest to the maximum peak point. The triangular area is obtained using the overshoot width and the amplitude. The units for OvershootArea is V-ns.



AC-OvershootArea uses the DPOJET measurement, DDR Over Area.

$$\text{OverShoot Area} = 0.5 * \text{Base} * \text{Height}$$

Where:

*Base* is the overshoot width.

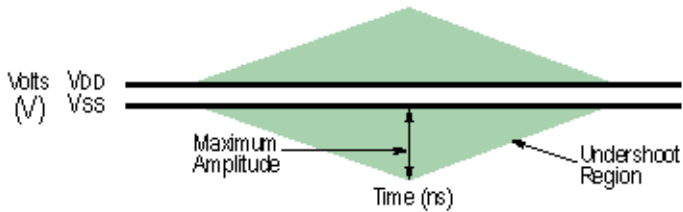
*Height* is the overshoot amplitude.

For more details, refer to DDR Over Area in the DPOJET help.

## AC-Undershoot

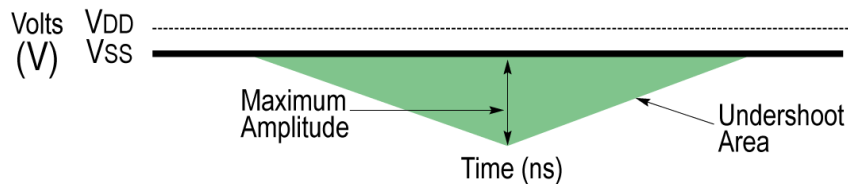
AC-Undershoot is the negative-going amplitude (expressed as a positive number) relative to  $V_{SS}$ , for each waveform event that goes below the  $V_{SS}$  reference voltage level.

AC-Undershoot uses the DPOJET measurement, Undershoot.



## AC-UndershootArea

AC-UndershootArea is defined as the inverted triangular area obtained by considering the voltage value closest to the maximum peak point. The triangular area is obtained using the undershoot width and the amplitude. The units for UndershootArea is V-ns.



AC-UndershootArea uses the DPOJET measurement, DDR UnderArea.

The application calculates this measurement using the following equation:

$$\text{UnderShoot Area} = 0.5 * \text{Base} * \text{Height}$$

Where:

*Base* is the undershoot width.

*Height* is the undershoot amplitude.

For more details, refer to DDR Under Area in the DPOJET help.

**Slew Rate-Hold-Fall(Addr-Cmd)**

Slew Rate-Hold-Fall(Addr/Cmd) measures the slew rate on the Addr/Cmd signal between the falling edge from  $V_{REF}$  to  $V_{IL(ac)max}$ . This measurement is available for DDR2, DDR3, and LPDDR2 generation.

Slew Rate-Hold-Fall(Addr/Cmd) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

Slew Rate-Hold-Fall(DQ) measures the slew rate on the DQ signal between the falling edge from  $V_{REF}$  to  $V_{IL(ac)max}$ . This measurement is available for both DDR2 and DDR3 generation.

**Slew Rate-Hold-Rise(Addr-Cmd)**

Slew Rate-Hold-Rise(Addr/Cmd) measures the slew rate on the Addr/Cmd signal between the rising edge from  $V_{REF}$  to  $V_{IH(ac)min}$ . This measurement is available for DDR2, DDR3, and LPDDR2 generation.

Slew Rate-Hold-Rise(Addr/Cmd) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer in Rise Slew Rate in the DPOJET help.

**Slew Rate-Setup-Fall(Addr-Cmd)**

Slew Rate-Setup-Fall(Addr/Cmd) measures the slew rate on the Addr/Cmd signal between the falling edge from  $V_{REF}$  to  $V_{IL(ac)max}$ . This measurement is available for DDR2, DDR3, and LPDDR2 generation.

Slew Rate-Setup-Fall(Addr/Cmd) uses the DPOJET measurement, Fall Slew Rate.

For more details, refer to Fall Slew Rate in the DPOJET help.

**Slew Rate-Setup-Rise(Addr-Cmd)**

Slew Rate-Setup-Rise(Addr/Cmd) measures the slew rate on the Addr/Cmd signal between the rising edge from  $V_{REF}$  to  $V_{IH(ac)min}$ . This measurement is available for DDR2, DDR3, and LPDDR2 generation.

Slew Rate-Setup-Rise(Addr/Cmd) uses the DPOJET measurement, Rise Slew Rate.

For more details, refer to Rise Slew Rate in the DPOJET help.

**tAH**

tAH measures the address input hold time.

tAH uses the DPOJET measurement, Hold.

For more details, refer to Hold of the DPOJET help.

**tAPW**

tAPW measures the address input pulse width.

tAPW uses the DPOJET measurement, Period.

For more details, refer in Period in the DPOJET help.

### **tAS**

tAS measures the address input setup time.

tAS uses the DPOJET measurement, Setup.

For more details, refer to Setup in the DPOJET help.

### **tCIPW-High**

tCIPW-High is the positive pulse width measured on an address and command signal. This uses the DPOJET measurement, Pos Width.

### **tCIPW-Low**

tCIPW-low is the negative pulse width measured on an address and command signal. This uses the DPOJET measurement, Neg Width.

### **tCMDH**

tCMDH measures the command input hold time.

tCMDH uses the DPOJET measurement, Hold.

For more details, refer to Hold in the DPOJET help.

### **tCMDPW**

tCMDPW measures the command input pulse width.

tCMDPW uses the DPOJET measurement, Period.

For more details, refer Period in the DPOJET help.

### **tCMDS**

tCMDS measures the command input setup time.

tCMDS uses the DPOJET measurement, Setup.

For more details, refer Setup in the DPOJET help.

### **tIS(base)**

tIS(base) is the input setup time measured on an address and command signal to the clock signal.

tIS(base) uses the DPOJET measurement, DDR Setup-Diff.

For more details, refer to DDR-Setup-Diff in the DPOJET help.

### **tIH(base)**

tIH(base) is the input hold time measured on an address and command signal to the clock signal.

tIH(base) uses the DPOJET measurement, DDR Hold-Diff.

For more details, refer to DDR Hold-Diff in the DPOJET help.

### **tIS(derated)**

Derating limits are calculated by adding the tIS(base) limit and  $\Delta tIS$ (derating) value.  $\Delta tIS$  for a rising signal is defined as the slew rate between the last crossing of  $V_{REF(dc)}$  and the first crossing of  $V_{IH(ac)min}$ , and for a falling signal is defined as the slew rate between the last crossing of  $V_{REF(dc)}$  and the first crossing of  $V_{il(ac)max}$ .

tIS(derated) uses the DPOJET measurement, DDR Setup-Diff.

$$tIS = tIS(base) + \Delta tIS$$

For more details, refer to DDR-Setup-Diff in the DPOJET help.

### **tIH(derated)**

Derating limits are calculated by adding the tIH(base) limit and  $\Delta tIH$ (derating) value.  $\Delta tIH$  for a rising signal is defined as the slew rate between the last crossing of  $V_{IL(dc)max}$  and the first crossing of  $V_{REF(dc)}$ , and for a falling signal is defined as the slew rate between the last crossing of  $V_{IH(dc)min}$  and the first crossing of  $V_{REF(dc)}$ .

tIH(derated) uses the DPOJET measurement, DDR Hold-Diff.

For more details, refer to DDR-Hold-Diff in the DPOJET help.

### **tIPW-High**

tIPW-High is the high input pulse width measured on an address and command signal.

tIPW-High uses the DPOJET measurement, Pos Width.

For more details, refer to Pos Width in the DPOJET help.

### **tIPW-Low**

tIPW-Low is the low input pulse width measured on an address and command signal.

tIPW-Low uses the DPOJET measurement, Neg Width.

For more details, refer to Neg Width in the DPOJET help.

## **Refresh**

### **tCKSRE**

tCKSRE measures the valid CK clocks required before self refresh exit.

tCKSRE uses the DPOJET measurement, tCKSRE.

For more details, refer to tCKSRE in the DPOJET help.

### **tCKSRX**

tCKSRX measures the valid CK clocks required before self refresh exit.

tCKSRX uses the DPOJET measurement, tCKSRX.

For more details, refer to tCKSRX in the DPOJET help.

**tRFC**

tRFC measures the refresh command period.

tRFC uses the DPOJET measurement, tCMD-CMD.

For more details, refer to tCMD-CMD in the DPOJET help.

**tREFTR(Read)**

tREFTR(Read) measures the refresh to RDTR command delay.

tREFTR(Read) uses the DPOJET measurement, tCMD-CMD.

For more details, refer to the topic tCMD-CMD in the DPOJET help.

**tREFTR(Write)**

tREFTR(Write) measures the refresh to WRTR command delay.

tREFTR(Write) uses the DPOJET measurement, tCMD-CMD.

For more details, refer to the topic tCMD-CMD of the DPOJET help.

**tXSNRW**

tXSNRW measures the exit self refresh to non-read.write command delay.

tXSNRW uses the DPOJET measurement, tCMD-CMD.

For more details, refer to tCMD-CMD in the DPOJET help.

**Power down****tPD**

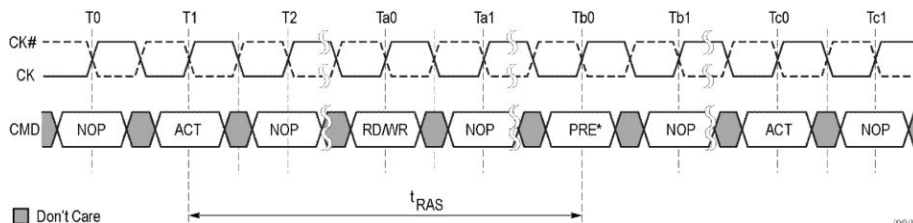
tPD measures the minimum power-down entry to exit time.

tPD uses the DPOJET measurement, tCMD-CMD.

For more details, refer to the topic tCMD-CMD in the DPOJET help.

**Active****tRAS**

tRAS measures the time elapsed from the ACTIVE to PRECHARGE command. This measurement is available for the GDDR5 generation only.

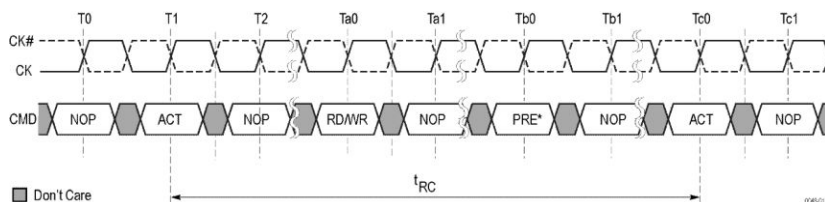


tRAS uses the DPOJET measurement, tCMDtoCMD.

For more details, refer to the topic tCMDtoCMD in the DPOJET help.

## t<sub>RC</sub>

t<sub>RC</sub> measures the time elapsed from the ACTIVE to ACTIVE command. This measurement is available for GDDR5 generation only.

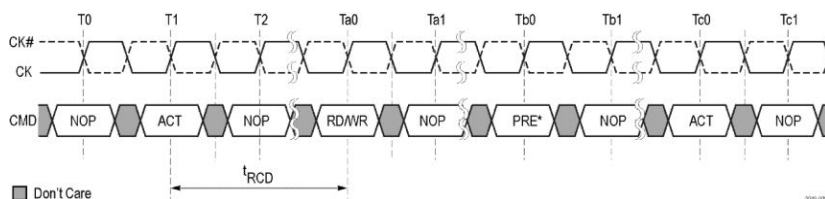


t<sub>RC</sub> uses the DPOJET measurement, t<sub>CMDtoCMD</sub>.

For more details, refer to the topic t<sub>CMDtoCMD</sub> of the DPOJET help.

## t<sub>RCDRD</sub>

t<sub>RCDRD</sub> measures the time elapsed between the ACTIVE and READ commands. This measurement is available for GDDR5 generation only.

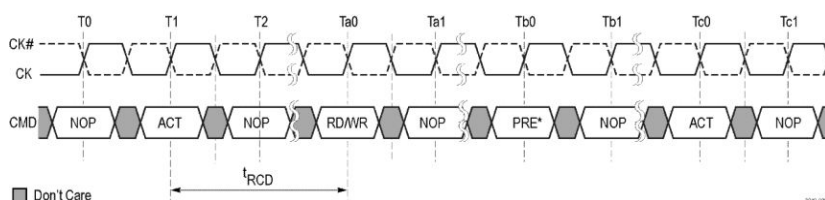


t<sub>RCDRD</sub> uses the DPOJET measurement, t<sub>CMDtoCMD</sub>.

For more details, refer to the topic t<sub>CMDtoCMD</sub> of the DPOJET help.

## t<sub>RCDWR</sub>

t<sub>RCDWR</sub> measures the time elapsed between the ACTIVE and WRITE commands. This measurement is available for GDDR5 generation only.



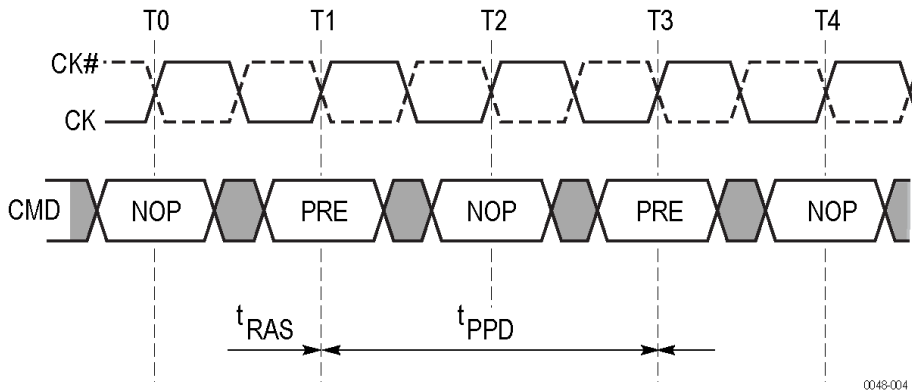
t<sub>RCDWR</sub> uses the DPOJET measurement, t<sub>CMDtoCMD</sub>.

For more details, refer to the topic t<sub>CMDtoCMD</sub> of the DPOJET help.

## Precharge

### tPPD

tPPD measures the elapsed time between the PRECHARGE and next PRECHARGE commands.

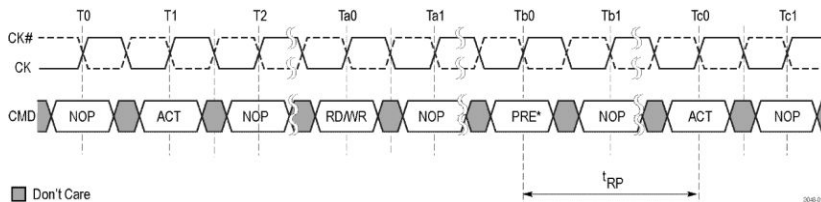


tPPD uses the DPOJET measurement, tCMDtoCMD. This measurement will be available for GDDR5 generation only.

For more details, refer to the topic tCMDtoCMD in the DPOJET help.

### tRP(ACT)

tRP(ACT) measures the PRECHARGE command period from PRECHARGE to ACTIVE commands..



tRP(ACT) uses the DPOJET measurement, tCMDtoCMD. This measurement will be available for GDDR5 generation only.

For more details, refer to the topic tCMDtoCMD of the DPOJET help.

### tRP(MRS)

tRP(MRS) measures the PRECHARGE command period from PRECHARGE to MRS (Mode Register Set) commands.

tRP(MRS) uses the DPOJET measurement, tCMDtoCMD. This measurement will be available for GDDR5 generation only.

For more details, refer to tCMDtoCMD in the DPOJET help.



**tRP(REF)**

tRP(REF) measures the precharge command period.

tRP(REF) uses the DPOJET measurement, tCMD-CMD.

For more details, refer to tCMD-CMD in the DPOJET help.

**tRP(SRE)**

tRP(SRE) measures the PRECHARGE command period from PRECHARGE to SELF REFRESH.

tRP(SRE) uses the DPOJET measurement, tCMD-CMD.

For more details, refer to tCMD-CMD in the DPOJET help.

**tRTPL**

tRTPL measures the READ to PRECHARGE command delay same bank with bank groups enabled.

tRTPL uses the DPOJET measurement, tCMD-CMD.

For more details, refer to tCMD-CMD in the DPOJET help.



---

# GPIB commands

## About the GPIB program

You can use remote GPIB commands to communicate with the DDRA application. Query measurement results using DPOJET commands. Sequence commands using DPOJET commands. Setup reports, logging, statistics, and limits using DPOJET commands. An example of a GPIB program is included with the DPOJET application in `C:\Users\Public\Tektronix\TekApplications\DPOJET\Examples`.

The example shows how a GPIB program executes the DPOJET application to do the following tasks:

1. Start the application.
2. Recall a setup.
3. Take a measurement.
4. View measurement results and plots.
5. Exit the application.

---

**NOTE.** *Commands are not case and space sensitive. Your program will operate correctly even if you do not follow the capitalization and spacing precisely.*

---

## GPIB reference materials

To use GPIB commands with your oscilloscope, you can refer to the following materials:

- The GPIB Program Example in `C:\TekApplications\DPOJET\Examples` for guidelines to use while designing a GPIB program.
- The Parameters topics for range of values, minimum units and default values of parameters.
- The programmer information in the online help of your oscilloscope.

## Argument types

The syntax shows the format that the instrument returns in response to a query. This is also the preferred format when sending the command to the instrument though any of the formats are accepted. This documentation represents these arguments as follows:

**Table 39: Argument types**

Symbol	Meaning
<NR1>	Signed integer value.
<NR2>	Floating point value without an exponent.
<NR3>	Floating point value with an exponent.
double	Double precision floating point with exponent.

## Commands

The DDRA commands are listed in alphabetical order.

### DDRA:APPLYBurstconfig

This command apply the LPDDR4 burst config settings.

#### Syntax

DDRA:APPLYBurstconfig

#### Inputs

None

#### Outputs

None

### DDRA:ADDALLTerr

This command adds all the measurements listed under the Terr node.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns measurement group does not exist under the generation or measurement type selected.

---

#### Syntax

DDRA:ADDALLTerr

#### Inputs

None

#### Outputs

None

## DDRA:ADDALLSLewdq

This command adds all the measurements listed under the Slew-Rate DQ node.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns measurement group does not exist under the generation or measurement type selected.

---

### Syntax

DDRA:ADDALLSLewdq

### Inputs

None

### Outputs

None

## DDRA:ADDALLDiffdq

This command adds all the measurements listed under the differential DQS node.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns measurement group does not exist under the generation or measurement type selected.

---

### Syntax

DDRA:ADDALLDiffdq

### Inputs

None

### Outputs

None

## DDRA:ADDCMDFLTFile

This command sets or queries the AddressCommand filter file used for the User Defined filter type.

### Syntax

```
DDRA:ADDCMDFLTFile {file_name}
```

---

**NOTE.** The file\_name should be complete path name. For example, C:\Users\Public\Filters\GDDR5\UserDefined\SingleEnded\GDDR5MCI\_DS-SE-SIM\_renorm\_read\_8GHz.ft

---

```
DDRA:ADDCMDFLTFile?
```

### Inputs

String

### Outputs

String

## DDRA:ADVBURSTLevelmode

This command sets or queries the Advance burst level mode.

### Syntax

```
DDRA:ADVBURSTLevelmode {AUTO | MANUAL}
```

```
DDRA:ADVBURSTLevelmode?
```

### Inputs

{AUTO | MANUAL}

### Outputs

{AUTO | MANUAL}

## DDRA:ADDALLSEdqs

This command adds all the measurements listed under the Single-Ended DQS node.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns measurement group does not exist under the generation or measurement type selected.

---

### Syntax

DDRA:ADDALLSEdqs

### Inputs

None

### Outputs

None

## DDRA:ADDMeas

This command selects the specified measurement in DDRA.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns measurement does not exist under the generation or measurement type selected

---

## Syntax

DDRA:ADDMeas {TCKABS | TCHABS | TCLABS | THP | TJITDUTY | TJITPER | TJITCC | VIDAC | SRQDIFFRISEDQS | SRQDIFFFALLDQS | SRQDIFFRISECK | SRQSERISEDQ | SRQSEFALLDQ | SRQDIFFFALLCK | INPUTSLEWDIFFRISEDQS | INPUTSLEWDIFFFALLDQS | INPUTSLEWDIFFRISECK | INPUTSLEWDIFFFALLCK | TQH | TISBASE | TISDERATED | TIHBASE | TISVREFF | TIHVREFF | TIHDERATED | TDQSK | TDQSKDIFF | TDSSSE | TDSSDIFF | TDSHSE | TDSHDIFF | TDQSSSE | TDQSSDIFF | TIPWHIGH | TIPWLOW | TDIPWSE | TIHVREFBASED | TISVREFBASED | TDHSEBASE | TDHSEDERATED | TDSSEBASE | TDSSEDERATED | TSDIFFBASE | TSDIFFDERATED | TDHDIFFBASE | TDHDIFFDERATED | TDQSQSE | TDQSQDIFF | TACDIFF | TDQSH | TDQSL | TCKAVG | TCLAVG | TCHAVG | TERR2PER | TERR3PER | TERR4PER | TERR5PER | TERR6TO10PER | TERR11TO50PER | DATAEYEWIDTH | VIXACDQS | VIXACCK | VIXACWCK | VOXACDQS | VOXACCK | ACOVRSHOOT | ACUNDSHOOT | ACOVRSHOOTDQS | ACOVRSHOOTDQSBAR | ACUNDSHOOTC | ACOVRSHOOTCKBAR | ACUNDSHOOTDQS | ACUNDSHOOTDQSBAR | ACUNDSHOOTCK | ACUNDSHOOTCKBAR | SETUPFALLADDRCMD | SETUPRISEADDRCMD | SLEWFALLCK | SLEWRISECK | HOLDFALLADDRCMD | HOLDRISEADDRCMD | SETUPFALLDQ | SETUPRISEDQ | SLEWSETUPFALLDQ | SLEWSETUPRISEDQ | SLEWSETUPSEFALLDQS | SLEWSETUPSERISEDQS | SLEWDIFFFALLDQS | SLEWDIFFRISEDQS | HOLDFALLDQ | HOLDRISEDQ | SLEHOLDFALLDQ | SLEWHOLDRISEDQ | SLEWHOLDSEFALLDQS | SLEWHOLDSERISEDQS | SETUPSEFALLDQ | SETUPSERISEDQ | HOLDSEFALLDQ | HOLDSERISEDQ | SLEWSEFALLDQS | SLEWSERISEDQS | TERR6PER | TERR7PER | TERR8PER | TERR9PER | TERR10PER | TERR11PER | TERR12PER | TERR13PER | TERR14PER | TERR15PER | TERR16PER | TERR17PER | TERR18PER | TERR19PER | TERR20PER | TERR21PER | TERR22PER | TERR23PER | TERR24PER | TERR25PER | TERR26PER | TERR27PER | TERR28PER | TERR29PER | TERR30PER | TERR31PER | TERR32PER | TERR33PER | TERR34PER | TERR35PER | TERR36PER | TERR37PER | TERR38PER | TERR39PER | TERR40PER | TERR41PER | TERR42PER | TERR43PER | TERR44PER | TERR45PER | TERR46PER | TERR47PER | TERR48PER | TERR49PER | TERR50PER | TCK | TH | TCL | TDSSE | TDHSE | TRPRE | TWPRE | TWPST | TRPST | VSWINGMAXDQS | VSWINGMAXDQSBAR | VSWINGMAXCK | VSWINGMAXCKBAR | DATAEYEHEIGHT | VSEHDQS | VSEHDQSBAR | VSEHCK | VSEHCKBAR | VSELDQS | VSELDQSBAR | VSELCK | VSELCKBAR | VSEHACDQ | VSEHACDQSBAR | VSEHACCK | VSEHACCKBAR | VSELACDQS | VSELACDQSBAR | VSELACCK | VSELACCKBAR | SLEWHOLDFALLADDRCMD | SLEWHOLDRISEADDRCMD | SLEWSETUPFALLADDRCMD | SLEWSETUPRISEADDRCMD | ACOVRSHOOTAREACKBAR | ACOVRSHOOTAREACK | ACOVRSHOOTAREADQSBAR | ACOVRSHOOTAREADQS | ACOVRSHOOTAREA | ACUNDSHOOTAREACKBAR | ACUNDSHOOTAREACK | CKSLEWRISECK | CKSLEWFALLCK | CKSLEWRISECKBAR | CKSLEWFALLCKBAR | ACUNDSHOOTAREADQSBAR | ACUNDSHOOTAREADQS | ACUNDSHOOTAREA | TSDIFFVREFBASED | TDHDIFFVREFBASED | VINCK | VINCKBAR | VINWCK | VINWCKBAR | TCMD5 | TCMDH | TAS | TAH | TCMDPW | TAPW | WCKSLEWRISEWCK | WCKSLEWRISEWCKBAR | WCKSLEWFALLWCL | WCKSLEWFALLWCKBAR | TWCK | TWCKHP | TWCKL | TWCKH | TDVACWCK | SSCDOWNSPREADWCK | SSCMODFREQWCK | TDVACCK | SSCDOWNSPREADCK | SSCMIDFREQWCK | SSCPROVILECK | SSCPROVILEWCK | TRC | TRAS | TRCDRD | TRCDWR | TRTPL | TPPD | TRPREF | TRPSRE | TRPMRS | TRPACT | TRFC | TCKSRE | TCKSRX | TXSNRW | TREFTRWRITE | TREFTRREAD | TPD | TWSRE | TWRPDE | TRDSRE | TRDPDE | VMAXAC | VMINAC | TDQRISSELEW | TDQFALLSLEW | TDQQTJ | TDQDJ | TDQRJ | VDQVOH | VDQVOL | TDQHP | TWCKRISSELEW | TWCKFALLSLEW | TWCKTJ | TWCKDJ | TWCKRJ | VOHWCK | VOHWCKBAR | VOLWCK | VOLWCKBAR | VWCKSWING | VIXDQ | VIXCA | ACOVRSHOOTAREADQ | ACUNDSHOOTAREADQ | ACOVRSHOOTDQ | TCIPWLOW | TCIPWHIGH | TQSLDBI | TQSHDBI | TQHDBI | TDQS2DQ | ACUNDSHOOTDQ | TDVACDQS | TDVACDQSBAR | TDVACDQ | TDVACADDRCMD | TRP | TDQSS | TDVACADDRCMD | TRP | TDQSS | TDIPWHIGH | TDIPWLOW | VIHLC | SRINRise | SRINFall | TQSH | TQSL | TIPWHIGHCA | TIPWLOWCA | TIPWHIGHCS | TIPWLOWCS | TISDERATEDCS | TISDERATEDCA | TISBASECS | TISBASECA | TIHDERATEDCS | TIHDERATEDCA | TIHBASECS | TIHBASECA | TLZDQ | THZDQ | TLZDQS | THZDQS | TWR | TWTR | TCCDRD | TCCDWR | DDRARXMASK | TRTP | CLOCKEYEWIDTH | SRR1 | SRF1 | }



### Inputs

See syntax for measurement options.

### Outputs

None

## DDRA:ALternatethresholds

This command sets or queries the alternate thresholds for the measurements selected in a particular generation.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns alternate threshold is not supported for the generation selected select a measurement, before selecting the alternate threshold.

---

### Syntax

```
DDRA:ALternatethresholds {AC160 | AC135 | AC130 | AC175| AC150 | AC125 | AC220 | AC300}
```

```
DDRA:ALternatethresholds?
```

### Inputs

```
{AC160 | AC135 | AC130 | AC175| AC150 | AC125 | AC220 | AC300}
```

### Outputs

```
{AC160 | AC135 | AC130 | AC175| AC150 | AC125 | AC220 | AC300}
```

## DDRA:AMPBasedmargin

This command sets or queries the margin value.

### Syntax

```
DDRA:AMPBasedmargin <NR3>
```

```
DDRA:AMPBasedmargin?
```

### Inputs

NR3

### Outputs

NR3

## DDRA:BURSTIDMethod

This command sets or queries the burst identification method.

### Syntax

```
DDRA:BURSTIDMethod{PREAMPattern | AMPBased}
```

```
DDRA:BURSTIDMethod?
```

### Inputs

```
{PREAMPattern | AMPBased}
```

### Outputs

```
{PREAMPattern | AMPBased}
```

## DDRA:BURSTDETECTmethod

This command sets or queries the Burst Detection method used for the measurement.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns select a measurement and set the applicable source type.

---

### Syntax

```
DDRA:BURSTDETECTmethod {DQDQS | CHIPselect | LOGICstate | VISUALSEARCH | NONE}
```

```
DDRA:BURSTDETECTmethod?
```

### Inputs

```
{DQDQS | CHIPselect | LOGICstate | VISUALSEARCH | NONE}
```

### Outputs

```
{DQDQS | CHIPselect | LOGICstate | VISUALSEARCH | NONE}
```

## DDRA:BURSTLength

This command sets or queries the burst length required for the selected bus. Select and configure the bus before setting the burst length.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns a bus has to be selected and configured.

---

### Syntax

DDRA:BURSTLength <NR3>

DDRA:BURSTLength?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:BURSTLatency

This command sets or queries the Burst Latency required for the selected bus. Select and configure the bus before setting the burst latency.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns a bus has to be selected and configured.

---

### Syntax

DDRA:BURSTLatency <NR3>

DDRA:BURSTLatency?

### Inputs

<NR3>

### Outputs

<NR3>.

## DDRA:BURSTLevelmode

This command sets or queries the burst level mode for the DQ and DQS settings.

### Syntax

```
DDRA:BURSTLevelmode {AUTO | MANUAL}
```

```
DDRA:BURSTLevelmode?
```

### Inputs

```
{AUTO | MANUAL}
```

### Outputs

```
{AUTO | MANUAL}
```

## DDRA:BURSTTolerance

This command sets or queries the burst tolerance required for the selected bus. Select and configure the bus before setting the burst tolerance.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns a bus has to be selected and configured.

---

### Syntax

```
DDRA:BURSTTolerance <NR3>
```

```
DDRA:BURSTTolerance?
```

### Inputs

```
<NR3>
```

### Outputs

```
<NR3>
```

## DDRA:BUS

This command sets or queries the Bus to be used for the measurements. The bus needs to be configured before being selected.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns select a measurement, before selecting a bus.

---

### Syntax

DDRA:BUS {bus\_name}

DDRA:BUS?

### Inputs

String

### Outputs

String

## DDRA:CLKFLTFile

This command sets or queries the CLK filter file used for the User Defined filter type.

### Syntax

DDRA:CLKFLTFile {file\_name}

DDRA:CLKFLTFile?

### Inputs

String

### Outputs

String

## DDRA:CSACTive

This command sets or queries the chip select active mode.

### Syntax

DDRA:CSACTive {L | H}

DDRA:CSACTive?

### Inputs

{L | H}

### Outputs

{L | H}

## DDRA:CLEARALLMeas

This command clears the entire list of defined measurements in DDRA.

### Syntax

DDRA:CLEARALLMeas

### Inputs

None

### Outputs

None

## DDRA:CSSOURce

This command sets or queries the sources for the chip select source type..

### Syntax

DDRA:CSSOURce {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

DDRA:CSSOURce?

### Inputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

### Outputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

## DDRA:CLKBARFLTFile

This command sets or queries the CLKBar filter file used for the User Defined filter type.

### Syntax

```
DDRA:CLKBARFLTFile{file_name}
```

---

**NOTE.** The *file\_name* should be complete path name. For example, *C:\Users\Public\Filters\GDDR5\UserDefined\SingleEnded\GDDR5MCI\_DS-SE-SIM\_renorm\_read\_8GHz.ft*

---

```
DDRA:CLKBARFLTFile?
```

### Inputs

string

### Outputs

string

## DDRA:CASMAX

This command sets or queries the CAS Max value for the chip select burst detection method.

### Syntax

```
DDRA:CASMAX <NR3>
```

```
DDRA:CASMAX?
```

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:CASMIN

This command sets or queries the CAS Min value for the chip select burst detection method.

### Syntax

```
DDRA:CASMIN <NR3>
```

```
DDRA:CASMIN?
```

### Inputs

```
<NR3>
```

### Outputs

```
<NR3>
```

## DDRA:CSLevel

This command sets or queries the chip select level.

### Syntax

```
DDRA:CSLevel <NR3>
```

```
DDRA:CSLevel?
```

### Inputs

```
<NR3>
```

### Outputs

```
<NR3>
```

## DDRA:CSMode

This command sets or queries the chip select mode.

### Syntax

```
DDRA:CSMode {AUTO | MANUAL}
```

```
DDRA:CSMode?
```

### Inputs

```
{AUTO | MANUAL}
```

### Outputs

```
{AUTO | MANUAL}
```



## DDRA:CUSTOMRate

This command sets or queries the custom data rate for a particular DDR generation.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns set the data rate to custom.

---

### Syntax

DDRA:CUSTOMRate <NR3>

DDRA:CUSTOMRate?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:DATAHIGH

This command sets or queries the data high value for the DQ and DQS settings.

### Syntax

DDRA:DATAHIGH <NR3>

DDRA:DATAHIGH?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:DATALOW

This command sets or queries the data low value for the DQ and DQS settings.

### Syntax

DDRA:DATALOW <NR3>

DDRA:DATALOW?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:DQSBARFLTfile

This command sets or queries the DQSBAR filter file used for the User Defined filter type.

### Syntax

DDRA:DQSBARFLTfile {file\_name}

---

**NOTE.** The file\_name should be complete path name. For example, C:\Users\Public\Filters\GDDR5\UserDefined\SingleEnded\GDDR5MCI\_DS-SE-SIM\_renorm\_read\_8GHz.ft.

---

DDRA:DQSBARFLTfile?

### Inputs

String

### Outputs

String

## DDRA:DQSFLTFile

This command sets or queries the DQS filter file used for the User Defined filter type.

### Syntax

```
DDRA:DQSFLTFile {file_name}
```

---

**NOTE.** The *file\_name* should be complete path name. For example, *C:\Users\Public\Filters\GDDR5\UserDefined\SingleEnded\GDDR5MCI\_DS-SE-SIM\_renorm\_read\_8GHz.ftt*.

---

```
DDRA:DQSFLTFile?
```

### Inputs

string

### Outputs

string

## DDRA:DQFLTFile

This command sets or queries the DQ filter file used for the User Defined filter type.

### Syntax

```
DDRA:DQFLTFile {file_name}
```

---

### NOTE.

The *file\_name* should be complete path name. For example, *C:\Users\Public\Filters\GDDR5\UserDefined\SingleEnded\GDDR5MCI\_DS-SE-SIM\_renorm\_read\_8GHz.ftt*

---

```
DDRA:DQFLTFile?
```

### Inputs

string

### Outputs

string

## DDRA:DATAMID

This command sets or queries the data mid value for the DQ and DQS settings.

### Syntax

DDRA:DATAMID <NR3>

DDRA:DATAMID?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:DATARate

This command sets or queries the standard data rate for a particular DDR generation.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns invalid data rate value, for the generation selected.

---

### Syntax

DDRA:DATARate {200 | 266 | 333 | 370 | 400 | 500 | 533 | 600 | 667 | 700 | 800 | 900 | 933 | 1000 | 1066 | 1200 | 1333 | 1466 | 1600 | 1866 | 2133 | 2400 | 2666 | 2667 | 3200 | 3733 | 4000 | 4266 | 4800 | 5000 | 5500 | CUSTOM}

DDRA:DATARate?

### Inputs

String.

### Outputs

The current data rate. A query for DDRA:LASTError returns Invalid data rate value, for the generation selected.

## DDRA:DQDQSLEVELSTatus?

This command queries the DQ and DQS level status.

### Syntax

```
DDRA:DQDQSLEVELSTatus?
```

### Outputs

```
{AUTO | MANUAL
```

## DDRA:FLTtype

This command sets or queries the interposer filter type. The user added interposer filter names can also be an input to this command.

### Syntax

```
{None| USERDefined | DIRECTAttached < Custom Interposer Filter Type >}
```

```
DDRA:FLTtype?
```

### Inputs

```
{None| USERDefined | DIRECTAttached < Custom Interposer Filter Type >}
```

### Outputs

```
{None| USERDefined | DIRECTAttached < Custom Interposer Filter Type >}
```

## DDRA:GENeration

This command sets or queries the standard DDR generation.

### Syntax

```
DDRA:GENeration {DDR | DDR2 | DDR3 | DDR3L | DDR4 | LPDDR | LPDDR2 | LPDDR3 | LPDDR4 | GDDR3 | GDDR5}
```

```
DDRA:GENeration?
```

### Inputs

```
{DDR | DDR2 | DDR3 | DDR3L | DDR4 | LPDDR | LPDDR2 | LPDDR3 | LPDDR4 | GDDR3 | GDDR5}
```

### Outputs

```
{DDR | DDR2 | DDR3 | DDR3L | DDR4 | LPDDR | LPDDR2 | LPDDR3 | LPDDR4 | GDDR3 | GDDR5}
```

## DDRA:HYSTERESIS

This command sets or queries the edge detection hysteresis value for the DQ and DQS settings.

### Syntax

```
DDRA:HYSTERESis <NR3>
```

```
DDRA:HYSTERESis?
```

### Inputs

```
<NR3>
```

### Outputs

```
<NR3>
```

## DDRA:HORIZontalscaling

This command sets or queries the horizontal scaling enabled or disabled for the measurements selected in a particular Generation.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns select a measurement, before selecting any of the scaling method.

---

### Syntax

```
DDRA:HORIZontalscaling {0 | 1}
```

```
DDRA:HORIZontalscaling?
```

### Inputs

```
{0 | 1}
```

### Outputs

```
{0 | 1}
```

## DDRA:ISOLBurstlen

This command sets or queries the isolated burst length.

### Syntax

```
DDRA:ISOLBurstlen{16|32}
```

```
DDRA:ISOLBurstlen?
```

### Inputs

```
{16|32}
```

### Outputs

```
{16|32}
```

## DDRA:LASTError?

This query command returns a string containing the last DDRA error. If no errors have occurred since startup or since the last call to :DDRA:LASTError?, this command returns an empty string.

### Syntax

```
DDRA:LASTError?
```

### Inputs

```
None
```

### Outputs

```
String containing the last error.
```

## DDRA:LOGICTrigger

This command sets or queries the symbol that needs to be triggered for the selected bus. Select and configure the bus before selecting a symbol for the particular bus.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns a bus has to be selected and configured.

---

### Syntax

```
DDRA:LOGICTrigger {READ | WRITE |...}
```

```
DDRA:LOGICTrigger?
```

### Inputs

```
<string> {READ | WRITE |...}
```

### Outputs

```
<string> {READ | WRITE |...}
```

## DDRA:MEASType

This command sets or queries the measurement type for a particular DDR generation.

### Syntax

```
DDRA:MEASType {WRITEbursts | READbursts | CKDiff | CKSE | DQSSE | ADDR CMD | WCKDiff | WCKSE | REFresh | PREChARGE | POWERDown | ACTive | DQSSERead}
```

```
DDRA:MEASType?
```

### Inputs

```
{WRITEbursts | READbursts | CKDiff | CKSE | DQSSE | ADDR CMD | WCKDiff | WCKSE | REFRESH | PRECHARGE | POWERDOWN | ACTIVE | DQSSERead}
```

### Outputs

The selected measurement type.

## DDRA:MARGIN

This command sets or queries the termination logic margin value for the DQ and DQS settings.

### Syntax

```
DDRA:MARGIN <NR3>
```

```
DDRA:MARGIN?
```

### Inputs

```
<NR3>
```

### Outputs

```
<NR3>
```

## DDRA:POSTamble

This command sets or queries POSTamble length.

### Syntax

```
DDRA:POSTamble <NR3>
```

```
DDRA:POSTamble?
```

### Inputs

```
0.5 and 1.5
```

### Outputs

```
0.5 and 1.5
```



## DDRA:PREAmbletype

This command sets or queries the preamble type.

### Syntax

```
DDRA:PREAmbletype {Static | Toggle}
```

```
DDRA:PREAmbletype?
```

### Inputs

```
{Static | Toggle}
```

### Outputs

```
{Static | Toggle}
```

## DDRA:PTPeak

This command sets or queries the peak-peak value.

### Syntax

```
DDRA:PTPeak <NR3>
```

```
DDRA:PTPeak?
```

### Inputs

```
NR3
```

### Outputs

```
NR3
```

## DDRA:RXMASKFile

This command sets or queries filter file path for mask file.

### Syntax

```
DDRA:RXMASKFile <STRING>
```

```
DDRA:RXMASKFile?
```

### Inputs

```
String
```

### Outputs

```
String
```

## DDRA:SOURCE:ADDRCMD

This command sets or queries the sources for the Address Command source type.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns select a measurement and set the applicable source type.

---

### Syntax

DDRA:SOURCE:ADDRCMD {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

DDRA:SOURCE:ADDRCMD?

### Inputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

### Outputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

## DDRA:SOURCE:CLOCK

This command sets or queries the sources for the clock source type.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns select a measurement and set the applicable source type.

---

### Syntax

DDRA:SOURCE:CLOCK {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

DDRA:SOURCE:CLOCK?

### Inputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

### Outputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

## DDRA:SOURCE:STROBE

This command sets or queries the sources for the strobe source type.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns select a measurement and set the applicable source type.

---

### Syntax

DDRA:SOURCE:STROBE {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

DDRA:SOURCE:STROBE?

### Inputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

### Outputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

## DDRA:SOURCE:DATA

This command sets or queries the sources for the data source type.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns select a measurement and set the applicable source type.

---

### Syntax

DDRA:SOURCE:DATA {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

DDRA:SOURCE:DATA?

### Inputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

### Outputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

## DDRA:SOURCE?

This branch-query command returns the sources selected for the measurement.

### Syntax

DDRA:SOURCE?

### Inputs

None

### Outputs

String

## DDRA:SOURCE:CLOCKBar

This command sets or queries the sources for the clock bar source type.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns select a measurement and set the applicable source type.

---

### Syntax

DDRA:SOURCE:CLOCKBar {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

DDRA:SOURCE:CLOCKBar?

### Inputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

### Outputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

## DDRA:SOURCE:STRObebar

This command sets or queries the sources for the strobe bar source type.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns select a measurement and set the applicable source type.

---

### Syntax

```
DDRA:SOURCE:STRObebar {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 |  
REF2 | REF3 | REF4}
```

```
DDRA:SOURCE:STRObebar?
```

### Inputs

```
{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}
```

### Outputs

```
{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}
```

## DDRA:STROBEHIGH

This command sets or queries the strobe high value for the DQ and DQS settings.

### Syntax

```
DDRA:STROBEHIGH <NR3>
```

```
DDRA:STROBEHIGH?
```

### Inputs

```
<NR3>
```

### Outputs

```
<NR3>
```

## DDRA:STROBEMID

This command sets or queries the strobe mid value for the DQ and DQS settings.

### Syntax

DDRA:STROBEMID <NR3>

DDRA:STROBEMID?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:STROBELOW

This command sets or queries the strobe low value for the DQ and DQS settings.

### Syntax

DDRA:STROBELOW <NR3>

DDRA:STROBELOW?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:SOURCE:WCKBar

This command sets or queries the sources for the WCK bar source type.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns select a measurement and set the applicable source type.

---

### Syntax

DDRA:SOURCE:WCKBar {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

DDRA:SOURCE:WCKBar?

### Inputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}

### Outputs

{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}.

## DDRA:SOURCE:WCK

This command sets or queries the sources for the WCK source type.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns select a measurement and set the applicable source type.

---

### Syntax

```
DDRA:SOURCE:WCK {CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}
```

```
DDRA:SOURCE:WCK?
```

### Inputs

```
{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}
```

### Outputs

```
{CH1 | CH2 | CH3 | CH4 | MATH1 | MATH2 | MATH3 | MATH4 | REF1 | REF2 | REF3 | REF4}.
```

## DDRA:SYMBOLFile

This command sets or queries the symbol file used for the selected bus. Select and configure the bus before selecting a symbol file for the particular bus.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns a bus has to be selected and configured.

---

### Syntax

```
DDRA:SYMBOLFile {file_name}
```

---

**NOTE.** The file\_name should be complete path name. For example, C:\Users\Public\Filters\GDDR5\UserDefined\SingleEnded\GDDR5MCI\_DS-SE-SIM\_renorm\_read\_8GHz.ft

---

```
DDRA:SYMBOLFile?
```

### Inputs

```
String
```

### Outputs

```
string
```

## DDRA:THREShold

This command sets or queries the threshold value.

### Syntax

```
DDRA:THREShold <NR3>
```

```
DDRA:THREShold?
```

### Inputs

NR3

### Outputs

NR3

## DDRA:TDQS2DQMode

This command sets or queries the TDQS2DQ mode.

### Syntax

```
DDRA:TDQS2DQMode {Auto | UserDefined}
```

```
DDRA:TDQS2DQMode?
```

### Inputs

{Auto | UserDefined}

### Outputs

{Auto | UserDefined}

## DDRA:TDQS2DQ

This command sets or queries the TDQS2DQ value.

### Syntax

```
DDRA:TDQS2DQ <NR3>
```

```
DDRA:TDQS2DQ?
```

### Inputs

NR3

### Outputs

NR3



## DDRA:TCKAVG

This command sets or queries TCKAVG.

### Syntax

DDRA:TCKAVG<NR3>

DDRA:TCKAVG?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:TIMGMode

This command sets or queries the timing mode.

### Syntax

DDRA:TIMGMode{1|2}

DDRA:TIMGMode?

### Inputs

{1|2}

### Outputs

{1|2}

## DDRA:TCKAVGMIN

This command sets or queries TCKAVGMIN.

### Syntax

DDRA:TCKAVGMIN<NR3>

DDRA:TCKAVGMIN?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:VCENTCA

This command sets or queries VCENTCA

### Syntax

DDRA:VCENTCA<NR3>

DDRA:VCENTCA?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:VCENTDQ

This command sets or queries VCENTDQ.

### Syntax

DDRA:VCENTDQ<NR3>

DDRA:VCENTDQ?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:VDD

This command sets or queries the user-defined VDD value for a particular DDR generation.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns select user defined mode to configure Vdd/Vref value.

---

### Syntax

DDRA:VDD <NR3>

DDRA:VDD?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:VDDMode

This command sets or queries the VDD mode for a particular DDR generation.

### Syntax

```
DDRA:VDDMode {JEDEC | Manual}
```

```
DDRA:VDDMode?
```

### Inputs

```
{JEDEC | Manual}
```

### Outputs

The currently selected VDD mode {JEDEC | Manual}.

## DDRA:VERTicalscaling

This command sets or queries the vertical scaling enabled or disabled for the measurements selected in a particular generation.

---

**NOTE.** If there is an error, the `DDRA:LASTError?` query returns select a measurement, before selecting any of the scaling method.

---

### Syntax

```
DDRA:VERTicalscaling {0 | 1}
```

```
DDRA:VERTicalscaling?
```

### Inputs

```
{0 | 1}
```

### Outputs

```
{0 | 1}
```

## DDRA:VERsion?

This command queries the DDRA Version.

### Syntax

DDRA:VERsion?

### Outputs

String

## DDRA:VIHACMin?

This query-only command returns the VIHACMin value.

### Syntax

DDRA:VIHACMin?

### Inputs

None

### Outputs

<NR3>

## DDRA:VIHDCMin?

This query-only command returns the VIHDCMin value.

### Syntax

DDRA:VIHDCMin?

### Inputs

None

### Outputs

<NR3>

## DDRA:VILACMax?

This query-only command returns the VILACMax value.

### Syntax

DDRA:VILACMax?

### Inputs

None

### Outputs

<NR3>

## DDRA:VILDCMax?

This query-only command returns the VILDCMax value.

### Syntax

DDRA:VILDCMax?

### Inputs

None

### Outputs

<NR3>

## DDRA:VREF

This command sets or queries the user-defined Vref value for a particular DDR generation.

---

**NOTE.** If there is an error, the DDRA:LASTError? query returns select user defined mode to configure Vdd/Vref value.

---

### Syntax

DDRA:VREF <NR3>

DDRA:VREF?

### Inputs

<NR3>

### Outputs

<NR3>

## DDRA:VREFDC?

This query-only command returns the VREFDC value.

### Syntax

DDRA:VREFDC?

### Inputs

None

### Outputs

<NR3>

## DDRA:VREFMode

This command sets or queries the Vref mode for a particular DDR generation.

### Syntax

DDRA:VREFMode {JEDEC | Manual}

DDRA:VREFMode?

### Inputs

{JEDEC | Manual}

### Outputs

The currently selected Vref mode {JEDEC | Manual}.

## DDRA:WRITEAmpgtread

This command sets or queries the Write amplitude is greater than read amplitude is enabled or disabled.

### Syntax

DDRA:WRITEAmpgtread {0 | 1}

DDRA:WRITEAmpgtread?

### Inputs

{0 | 1}

### Outputs

{0 | 1}

## DDRA:WCKBARFLTFile

This command sets or queries the WCKBar filter file used for the User Defined filter type.

### Syntax

```
DDRA:WCKBARFLTFile{file_name}
```

---

**NOTE.** The file\_name should be complete path name. For example, C:\Users\Public\Filters\GDDR5\UserDefined\SingleEnded\GDDR5MCI\_DS-SE-SIM\_renorm\_read\_8GHz.ft

---

```
DDRA:WCKBARFLTFile?
```

### Inputs

string

### Outputs

string

## DDRA:WCKFLTFile

This command sets or queries the WCK filter file used for the User Defined filter type.

### Syntax

```
DDRA:WCKFLTFile {file_name}
```

---

**NOTE.** The file\_name should be complete path name. For example, C:\Users\Public\Filters\GDDR5\UserDefined\SingleEnded\GDDR5MCI\_DS-SE-SIM\_renorm\_read\_8GHz.ft.

---

```
DDRA:WCKFLTFile?
```

### Inputs

string

### Outputs

string





---

# Index

## A

- About DDRA, 8
- AC 150, 44
- AC 175, 43
- AC-Overshoot, 159
- AC-Overshoot(CK), 145–147
- AC-Overshoot(CK#), 145
- AC-Overshoot(DQS), 152
- AC-Overshoot(DQS#), 152
- AC-OvershootArea, 159
- AC-OvershootArea(DQS), 153
- AC-OvershootArea(DQS#), 152
- AC-Undershoot, 160
- AC-Undershoot(CK), 146, 147
- AC-Undershoot(CK#), 146
- AC-Undershoot(DQS), 153
- AC-Undershoot(DQS#), 153
- AC-UndershootArea, 160
- AC-UndershootArea(DQS), 154
- AC-UndershootArea(DQS#), 154
- Algorithms, 121
- Alternate Thresholds, 43
- Argument Types, 169

## B

- Browse, 9

## C

- Check Boxes, 9
- CKslew-Fall(CK), 148
- CKslew-Fall(CK#), 148
- CKslew-Rise(CK), 148
- CKslew-Rise(CK#), 148
- Command button, 9
- Control Panel
  - Advanced Setup DPOJET, 11
  - Clear, 11
  - Recalc, 11
  - Run, 11

- Show Plots, 11
  - Single, 11
- Conventions, 1
- Customer Feedback, 2

## D

- D, 15
- Data Eye Height, 121
- Data Eye Width
  - superimposed eye, 122
- Data Rate, 61
- DDR, 1
- DDR Generation, 61
- DDR Method, 26
- DDR104, 119
- DDR105, 119
- DDR106, 119
- DDR107, 119
- DDR2-tDQSCK, 135
- DDRA
  - DQFLTFile, 185
- DDRA Prerequisites, 6
- Derating, 163
- Directories
  - 64-bit systems, 11
  - 64-bit systems, 47
- DPOJET, 1
- DQ/DQS Phase Alignment, 44
- DUT, 1
- Dynamic Limits, 15
- Dynamic Limits for DDR, 100
- Dynamic Limits for DDR2, 101
- Dynamic Limits for DDR3, 101
- Dynamic Limits for DDR3L, 102
- Dynamic Limits for DDR4, 103
- Dynamic Limits for LPDDR, 104
- Dynamic Limits for LPDDR2, 104
- Dynamic Limits for LPDDR3, 105
- Dynamic Limits for LPDDR4, 106

**E**

E1001, 116  
E1002, 116  
E1003, 116  
E1004, 116  
E1005, 116  
E1006, 116  
E1007, 116  
E1008, 116  
E1009, 116  
E1010, 116  
E1012, 116  
E1013, 116  
E102, 116  
E1020, 116  
E1021, 116  
E1022, 116  
E1026, 116  
E1027, 116  
E1028, 116  
E1029, 116  
E103, 116  
E1035, 117  
E104, 116  
E1040, 117  
E105, 116  
E1054, 117  
E1055, 117  
E1056, 117  
E1057, 117  
E1058, 117  
E1059, 117  
E106, 116  
E1061, 117  
E1062, 117  
E1063, 117  
E2001, 117  
E2002, 117  
E2003, 117  
E2004, 117  
E2005, 117  
E2006, 117

E2007, 117  
E2008, 117  
E202, 116  
E3001, 117  
E3002, 117  
E3003, 117  
E3004, 117  
E3005, 117  
E3006, 117  
E3007, 117  
E3008, 117  
E3010, 117  
E3011, 117  
E3012, 117  
E400, 116  
E4000, 118  
E4001, 118  
E4002, 118  
E4003, 118  
E4004, 118  
E4005, 118  
E4006, 118  
E4007, 118  
E4027, 118  
E4028, 118  
E4029, 118  
E4030, 118  
E4031, 118  
E411, 116  
E424, 116  
E425, 116  
E500, 116

**G**

Generations  
    DDR, 5  
    DDR2, 5  
    DDR3, 5  
    GDDR3, 5  
    LPDDR, 5  
GPIB Command  
    DDRA:AMPBasedmargin, 175



**I**

Input Slew-Diff-Fall(CK), 144  
 Input Slew-Diff-Fall(DQS), 125  
 Input Slew-Diff-Rise(CK), 144  
 Input Slew-Diff-Rise(DQS), 124

**M**

Measurement Levels, 53

Measurement Sources

DDR, 67  
 DDR2, 69  
 DDR3, 73  
 DDR3L, 77  
 DDR4, 81  
 GDDR5, 84  
 LPDDR, 86  
 LPDDR2, 88  
 LPDDR3, 92  
 LPDDR4, 96

Measurement Type

Active, 33  
 Address/Command, 33  
 Clock (Single Ended), 33  
 Clock(Diff), 33  
 DQS(Single Ended), 33  
 Power Down, 33  
 Precharge, 33  
 Read Bursts, 33  
 Refresh, 33  
 Slew Rate(Diff), 33  
 WCK(Diff), 33  
 WCK(Single Ended), 33  
 Write Bursts, 33

**O**

Opt. ASM, xiii  
 Oscilloscope model number, 2  
 Overshoot, 159

**P**

Parameters, 61

Plots, 55  
 probes, 6

**R**

Recalling a Default Setup, 13  
 Ref Levels Setup, 53  
 Related Documentation, 1  
 Requirements, 6  
 Results, 54

**S**

Saving a Setup, 12  
 Search and Mark, xiii  
 Slew Rate-Hold-Fall(Addr/Cmd), 161  
 Slew Rate-Hold-Fall(DQ), 139  
 Slew Rate-Hold-Rise(Addr/Cmd), 161  
 Slew Rate-Hold-Rise(DQ), 139  
 Slew Rate-Hold-SE-Fall(DQS), 128  
 Slew Rate-Hold-SE-Rise(DQS), 129  
 Slew Rate-Setup-Fall(Addr/Cmd), 161  
 Slew Rate-Setup-Fall(DQ), 139  
 Slew Rate-Setup-Rise(Addr/Cmd), 161  
 Slew Rate-Setup-Rise(DQ), 139  
 Slew Rate-Setup-SE-Fall(DQS), 129  
 Slew Rate-Setup-SE-Rise(DQS), 129  
 Speed Bins, 31  
 SRQdiff-Fall(DQS), 134  
 SRQdiff-Rise(DQS), 134  
 SRQse-Fall(DQ), 136  
 SRQse-Rise(DQ), 136  
 SSC Downspread(CK), 139  
 SSC Downspread(WCK), 155  
 SSC Mod Freq(CK), 140  
 SSC Mod Freq(WCK), 155  
 SSC Profile(CK), 140  
 SSC Profile(WCK), 155  
 Step1, 28  
 Step2, 31  
 Step4, 38  
 Step5, 42  
 Step6, 42  
 Symbol file, 47

**T**

- tAC-Diff, 133
- tAH, 161
- tAPW, 161
- tAS, 162
- tCH, 140
- tCH(abs), 140
- tCH(avg), 141
- tCK, 140
- tCK(abs), 141
- tCK(avg), 141
- tCKSRE, 163
- tCKSRX, 163
- tCL, 140
- tCL(abs), 141
- tCL(avg), 142
- tCMDH, 162
- tCMDPW, 162
- tCMDS, 162
- tDH-Diff(base), 125
- tDH-Diff(derated), 126
- tDH-Diff(Vref-based), 126
- tDH-SE(base), 130
- tDIPW-SE, 129
- tDQSCK-Diff, 132
- tDQSCK-SE, 135
- tDQSH, 127
- tDQSL, 128
- tDQSQ-DBI, 133
- tDQSQ-Diff, 133
- tDQSQ-SE, 135
- tDQSS-Diff, 128
- tDQSS-SE, 130
- tDS-Diff(base), 126
- tDS-Diff(derated), 127
- tDS-Diff(Vref-based), 127
- tDS-SE(base), 129
- tDSH-Diff, 128
- tDSH-SE, 129
- tDSS-Diff, 128
- tDSS-SE, 129
- tDVAC(CK), 130
- tDVAC(WCK), 155
- tERR
  - tERR(m-nper), 142
  - tERR(nper), 142
- tHP, 142
- tIH(base), 162
- tIH(derated), 163
- tIPW-High, 163
- tIPW-Low, 163
- tIS(base), 162
- tIS(derated), 163
- tJIT(cc), 143
- tJIT(duty), 143
- tJIT(per), 144
- tPD, 164
- tPPD, 166
- tQH, 133
- tRAS, 164
- tRC, 165
- tRCDRD, 165
- tRCDWR, 165
- tRDPDE, 137
- tRDSRE, 137
- tREFTR(Read), 164
- TREFTR(Write), 164
- tRFC, 164
- tRP(ACT), 166
- tRP(MRS), 166
- tRP(REF), 167
- tRP(SRE), 167
- tRPRE, 137
- tRPST, 138
- tRTPL, 167
- tWCK, 155
- tWCK-DJ, 155
- tWCK-Fall-Slew, 156
- tWCK-Rise-Slew, 156
- tWCK-RJ, 156
- tWCK-TJ, 156
- tWCKH, 156
- tWCKHP, 156
- tWCKL, 156
- tWPRE, 130

tWPST, 131  
tWRPDE, 132  
tWRSRE, 132  
tXSNRW, 164

## U

Undershoot, 160

## V

Vdd and Vref, 30  
VID(ac), 144  
VIN(CK), 148  
VIN(CK#), 148  
VIN(WCK), 157  
VIN(WCK#), 157  
Virtual Keypad, 9  
Vix(ac)CK, 148  
Vix(ac)DQS, 151  
Vix(ac)WCK, 157  
VOH, 157  
VOH(WCK), 157  
VOH(WCK#), 158  
VOL, 157  
VOL(WCK), 157  
VOL(WCK#), 158

Vox(ac)CK, 149  
Vox(ac)DQS, 151  
VSEH(AC)CK, 149  
VSEH(AC)CK#, 150  
VSEH(CK), 150  
VSEH(CK#), 150  
VSEL(AC)CK, 151  
VSEL(AC)CK#, 151  
VSEL(CK), 151  
VSEL(CK#), 151  
VSWING(MAX)CK, 149  
VSWING(MAX)CK#, 149  
VWCK-Swing, 157

## W

W1011, 116  
W1051, 117  
W1053, 117  
W4008, 118  
W4009, 118  
W410, 116  
WCKslew-Fall(WCK), 158  
WCKslew-Fall(WCK#), 158  
WCKslew-Rise(WCK), 158  
WCKslew-Rise(WCK#), 158